

# ADS131M04-Q1 Automotive, 4-Channel, 64-kSPS, Simultaneous-Sampling, 24-Bit, Delta-Sigma ADC

## 1 Features

- AEC-Q100 qualified for automotive applications:
  - Temperature grade 1:  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ ,  $T_A$
- Functional Safety-Capable
  - Documentation available to aid functional safety system design
- 4 simultaneously sampling differential inputs
- Programmable data rate up to 64 kSPS
- Programmable gain up to 128
- Noise performance:
  - 102-dB dynamic range at gain = 1, 4 kSPS
  - 80-dB dynamic range at gain = 64, 4 kSPS
- Total harmonic distortion:  $-100$  dB
- High-impedance inputs for direct sensor connection:
  - 330-k $\Omega$  input impedance for gains of 1, 2, and 4
  - $\geq 1\text{-M}\Omega$  input impedance for gains of 8, 16, 32, 64, and 128
- Programmable channel-to-channel phase delay calibration:
  - Resolution = 244 ns,  $f_{\text{CLKIN}} = 8.192$  MHz
- Fast start-up:
  - First data within 0.5 ms of supply ramp
- Integrated negative charge pump allows input signals below ground
- Crosstalk between channels:  $-120$  dB
- Low-drift internal voltage reference
- CRC on communications and register map
- Analog and digital supplies: 2.7 V to 3.6 V
- Low-power consumption: 3.3 mW at 3-V AVDD and DVDD
- Package: 20-pin TSSOP

## 2 Applications

- Automotive battery management systems (BMS):
  - Current-shunt measurements
  - Voltage measurements using external resistor dividers
  - Temperature measurements using thermistors or analog output temperature sensors
- EV charging stations:
  - DC e-metering
  - AC e-metering
- Energy storage systems (ESS)

## 3 Description

The ADS131M04-Q1 is a four-channel, simultaneously sampling, 24-bit, delta-sigma ( $\Delta\Sigma$ ), analog-to-digital converter (ADC) that offers wide dynamic range and low power, making the device designed for automotive battery management systems (BMS). The ADC inputs can be directly interfaced to shunt resistors for bidirectional battery-current measurements, to resistor-divider networks for high-voltage measurements, or to temperature sensors (such as thermistors or analog output temperature sensors).

The individual ADC channels can be independently configured depending on the sensor input. A low-noise, programmable gain amplifier (PGA) provides gains ranging from 1 to 128 to amplify low-level signals. Additionally, this device integrates channel-to-channel phase calibration and offset and gain calibration registers to help remove signal-chain errors.

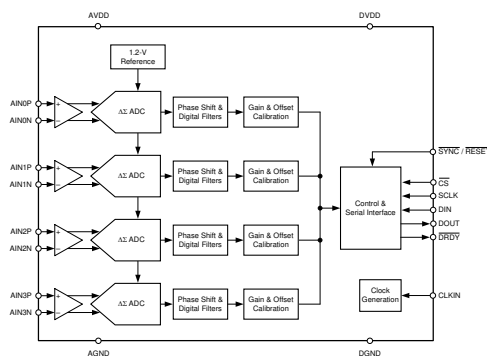
A low-drift, 1.2-V reference is integrated into the device, reducing printed circuit board (PCB) area. Optional cyclic redundancy checks (CRCs) on the data input, data output, and register map maintain communication integrity.

The complete analog front-end (AFE) is offered in a 20-pin TSSOP package and is specified over the automotive temperature range of  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ .

### Package Information<sup>(1)</sup>

| PART NUMBER  | PACKAGE    | BODY SIZE (NOM)          |
|--------------|------------|--------------------------|
| ADS131M04-Q1 | TSSOP (20) | 6.50 mm $\times$ 4.40 mm |

- (1) For all available packages, see the orderable addendum at the end of the data sheet.



**Simplified Block Diagram**



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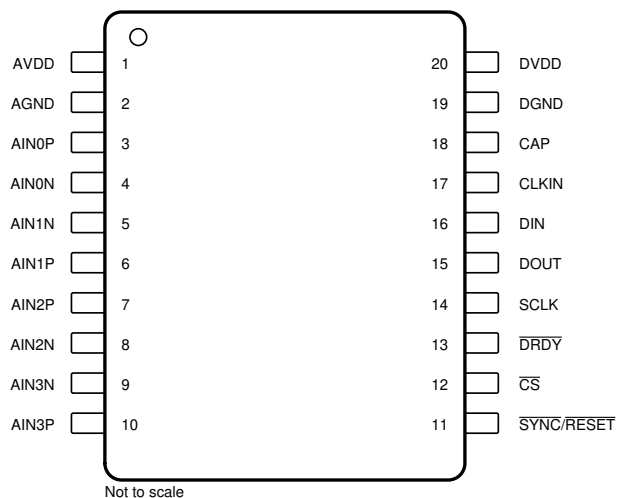
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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision * (March 2022) to Revision A (August 2022)                          | Page     |
|-------------------------------------------------------------------------------------------|----------|
| • Changed document status from <i>advance information</i> to <i>production data</i> ..... | <b>1</b> |

## 5 Pin Configuration and Functions



**Figure 5-1. PW Package, 20-Pin TSSOP (Top View)**

**Table 5-1. Pin Functions**

| PIN        |     | I/O            | DESCRIPTION <sup>(1)</sup>                                                      |
|------------|-----|----------------|---------------------------------------------------------------------------------|
| NAME       | NO. |                |                                                                                 |
| AGND       | 2   | Supply         | Analog ground                                                                   |
| AIN0N      | 4   | Analog input   | Negative analog input 0                                                         |
| AIN0P      | 3   | Analog input   | Positive analog input 0                                                         |
| AIN1N      | 5   | Analog input   | Negative analog input 1                                                         |
| AIN1P      | 6   | Analog input   | Positive analog input 1                                                         |
| AIN2N      | 8   | Analog input   | Negative analog input 2                                                         |
| AIN2P      | 7   | Analog input   | Positive analog input 2                                                         |
| AIN3N      | 9   | Analog input   | Negative analog input 3                                                         |
| AIN3P      | 10  | Analog input   | Positive analog input 3                                                         |
| AVDD       | 1   | Supply         | Analog supply. Connect a 1-μF capacitor to AGND.                                |
| CAP        | 18  | Analog output  | Digital low-dropout (LDO) regulator output. Connect a 220-nF capacitor to DGND. |
| CLKIN      | 17  | Digital input  | Main clock input                                                                |
| CS         | 12  | Digital input  | Chip select; active low                                                         |
| DGND       | 19  | Supply         | Digital ground                                                                  |
| DIN        | 16  | Digital input  | Serial data input                                                               |
| DOUT       | 15  | Digital output | Serial data output                                                              |
| DRDY       | 13  | Digital output | Data ready; active low                                                          |
| DVDD       | 20  | Supply         | Digital I/O supply. Connect a 1-μF capacitor to DGND.                           |
| SCLK       | 14  | Digital input  | Serial data clock                                                               |
| SYNC/RESET | 11  | Digital input  | Conversion synchronization or system reset; active low                          |

(1) See the [Unused Inputs and Outputs](#) section for details on how to connect unused pins.

## 6 Specifications

### 6.1 Absolute Maximum Ratings

see (1)

|                       |                                                | MIN        | MAX        | UNIT |
|-----------------------|------------------------------------------------|------------|------------|------|
| Power-supply voltage  | AVDD to AGND                                   | −0.3       | 3.9        | V    |
|                       | AGND to DGND                                   | −0.3       | 0.3        |      |
|                       | DVDD to DGND                                   | −0.3       | 3.9        |      |
|                       | DVDD to DGND, CAP tied to DVDD                 | −0.3       | 2.2        |      |
|                       | CAP to DGND                                    | −0.3       | 2.2        |      |
| Analog input voltage  | AINxP, AINxN                                   | AGND − 1.6 | AVDD + 0.3 |      |
| Digital input voltage | $\overline{CS}$ , CLKIN, DIN, SCLK, SYNC/RESET | DGND − 0.3 | DVDD + 0.3 |      |
| Input current         | Continuous, all pins except power-supply pins  | −10        | 10         | mA   |
| Temperature           | Junction, $T_J$                                |            | 150        | °C   |
|                       | Storage, $T_{stg}$                             | −60        | 150        |      |

- (1) Operation outside the *Absolute Maximum Ratings* may cause permanent device damage. *Absolute Maximum Ratings* do not imply functional operation of the device at these or any other conditions beyond those listed under *Recommended Operating Conditions*. If used outside the *Recommended Operating Conditions* but within the *Absolute Maximum Ratings*, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.

### 6.2 ESD Ratings

|             |                         |                                                                                              |                           | VALUE | UNIT |
|-------------|-------------------------|----------------------------------------------------------------------------------------------|---------------------------|-------|------|
| $V_{(ESD)}$ | Electrostatic discharge | Human-body model (HBM),<br>per AEC Q100-002 <sup>(1)</sup><br>HBM ESD classification level 2 |                           | ±2000 | V    |
|             |                         | Charged-device model (CDM),<br>per AEC Q100-011<br>CDM ESD classification level C4B          | Corner pins               | ±750  |      |
|             |                         |                                                                                              | All other non-corner pins | ±500  |      |

- (1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

## 6.3 Recommended Operating Conditions

over operating ambient temperature range (unless otherwise noted)

|                                            |                               |                                                           | MIN                      | NOM   | MAX                     | UNIT |
|--------------------------------------------|-------------------------------|-----------------------------------------------------------|--------------------------|-------|-------------------------|------|
| POWER SUPPLY                               |                               |                                                           |                          |       |                         |      |
|                                            | Analog power supply           | AVDD to AGND, normal operating modes                      | 2.7                      | 3.0   | 3.6                     | V    |
|                                            |                               | AVDD to AGND, standby and current-detect modes            | 2.4                      | 3.0   | 3.6                     |      |
|                                            |                               | AGND to DGND                                              | −0.3                     | 0     | 0.3                     |      |
|                                            | Digital power supply          | DVDD to DGND                                              | 2.7                      | 3.0   | 3.6                     | V    |
|                                            |                               | DVDD to DGND, DVDD shorted to CAP (digital LDO bypassed)  | 1.65                     | 1.8   | 2                       |      |
| ANALOG INPUTS <sup>(1)</sup>               |                               |                                                           |                          |       |                         |      |
| V <sub>AINxP</sub> ,<br>V <sub>AINxN</sub> | Absolute input voltage        | Gain = 1, 2, or 4                                         | AGND − 1.3               |       | AVDD                    | V    |
|                                            |                               | Gain = 8, 16, 32, 64 or 128                               | AGND − 1.3               |       | AVDD − 1.8              |      |
| V <sub>IN</sub>                            | Differential input voltage    | V <sub>IN</sub> = V <sub>AINxP</sub> - V <sub>AINxN</sub> | −V <sub>REF</sub> / Gain |       | V <sub>REF</sub> / Gain | V    |
| EXTERNAL CLOCK SOURCE                      |                               |                                                           |                          |       |                         |      |
| f <sub>CLKIN</sub>                         | External clock frequency      | High-resolution mode                                      | 0.3                      | 8.192 | 8.4                     | MHz  |
|                                            |                               | Low-power mode                                            | 0.3                      | 4.096 | 4.15                    |      |
|                                            |                               | Very-low-power mode                                       | 0.3                      | 2.048 | 2.08                    |      |
|                                            | Duty cycle                    |                                                           | 40%                      | 50%   | 60%                     |      |
| DIGITAL INPUTS                             |                               |                                                           |                          |       |                         |      |
|                                            | Input voltage                 |                                                           | DGND                     |       | DVDD                    | V    |
| TEMPERATURE RANGE                          |                               |                                                           |                          |       |                         |      |
| T <sub>A</sub>                             | Operating ambient temperature |                                                           | −40                      |       | 125                     | °C   |

(1) The subscript "x" signifies the channel. For example, the positive analog input to channel 0 is named AIN0P. See the [Pin Configuration and Functions](#) section for the pin names.

## 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | ADS131M04-Q1 | UNIT |
|-------------------------------|----------------------------------------------|--------------|------|
|                               |                                              | PW (TSSOP)   |      |
|                               |                                              | 20 PINS      |      |
| $R_{\theta JA}$               | Junction-to-ambient thermal resistance       | 94.9         | °C/W |
| $R_{\theta JC(top)}$          | Junction-to-case (top) thermal resistance    | 34.9         | °C/W |
| $R_{\theta JB}$               | Junction-to-board thermal resistance         | 46.4         | °C/W |
| $\Psi_{JT}$                   | Junction-to-top characterization parameter   | 2.7          | °C/W |
| $\Psi_{JB}$                   | Junction-to-board characterization parameter | 46.0         | °C/W |
| $R_{\theta JC(bot)}$          | Junction-to-case (bottom) thermal resistance | N/A          | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.5 Electrical Characteristics

minimum and maximum specifications apply from  $T_A = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ ; typical specifications are at  $T_A = 25^{\circ}\text{C}$ ; all specifications are at  $\text{AVDD} = 3\text{ V}$ ,  $\text{DVDD} = 3\text{ V}$ ,  $f_{\text{CLKIN}} = 8.192\text{ MHz}$ , data rate = 4 kSPS, all channels enabled, global-chop mode disabled and gain = 1 (unless otherwise noted)

| PARAMETER               |                                  | TEST CONDITIONS                                                                                                                   | MIN                         | TYP               | MAX               | UNIT |
|-------------------------|----------------------------------|-----------------------------------------------------------------------------------------------------------------------------------|-----------------------------|-------------------|-------------------|------|
| ANALOG INPUTS           |                                  |                                                                                                                                   |                             |                   |                   |      |
| I <sub>B</sub>          | Input bias current               | Gain = 1, 2, or 4, V <sub>INP</sub> = V <sub>INN</sub> = 0 V, I <sub>B</sub> = (I <sub>BP</sub> + I <sub>BN</sub> ) / 2           | 0.6                         |                   | μA                |      |
|                         | Input bias current               | Gain = 8, 16, 32, 64 or 128, V <sub>INP</sub> = V <sub>INN</sub> = 0 V, I <sub>B</sub> = (I <sub>BP</sub> + I <sub>BN</sub> ) / 2 | 0.2                         |                   |                   |      |
| Z <sub>in</sub>         | Differential input impedance     | Gain = 1, 2, or 4                                                                                                                 | 300                         |                   | kΩ                |      |
|                         |                                  | Gain = 8, 16, 32, 64, or 128                                                                                                      | ±1 <sup>(1)</sup>           |                   | μA/V              |      |
| ADC CHARACTERISTICS     |                                  |                                                                                                                                   |                             |                   |                   |      |
|                         | Resolution                       |                                                                                                                                   | 24                          |                   | Bits              |      |
|                         | Gain settings                    |                                                                                                                                   | 1, 2, 4, 8, 16, 32, 64, 128 |                   |                   |      |
| f <sub>DATA</sub>       | Data rate                        | High-resolution mode, f <sub>CLKIN</sub> = 8.192 MHz                                                                              | 250                         | 64k               |                   | SPS  |
|                         |                                  | Low-power mode, f <sub>CLKIN</sub> = 4.096 MHz                                                                                    | 125                         | 32k               |                   |      |
|                         |                                  | Very-low-power mode, f <sub>CLKIN</sub> = 2.048 MHz                                                                               | 62.5                        | 16k               |                   |      |
|                         | Startup time                     | Measured from supplies at 90% to first DRDY falling edge                                                                          | 0.5                         |                   | ms                |      |
| ADC PERFORMANCE         |                                  |                                                                                                                                   |                             |                   |                   |      |
| INL                     | Integral nonlinearity (best fit) |                                                                                                                                   | 6                           |                   | ppm of FSR        |      |
|                         | Offset error (input referred)    |                                                                                                                                   | ±175                        |                   | μV                |      |
|                         |                                  | Global-chop mode, channel 0                                                                                                       | ±35                         |                   |                   |      |
|                         |                                  | Global-chop mode, channels 1-3                                                                                                    | ±15                         |                   |                   |      |
|                         | Offset drift                     |                                                                                                                                   | 300                         |                   | nV/°C             |      |
|                         |                                  | Global-chop mode                                                                                                                  | 200                         |                   |                   |      |
|                         | Offset error time drift          | 1000 hours at 85°C                                                                                                                | 4                           |                   | μV                |      |
|                         | Gain error                       |                                                                                                                                   | ±0.1%                       |                   |                   |      |
|                         | Gain drift                       |                                                                                                                                   | 1                           |                   | ppm/°C            |      |
|                         |                                  | Including internal reference                                                                                                      | 8.5                         |                   |                   |      |
|                         | Gain error time drift            | 1000 hours at 85°C                                                                                                                | 400                         |                   | ppm               |      |
| CMRR                    | Common-mode rejection ratio      | At dc                                                                                                                             | 100                         |                   | dB                |      |
|                         |                                  | f <sub>CM</sub> = 50 Hz or 60 Hz                                                                                                  | 94                          |                   |                   |      |
| PSRR                    | Power-supply rejection ratio     | AVDD at dc                                                                                                                        | 75                          |                   | dB                |      |
|                         |                                  | DVDD at dc                                                                                                                        | 88                          |                   |                   |      |
|                         |                                  | AVDD supply, f <sub>PS</sub> = 50 Hz or 60 Hz                                                                                     | 78                          |                   |                   |      |
|                         |                                  | DVDD supply, f <sub>PS</sub> = 50 Hz or 60 Hz                                                                                     | 85                          |                   |                   |      |
|                         | Input-referred noise             |                                                                                                                                   | 5.35                        |                   | μV <sub>RMS</sub> |      |
| During fast-startup     |                                  | 1.5                                                                                                                               |                             | mV <sub>RMS</sub> |                   |      |
|                         | Dynamic range                    | Gain = 1                                                                                                                          | 99                          | 102               | dB                |      |
| Gain = 64               |                                  | 80                                                                                                                                |                             |                   |                   |      |
| All other gain settings |                                  | See <a href="#">Table 7-1</a>                                                                                                     |                             |                   |                   |      |
|                         | Crosstalk                        | f <sub>IN</sub> = 50 Hz or 60 Hz                                                                                                  | −120                        |                   | dB                |      |
| SNR                     | Signal-to-noise ratio            | f <sub>IN</sub> = 50 Hz or 60 Hz, gain = 1, V <sub>IN</sub> = −0.5 dBFS, normalized                                               | 100                         |                   | dB                |      |
|                         |                                  | f <sub>IN</sub> = 50 Hz or 60 Hz, gain = 64, V <sub>IN</sub> = −0.5 dBFS, normalized                                              | 79                          |                   |                   |      |

## 6.5 Electrical Characteristics (continued)

minimum and maximum specifications apply from  $T_A = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ ; typical specifications are at  $T_A = 25^{\circ}\text{C}$ ; all specifications are at  $AVDD = 3\text{ V}$ ,  $DVDD = 3\text{ V}$ ,  $f_{CLKIN} = 8.192\text{ MHz}$ , data rate = 4 kSPS, all channels enabled, global-chop mode disabled and gain = 1 (unless otherwise noted)

| PARAMETER                         |                                       | TEST CONDITIONS                                                                              | MIN      | TYP         | MAX      | UNIT                    |
|-----------------------------------|---------------------------------------|----------------------------------------------------------------------------------------------|----------|-------------|----------|-------------------------|
| THD                               | Total harmonic distortion             | $f_{IN} = 50\text{ Hz or }60\text{ Hz (up to 50 harmonics)},$<br>$V_{IN} = -0.5\text{ dBFS}$ |          | -100        |          | dB                      |
| SFDR                              | Spurious-free dynamic range           | $f_{IN} = 50\text{ Hz or }60\text{ Hz (up to 50 harmonics)},$<br>$V_{IN} = -0.5\text{ dBFS}$ |          | 105         |          | dB                      |
| <b>INTERNAL VOLTAGE REFERENCE</b> |                                       |                                                                                              |          |             |          |                         |
| $V_{REF}$                         | Internal reference voltage            |                                                                                              |          | 1.2         |          | V                       |
|                                   | Accuracy                              | $T_A = 25^{\circ}\text{C}$                                                                   |          | $\pm 0.1\%$ |          |                         |
|                                   | Temperature drift                     |                                                                                              |          | 7.5         | 20       | ppm/ $^{\circ}\text{C}$ |
| <b>DIGITAL INPUTS/OUTPUTS</b>     |                                       |                                                                                              |          |             |          |                         |
| $V_{IL}$                          | Logic input level, low                |                                                                                              | DGND     |             | 0.2 DVDD | V                       |
| $V_{IH}$                          | Logic input level, high               |                                                                                              | 0.8 DVDD |             | DVDD     | V                       |
| $V_{OL}$                          | Logic output level, low               | $I_{OL} = -1\text{ mA}$                                                                      |          |             | 0.2 DVDD | V                       |
| $V_{OH}$                          | Logic output level, high              | $I_{OH} = 1\text{ mA}$                                                                       | 0.8 DVDD |             |          | V                       |
| $I_{IN}$                          | Input current                         | $DGND < V_{Digital\ Input} < DVDD$                                                           | -1       |             | 1        | $\mu\text{A}$           |
| <b>POWER SUPPLY</b>               |                                       |                                                                                              |          |             |          |                         |
| $I_{AVDD}$                        | Analog supply current                 | High-resolution mode                                                                         |          | 3.5         | 4.0      | mA                      |
|                                   |                                       | Low-power mode                                                                               |          | 2.0         | 2.2      |                         |
|                                   |                                       | Very-low-power mode                                                                          |          | 1.0         | 1.2      |                         |
|                                   |                                       | Current-detect mode                                                                          |          | 0.9         |          | mA                      |
|                                   |                                       | Standby mode                                                                                 |          | 0.3         |          | $\mu\text{A}$           |
| $I_{DVDD}$                        | Digital supply current <sup>(2)</sup> | High-resolution mode                                                                         |          | 0.4         | 0.5      | mA                      |
|                                   |                                       | Low-power mode                                                                               |          | 0.2         | 0.3      |                         |
|                                   |                                       | Very-low-power mode                                                                          |          | 0.1         | 0.2      |                         |
|                                   |                                       | Current-detect mode                                                                          |          | 0.065       |          | mA                      |
|                                   |                                       | Standby mode                                                                                 |          | 1           |          | $\mu\text{A}$           |
| $P_D$                             | Power dissipation                     | High-resolution mode                                                                         |          | 12          |          | mW                      |
|                                   |                                       | Low-power mode                                                                               |          | 6.6         |          |                         |
|                                   |                                       | Very-low-power mode                                                                          |          | 3.3         |          |                         |
|                                   |                                       | Current-detect mode                                                                          |          | 2.9         |          |                         |
|                                   |                                       | Standby mode                                                                                 |          | 3.9         |          | $\mu\text{W}$           |

(1) Specified in  $\mu\text{A/V}$  because current can flow either into or out of the input pin.

(2) Currents measured with SPI idle.

## 6.6 Timing Requirements

over operating ambient temperature range, DOUT load: 20 pF || 100 kΩ (unless otherwise noted)

|                              |                                                                       | MIN  | MAX  | UNIT               |
|------------------------------|-----------------------------------------------------------------------|------|------|--------------------|
| <b>1.65 V ≤ DVDD ≤ 2.0 V</b> |                                                                       |      |      |                    |
| t <sub>w</sub> (CLH)         | Pulse duration, CLKIN high                                            | 49   |      | ns                 |
| t <sub>w</sub> (CLL)         | Pulse duration, CLKIN low                                             | 49   |      | ns                 |
| t <sub>c</sub> (SC)          | SCLK period                                                           | 64   |      | ns                 |
| t <sub>w</sub> (SCL)         | Pulse duration, SCLK low                                              | 32   |      | ns                 |
| t <sub>w</sub> (SCH)         | Pulse duration, SCLK high                                             | 32   |      | ns                 |
| t <sub>d</sub> (CSSC)        | Delay time, first SCLK rising edge after $\overline{CS}$ falling edge | 16   |      | ns                 |
| t <sub>d</sub> (SCCS)        | Delay time, $\overline{CS}$ rising edge after final SCLK falling edge | 10   |      | ns                 |
| t <sub>w</sub> (CSH)         | Pulse duration, $\overline{CS}$ high                                  | 20   |      | ns                 |
| t <sub>su</sub> (DI)         | Setup time, DIN valid before SCLK falling edge                        | 5    |      | ns                 |
| t <sub>h</sub> (DI)          | Hold time, DIN valid after SCLK falling edge                          | 8    |      | ns                 |
| t <sub>w</sub> (RSL)         | Pulse duration, $\overline{SYNC/RESET}$ low to generate device reset  | 2048 |      | t <sub>CLKIN</sub> |
| t <sub>w</sub> (SYL)         | Pulse duration, $\overline{SYNC/RESET}$ low for synchronization       | 1    | 2047 | t <sub>CLKIN</sub> |
| t <sub>su</sub> (SY)         | Setup time, $\overline{SYNC/RESET}$ valid before CLKIN rising edge    | 10   |      | ns                 |
| <b>2.7 V ≤ DVDD ≤ 3.6 V</b>  |                                                                       |      |      |                    |
| t <sub>w</sub> (CLL)         | Pulse duration, CLKIN low                                             | 49   |      | ns                 |
| t <sub>w</sub> (CLH)         | Pulse duration, CLKIN high                                            | 49   |      | ns                 |
| t <sub>c</sub> (SC)          | SCLK period                                                           | 40   |      | ns                 |
| t <sub>w</sub> (SCL)         | Pulse duration, SCLK low                                              | 20   |      | ns                 |
| t <sub>w</sub> (SCH)         | Pulse duration, SCLK high                                             | 20   |      | ns                 |
| t <sub>d</sub> (CSSC)        | Delay time, first SCLK rising edge after $\overline{CS}$ falling edge | 16   |      | ns                 |
| t <sub>d</sub> (SCCS)        | Delay time, $\overline{CS}$ rising edge after final SCLK falling edge | 10   |      | ns                 |
| t <sub>w</sub> (CSH)         | Pulse duration, $\overline{CS}$ high                                  | 15   |      | ns                 |
| t <sub>su</sub> (DI)         | Setup time, DIN valid before SCLK falling edge                        | 5    |      | ns                 |
| t <sub>h</sub> (DI)          | Hold time, DIN valid after SCLK falling edge                          | 8    |      | ns                 |
| t <sub>w</sub> (RSL)         | Pulse duration, $\overline{SYNC/RESET}$ low to generate device reset  | 2048 |      | t <sub>CLKIN</sub> |
| t <sub>w</sub> (SYL)         | Pulse duration, $\overline{SYNC/RESET}$ low for synchronization       | 1    | 2047 | t <sub>CLKIN</sub> |
| t <sub>su</sub> (SY)         | Setup time, $\overline{SYNC/RESET}$ valid before CLKIN rising edge    | 10   |      | ns                 |

## 6.7 Switching Characteristics

over operating ambient temperature range, DOUT load: 20 pF || 100 kΩ (unless otherwise noted)

| PARAMETER                    |                                                                            | TEST CONDITIONS                                                      | MIN   | TYP | MAX | UNIT               |
|------------------------------|----------------------------------------------------------------------------|----------------------------------------------------------------------|-------|-----|-----|--------------------|
| <b>1.65 V ≤ DVDD ≤ 2.0 V</b> |                                                                            |                                                                      |       |     |     |                    |
| t <sub>p</sub> (CSDO)        | Propagation delay time, $\overline{CS}$ falling edge to DOUT driven        |                                                                      |       |     | 50  | ns                 |
| t <sub>p</sub> (SCDO)        | Propagation delay time, SCLK rising edge to valid new DOUT                 |                                                                      |       |     | 32  | ns                 |
| t <sub>p</sub> (CSDOZ)       | Propagation delay time, $\overline{CS}$ rising edge to DOUT high impedance |                                                                      |       |     | 75  | ns                 |
| t <sub>w</sub> (DRH)         | Pulse duration, $\overline{DRDY}$ high                                     |                                                                      |       | 4   |     | t <sub>CLKIN</sub> |
| t <sub>w</sub> (DRL)         | Pulse duration, $\overline{DRDY}$ low                                      |                                                                      |       | 4   |     | t <sub>CLKIN</sub> |
|                              | SPI timeout                                                                |                                                                      | 32768 |     |     | t <sub>CLKIN</sub> |
| t <sub>POR</sub>             | Power-on-reset time                                                        | Measured from supplies at 90% to first $\overline{DRDY}$ rising edge |       | 250 |     | μs                 |
| t <sub>REGACQ</sub>          | Register default acquisition time                                          |                                                                      |       | 5   |     | μs                 |

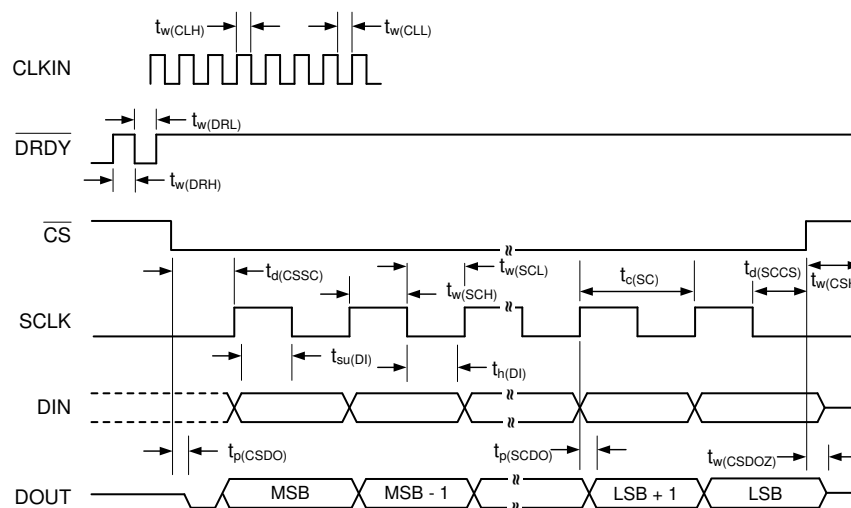


## 6.7 Switching Characteristics (continued)

over operating ambient temperature range, DOUT load: 20 pF || 100 kΩ (unless otherwise noted)

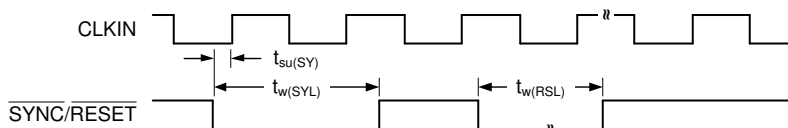
| PARAMETER                   |                                                                            | TEST CONDITIONS                                                      | MIN   | TYP | MAX | UNIT        |
|-----------------------------|----------------------------------------------------------------------------|----------------------------------------------------------------------|-------|-----|-----|-------------|
| <b>2.7 V ≤ DVDD ≤ 3.6 V</b> |                                                                            |                                                                      |       |     |     |             |
| $t_{p(CS\overline{DO})}$    | Propagation delay time, $\overline{CS}$ falling edge to DOUT driven        |                                                                      |       |     | 50  | ns          |
| $t_{p(SCDO)}$               | Propagation delay time, SCLK rising edge to valid new DOUT                 |                                                                      |       |     | 20  | ns          |
| $t_{p(CS\overline{DOZ})}$   | Propagation delay time, $\overline{CS}$ rising edge to DOUT high impedance |                                                                      |       |     | 75  | ns          |
| $t_{w(DRH)}$                | Pulse duration, $\overline{DRDY}$ high                                     |                                                                      |       | 4   |     | $t_{CLKIN}$ |
| $t_{w(DRL)}$                | Pulse duration, $\overline{DRDY}$ low                                      |                                                                      |       | 4   |     | $t_{CLKIN}$ |
|                             | SPI timeout                                                                |                                                                      | 32768 |     |     | $t_{CLKIN}$ |
| $t_{POR}$                   | Power-on-reset time                                                        | Measured from supplies at 90% to first $\overline{DRDY}$ rising edge |       | 250 |     | μs          |
| $t_{REGACQ}$                | Register default acquisition time                                          |                                                                      |       | 5   |     | μs          |

## 6.8 Timing Diagrams

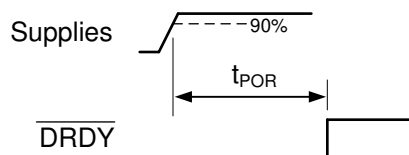


NOTE: SPI settings are CPOL = 0 and CPHA = 1.  $\overline{CS}$  transitions must take place when SCLK is low.

**Figure 6-1. SPI Timing Diagram**



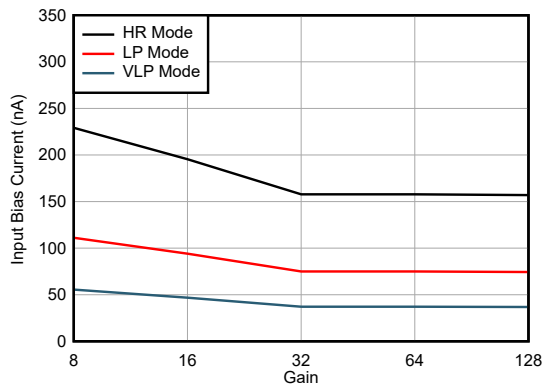
**Figure 6-2. SYNC/RESET Timing Requirements**



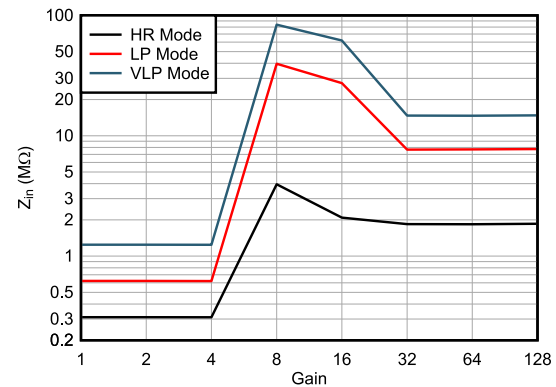
**Figure 6-3. Power-On-Reset Timing**

## 6.9 Typical Characteristics

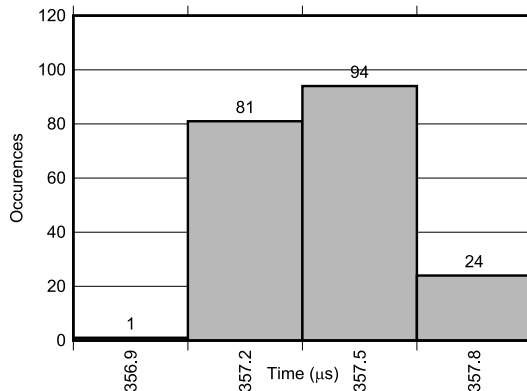
at  $T_A = 25^\circ\text{C}$ ,  $AVDD = 3\text{ V}$ ,  $DVDD = 3\text{ V}$ ,  $f_{\text{CLKIN}} = 8.192\text{ MHz}$ , data rate = 4 kSPS, and gain = 1 with global-chop mode disabled (unless otherwise noted)



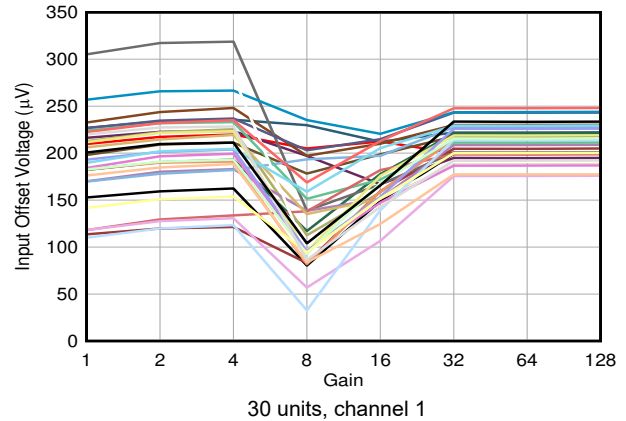
Gains of 8, 16, 32, 64, and 128 only  
**Figure 6-4. Input Bias Current vs Gain**



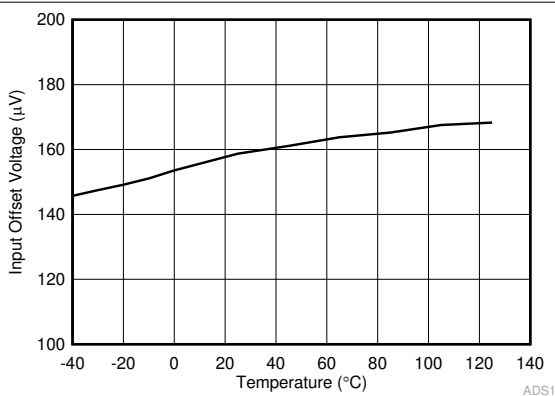
**Figure 6-5. Input Impedance vs Gain**



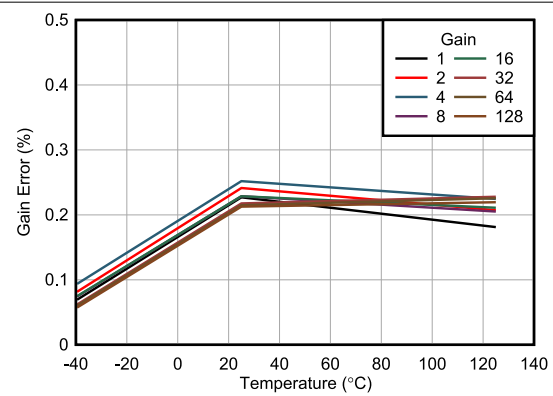
**Figure 6-6. Start-Up Time Histogram**



**Figure 6-7. Input Offset Voltage vs Gain**



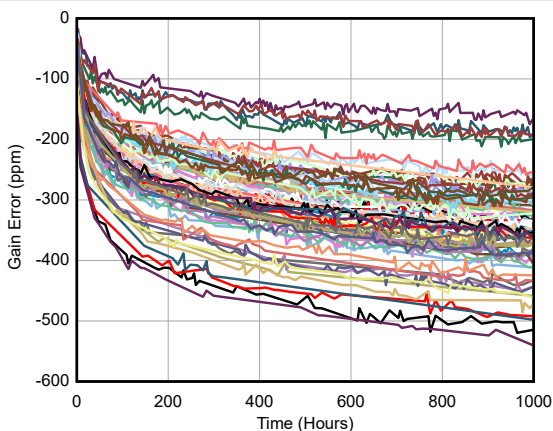
**Figure 6-8. Input Offset Voltage vs Temperature**



**Figure 6-9. Gain Error vs Temperature**

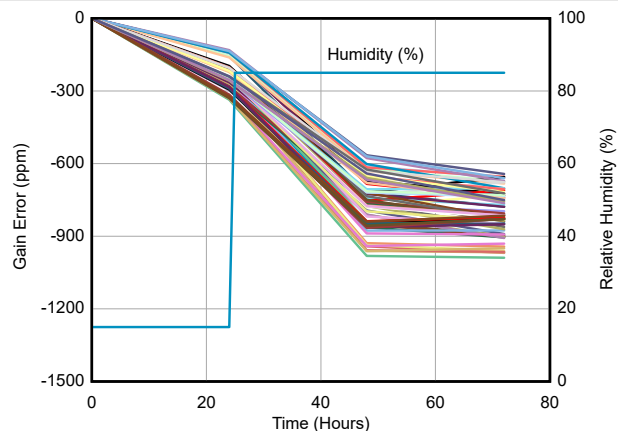
## 6.9 Typical Characteristics (continued)

at  $T_A = 25^\circ\text{C}$ ,  $AVDD = 3\text{ V}$ ,  $DVDD = 3\text{ V}$ ,  $f_{\text{CLKIN}} = 8.192\text{ MHz}$ , data rate = 4 kSPS, and gain = 1 with global-chop mode disabled (unless otherwise noted)



18 units, all channels

Figure 6-10. Gain Error vs Time



18 units, all channels

Figure 6-11. Gain Error vs Time Across Humidity

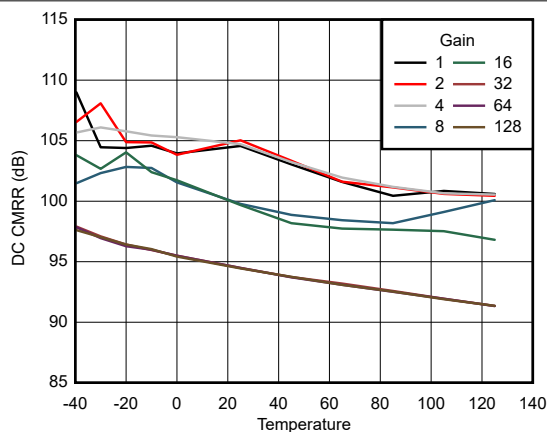


Figure 6-12. DC CMRR vs Temperature

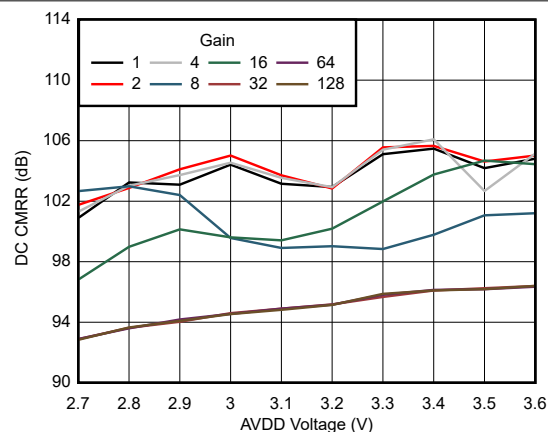


Figure 6-13. DC CMRR vs AVDD Voltage

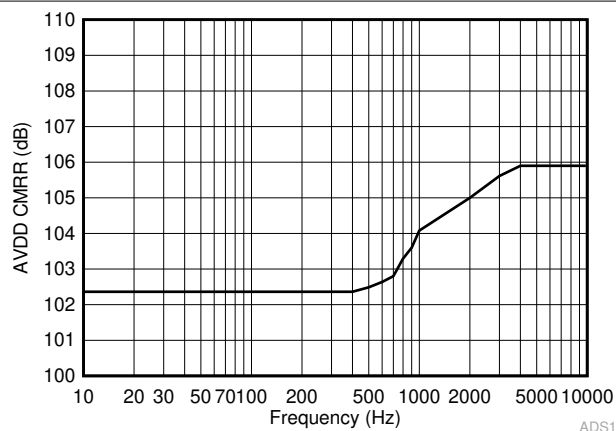


Figure 6-14. AVDD CMRR vs Frequency

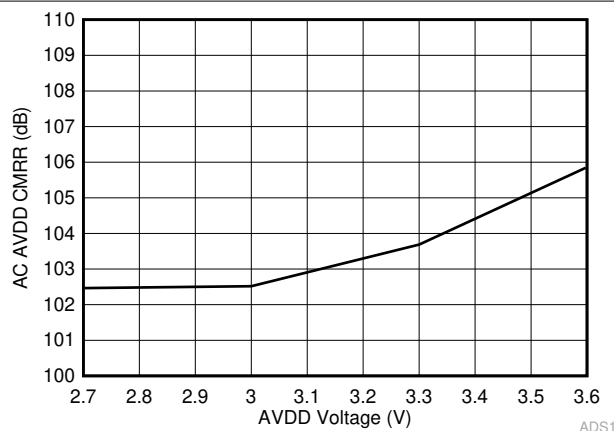


Figure 6-15. AC CMRR vs AVDD Voltage

## 6.9 Typical Characteristics (continued)

at  $T_A = 25^\circ\text{C}$ ,  $AVDD = 3\text{ V}$ ,  $DVDD = 3\text{ V}$ ,  $f_{\text{CLKIN}} = 8.192\text{ MHz}$ , data rate = 4 kSPS, and gain = 1 with global-chop mode disabled (unless otherwise noted)

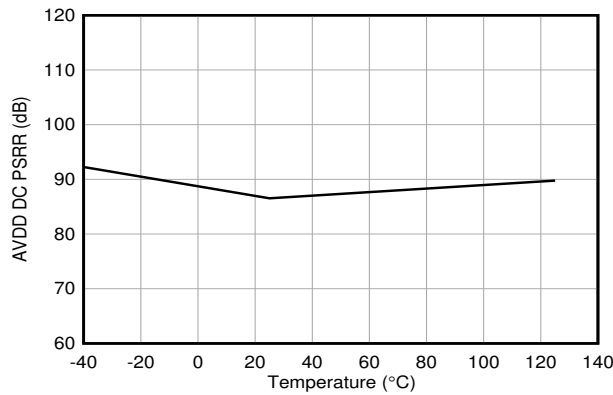


Figure 6-16. DC AVDD PSRR vs Temperature

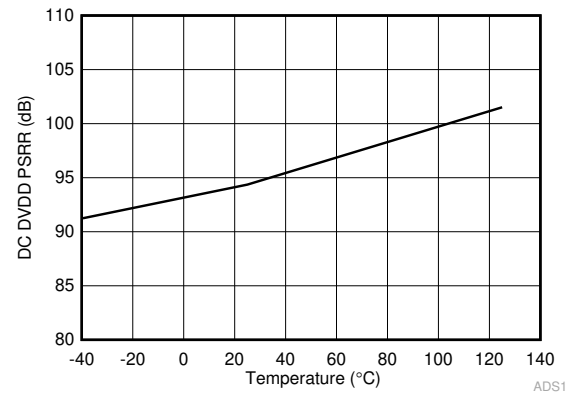


Figure 6-17. DC DVDD PSRR vs Temperature

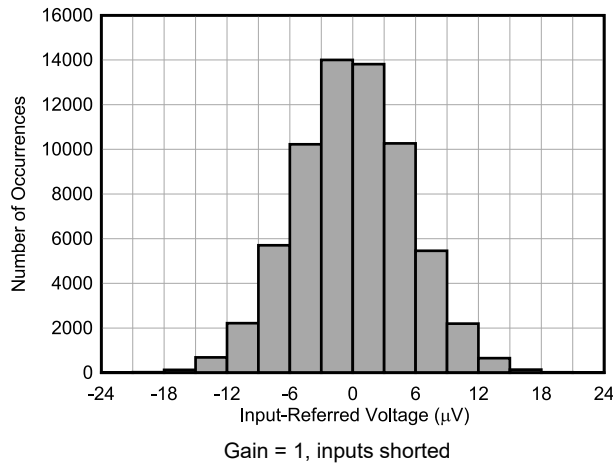


Figure 6-18. Single Device Noise Histogram at 4 kSPS

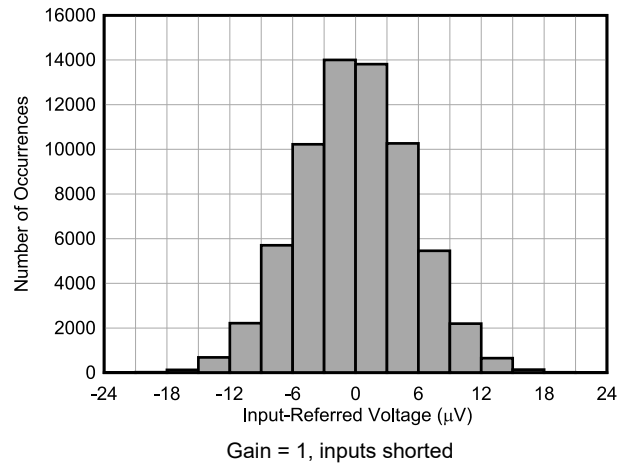


Figure 6-19. Single Device Noise Histogram at 32 kSPS

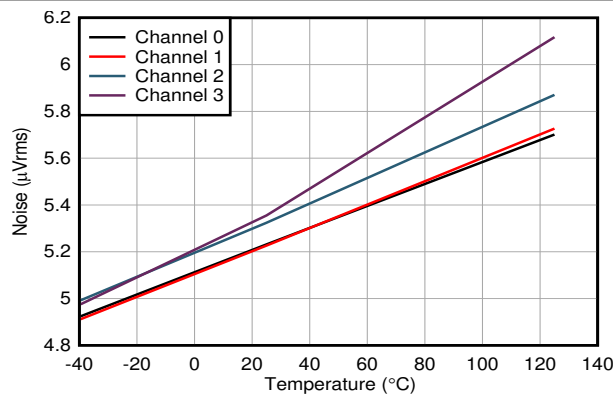


Figure 6-20. Noise vs Temperature

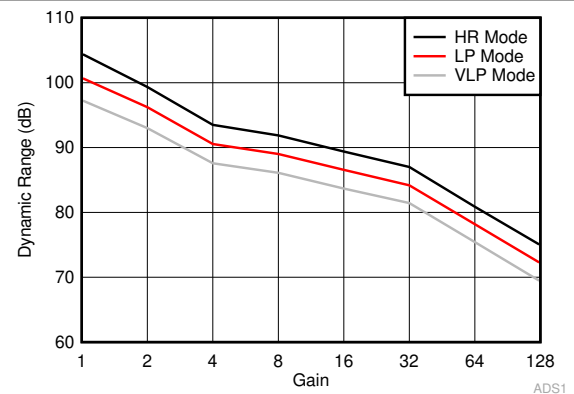


Figure 6-21. Dynamic Range at 4 kSPS vs Gain

## 6.9 Typical Characteristics (continued)

at  $T_A = 25^\circ\text{C}$ ,  $AVDD = 3\text{ V}$ ,  $DVDD = 3\text{ V}$ ,  $f_{CLKIN} = 8.192\text{ MHz}$ , data rate = 4 kSPS, and gain = 1 with global-chop mode disabled (unless otherwise noted)

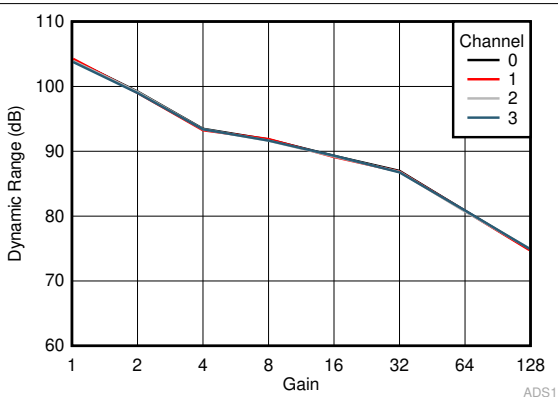


Figure 6-22. Dynamic Range vs Gain

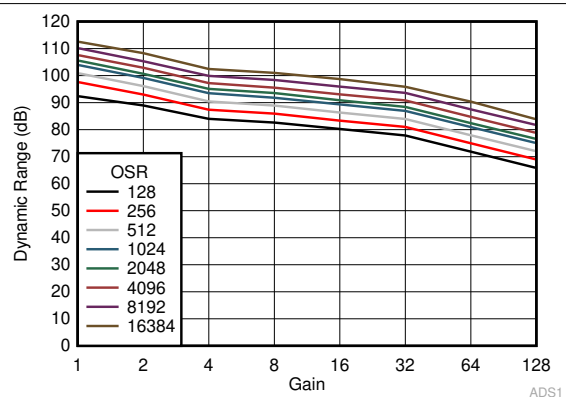


Figure 6-23. Dynamic Range vs Gain

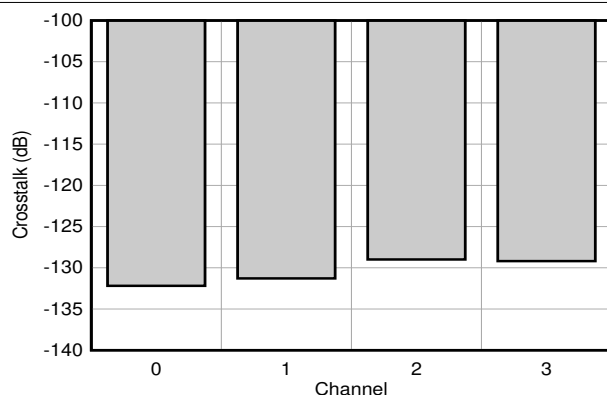


Figure 6-24. Crosstalk vs Channel

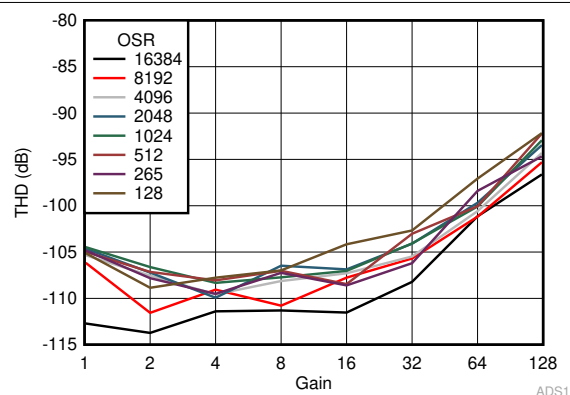


Figure 6-25. THD vs Gain

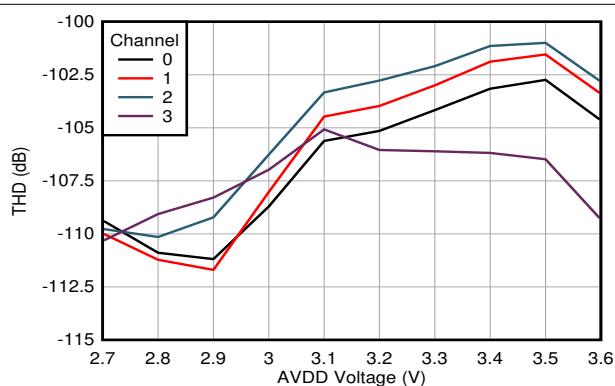


Figure 6-26. THD vs AVDD Voltage

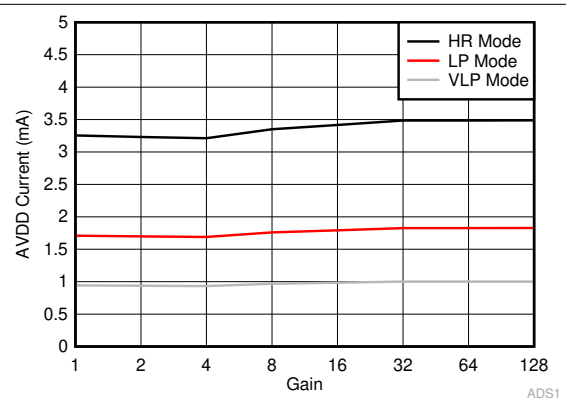


Figure 6-27. AVDD Current vs Gain

## 6.9 Typical Characteristics (continued)

at  $T_A = 25^\circ\text{C}$ ,  $AVDD = 3\text{ V}$ ,  $DVDD = 3\text{ V}$ ,  $f_{\text{CLKIN}} = 8.192\text{ MHz}$ , data rate = 4 kSPS, and gain = 1 with global-chop mode disabled (unless otherwise noted)

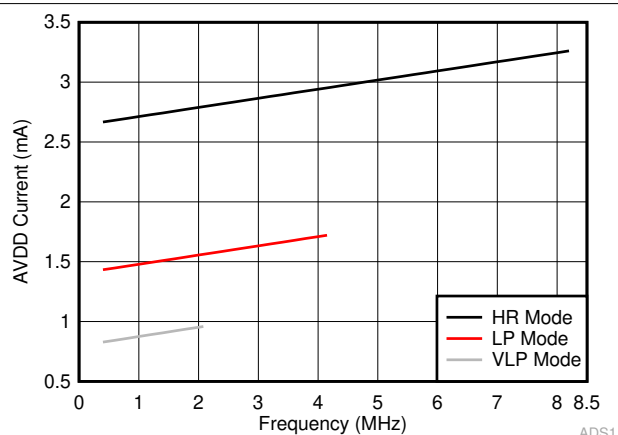


Figure 6-28. AVDD Current vs CLKIN Frequency

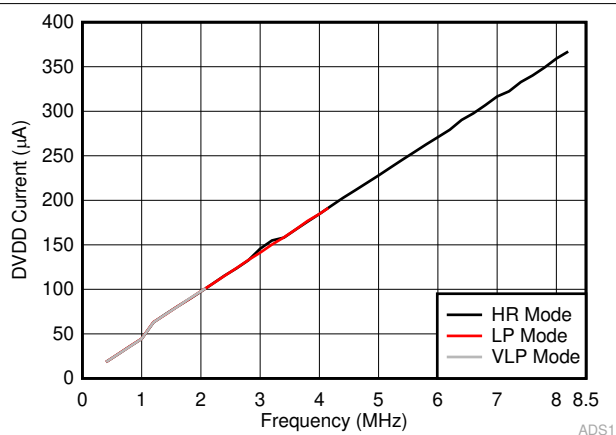


Figure 6-29. DVDD Current vs CLKIN Frequency

## 7 Parameter Measurement Information

### 7.1 Noise Measurements

Adjust the data rate and gain to optimize the ADS131M04-Q1 noise performance. When averaging is increased by reducing the data rate, noise drops correspondingly. [Table 7-1](#) summarizes the ADS131M04-Q1 noise performance using the 1.2-V internal reference and a 3.0-V analog power supply. The data are representative of typical noise performance at  $T_A = 25^\circ\text{C}$  when  $f_{\text{CLKIN}} = 8.192\text{ MHz}$ . The modulator clock frequency  $f_{\text{MOD}}$  is equal to  $f_{\text{CLKIN}} / 2$ . The data shown are typical input-referred noise results with the analog inputs shorted together and taking an average of multiple readings across all channels. A minimum 1 second of consecutive readings are used to calculate the RMS. [Table 7-2](#) shows the dynamic range and effective resolution calculated from the noise data. [Equation 1](#) calculates dynamic range. [Equation 2](#) calculates effective resolution. In each case,  $V_{\text{REF}}$  corresponds to the internal 1.2-V reference. In global-chop mode, noise is improved by a factor of  $\sqrt{2}$ .

The noise performance scales with the OSR and gain settings, but is independent from the configured power mode. Thus, the device exhibits the same noise performance in different power modes when selecting the same OSR and gain settings. However, the data rate at the OSR settings scales based on the applied clock frequency for the different power modes.

$$\text{Dynamic Range} = 20 \times \log \left( \frac{V_{\text{REF}}}{\sqrt{2} \times \text{Gain} \times V_{\text{RMS}}} \right) \quad (1)$$

$$\text{Effective Resolution} = \log_2 \left( \frac{2 \times V_{\text{REF}}}{\text{Gain} \times V_{\text{RMS}}} \right) \quad (2)$$

**Table 7-1. Noise ( $\mu\text{V}_{\text{RMS}}$ ) at  $T_A = 25^\circ\text{C}$**

| OSR   | DATA RATE (kSPS),<br>$f_{\text{CLKIN}} = 8.192\text{ MHz}$ | GAIN  |       |       |       |      |      |      |      |
|-------|------------------------------------------------------------|-------|-------|-------|-------|------|------|------|------|
|       |                                                            | 1     | 2     | 4     | 8     | 16   | 32   | 64   | 128  |
| 16384 | 0.25                                                       | 1.90  | 1.69  | 1.56  | 0.95  | 0.64 | 0.42 | 0.42 | 0.42 |
| 8192  | 0.5                                                        | 2.39  | 2.13  | 2.13  | 1.29  | 0.86 | 0.57 | 0.57 | 0.57 |
| 4096  | 1                                                          | 3.38  | 2.99  | 2.88  | 1.74  | 1.17 | 0.77 | 0.77 | 0.77 |
| 2048  | 2                                                          | 4.25  | 3.91  | 3.79  | 2.27  | 1.52 | 1.00 | 1.00 | 1.00 |
| 1024  | 4                                                          | 5.35  | 4.68  | 4.52  | 2.70  | 1.82 | 1.20 | 1.20 | 1.20 |
| 512   | 8                                                          | 7.56  | 6.62  | 6.37  | 3.82  | 2.55 | 1.69 | 1.69 | 1.69 |
| 256   | 16                                                         | 10.68 | 9.56  | 9.09  | 5.42  | 3.63 | 2.39 | 2.39 | 2.40 |
| 128   | 32                                                         | 21.31 | 15.26 | 13.52 | 7.89  | 5.21 | 3.41 | 3.42 | 3.42 |
| 64    | 64                                                         | 75.34 | 41.63 | 26.84 | 14.59 | 8.9  | 5.57 | 5.58 | 5.58 |

**Table 7-2. Dynamic Range (Effective Resolution) at  $T_A = 25^\circ\text{C}$**

| OSR   | DATA RATE (kSPS),<br>$f_{\text{CLKIN}} = 8.192\text{ MHz}$ | GAIN       |            |            |            |           |           |           |           |
|-------|------------------------------------------------------------|------------|------------|------------|------------|-----------|-----------|-----------|-----------|
|       |                                                            | 1          | 2          | 4          | 8          | 16        | 32        | 64        | 128       |
| 16384 | 0.25                                                       | 113 (20.3) | 108 (19.4) | 103 (18.6) | 101 (18.3) | 98 (17.8) | 96 (17.5) | 90 (16.5) | 84 (15.4) |
| 8192  | 0.5                                                        | 111 (19.9) | 106 (19.1) | 100 (18.1) | 98 (17.8)  | 96 (17.4) | 93 (17.0) | 87 (16.0) | 81 (15.0) |
| 4096  | 1                                                          | 108 (19.4) | 103 (18.6) | 97 (17.7)  | 96 (17.4)  | 93 (17.0) | 91 (16.6) | 85 (15.6) | 79 (14.6) |
| 2048  | 2                                                          | 106 (19.1) | 101 (18.2) | 95 (17.3)  | 93 (17.0)  | 91 (16.6) | 88 (16.2) | 82 (15.2) | 76 (14.2) |
| 1024  | 4                                                          | 104 (18.8) | 99 (18.0)  | 93 (17.0)  | 92 (16.8)  | 89 (16.3) | 87 (15.9) | 81 (14.9) | 75 (13.9) |
| 512   | 8                                                          | 101 (18.3) | 96 (17.5)  | 90 (16.5)  | 89 (16.3)  | 86 (15.8) | 84 (15.4) | 78 (14.4) | 72 (13.4) |
| 256   | 16                                                         | 98 (17.8)  | 93 (16.9)  | 87 (16.0)  | 86 (15.8)  | 83 (15.3) | 81 (14.9) | 75 (13.9) | 69 (12.9) |
| 128   | 32                                                         | 92 (16.8)  | 89 (16.3)  | 84 (15.4)  | 83 (15.2)  | 80 (14.8) | 78 (14.4) | 72 (13.4) | 65 (12.4) |
| 64    | 64                                                         | 81 (15.0)  | 80 (14.8)  | 78 (14.4)  | 77 (14.3)  | 75 (14.0) | 74 (13.7) | 68 (12.7) | 62 (11.7) |



## 8 Detailed Description

### 8.1 Overview

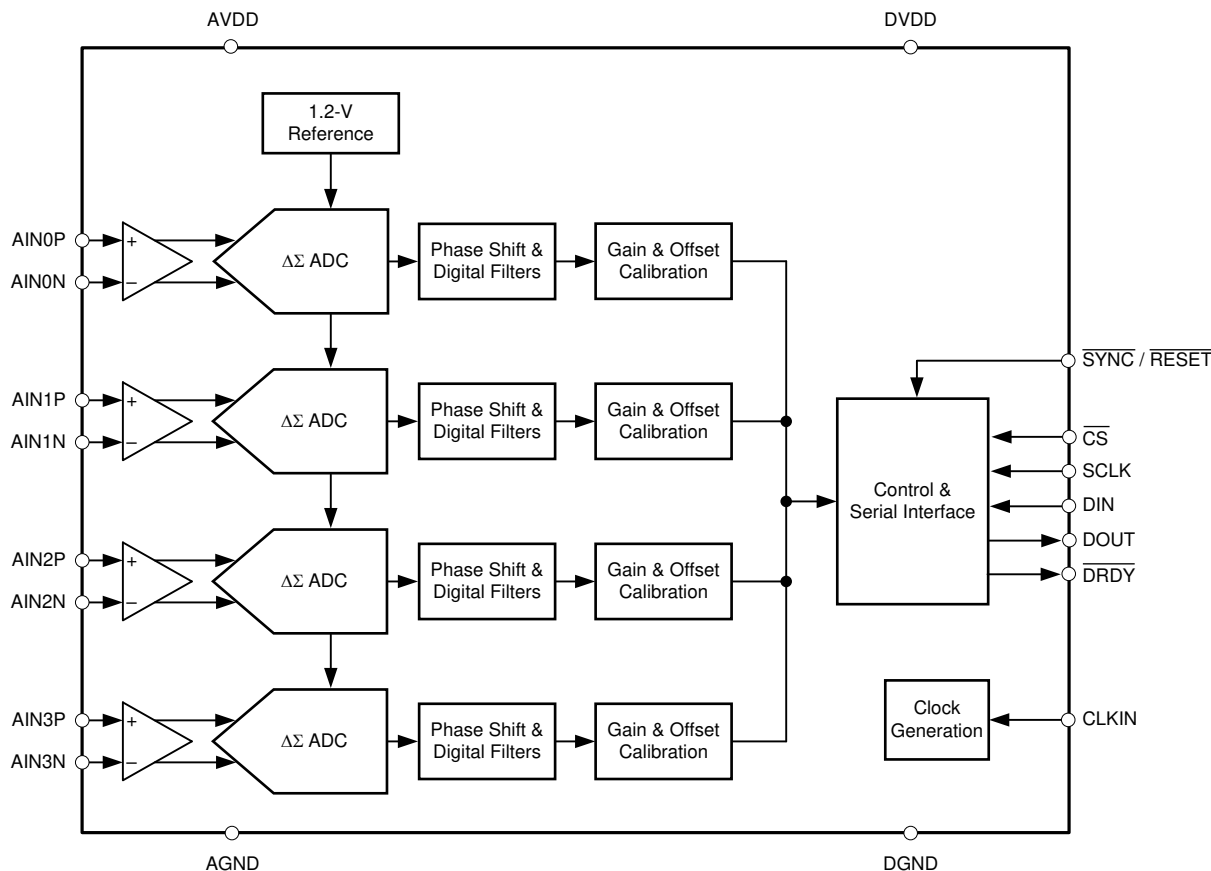
The ADS131M04-Q1 is a low-power, four-channel, simultaneous-sampling, 24-bit, delta-sigma ( $\Delta\Sigma$ ) analog-to-digital converter (ADC) with a low-drift internal reference voltage. The dynamic range, size, feature set, and power consumption are optimized for cost-sensitive applications requiring simultaneous-sampling.

The ADS131M04-Q1 requires both analog and digital supplies. The analog power supply (AVDD – AGND) can operate between 2.7 V and 3.6 V. An integrated negative charge pump allows absolute input voltages as low as 1.3 V below AGND, which enables measurements of input signals varying around ground with a single-ended power supply. The digital power supply (DVDD – DGND) accepts both 1.8-V and 3.3-V supplies. The device features a programmable gain amplifier (PGA) with gains up to 128. An integrated input precharge buffer enabled at gains greater than 4 ensures high input impedance at high PGA gain settings. The ADC receives the reference voltage from an integrated 1.2-V reference. The device allows differential input voltages as large as the reference. Three power-scaling modes allow designers to trade power consumption for ADC dynamic range.

Each channel on the ADS131M04-Q1 contains a digital decimation filter that demodulates the output of the  $\Delta\Sigma$  modulators. The filter enables data rates as high as 32 kSPS per channel in high-resolution mode. The relative phase of the samples can be configured between channels, thus enabling an accurate compensation for the sensor phase response. Offset and gain calibration registers can be programmed to automatically adjust output samples for measured offset and gain errors. The [Functional Block Diagram](#) provides a detailed diagram of the ADS131M04-Q1.

The device communicates via a serial programming interface (SPI)-compatible interface. Several SPI commands and internal registers control the operation of the ADS131M04-Q1. Other devices can be added to the same SPI bus by adding discrete  $\overline{\text{CS}}$  control lines. The  $\overline{\text{SYNC/RESET}}$  pin can be used to synchronize conversions between multiple ADS131M04-Q1 devices as well as to maintain synchronization with external events.

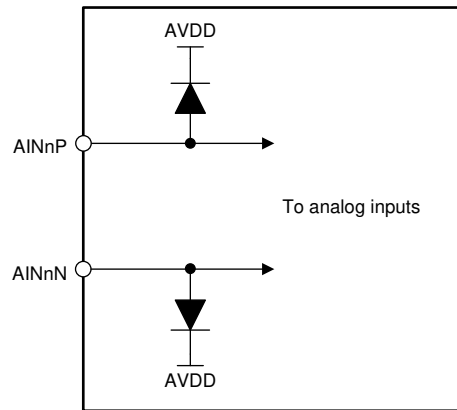
### 8.2 Functional Block Diagram



## 8.3 Feature Description

### 8.3.1 Input ESD Protection Circuitry

Basic electrostatic discharge (ESD) circuitry protects the ADS131M04-Q1 inputs from ESD and overvoltage events in conjunction with external circuits and assemblies. [Figure 8-1](#) depicts a simplified representation of the ESD circuit. The protection for input voltages exceeding AVDD can be modeled as a simple diode.



**Figure 8-1. Input ESD Protection Circuitry**

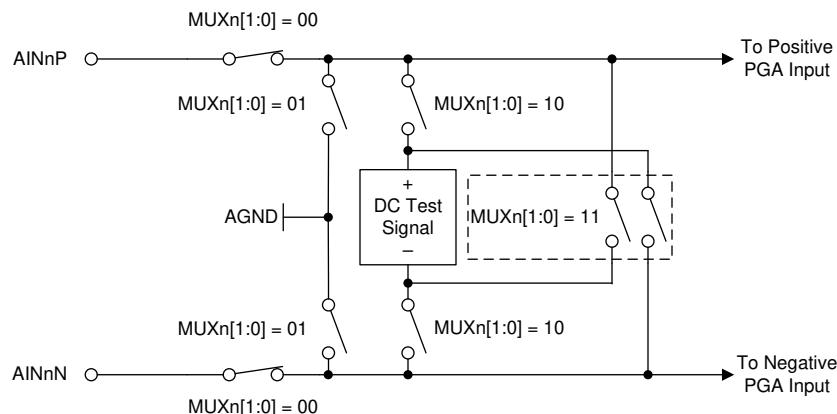
The ADS131M04-Q1 has an integrated negative charge pump that allows for input voltages below AGND with a unipolar supply. Consequently, shunt diodes between the inputs and AGND cannot be used to clamp excessive negative input voltages. Instead, the same diode that clamps overvoltage is used to clamp undervoltage at the reverse breakdown voltage. Take care to prevent input voltages or currents from exceeding the limits provided in the [Absolute Maximum Ratings](#) table.

### 8.3.2 Input Multiplexer

Each channel of the ADS131M04-Q1 has a dedicated input multiplexer. The multiplexer controls which signals are routed to the ADC channels. Configure the input multiplexer using the MUXn[1:0] bits in the CHn\_CFG register. The input multiplexer allows the following inputs to be connected to the ADC channel:

- The analog input pins corresponding to the given channel
- AGND, which is helpful for offset calibration
- Positive DC test signal
- Negative DC test signal

See the [Internal Test Signals](#) section for more information about the test signals. [Figure 8-2](#) shows a diagram of the input multiplexer on the ADS131M04-Q1.



**Figure 8-2. Input Multiplexer**

### 8.3.3 Programmable Gain Amplifier (PGA)

Each channel of the ADS131M04-Q1 features an integrated programmable gain amplifier (PGA) that provides gains of 1, 2, 4, 8, 16, 32, 64, and 128. The gains for all channels are individually controlled by the PGAGAINn bits for each channel in the GAIN1 register.

Varying the PGA gain scales the differential full-scale input voltage range (FSR) of the ADC. Equation 3 describes the relationship between FSR and gain. Equation 3 uses the internal reference voltage, 1.2 V, as the scaling factor without accounting for gain error caused by tolerance in the reference voltage.

$$\text{FSR} = \pm 1.2 \text{ V} / \text{Gain} \quad (3)$$

Table 8-1 shows the corresponding full-scale ranges for each gain setting.

**Table 8-1. Full-Scale Range**

| GAIN SETTING | FSR       |
|--------------|-----------|
| 1            | ±1.2 V    |
| 2            | ±600 mV   |
| 4            | ±300 mV   |
| 8            | ±150 mV   |
| 16           | ±75 mV    |
| 32           | ±37.5 mV  |
| 64           | ±18.75 mV |
| 128          | ±9.375 mV |

The input impedance of the PGA dominates the input impedance characteristics of the ADS131M04-Q1. The PGA input impedance for gain settings up to 4 behaves according to Equation 4 without accounting for device tolerance and change over temperature. Minimize the output impedance of the circuit that drives the ADS131M04-Q1 inputs to obtain the best possible gain error, INL, and distortion performance.

$$330 \text{ k}\Omega \times 4.096 \text{ MHz} / f_{\text{MOD}} \quad (4)$$

where:

- $f_{\text{MOD}}$  is the  $\Delta\Sigma$  modulator frequency,  $f_{\text{CLKIN}} / 2$

The device uses an input precharge buffer for PGA gain settings of 8 and higher. The input impedance at these gain settings is very high. Specifying the input bias current for these gain settings is therefore more useful. A plot of input bias current for the high gain settings is provided in Figure 6-5.

### 8.3.4 Voltage Reference

The ADS131M04-Q1 uses an internally generated, low-drift, band-gap voltage to supply the reference for the ADC. The reference has a nominal voltage of 1.2 V, allowing the differential input voltage to swing from –1.2 V to 1.2 V. The reference circuitry starts up very quickly to accommodate the fast start-up feature of this device. The device waits until after the reference circuitry is fully settled before generating conversion data.

### 8.3.5 Clocking and Power Modes

An LVCMOS clock must be provided at the CLKIN pin continuously when the ADS131M04-Q1 is running in normal operation. The frequency of the clock can be scaled in conjunction with the power mode to provide a tradeoff between power consumption and dynamic range.

The PWR[1:0] bits in the CLOCK register allow the device to be configured in one of three power modes: high-resolution (HR) mode, low-power (LP) mode, and very low-power (VLP) mode. Changing the PWR[1:0] bits scales the internal bias currents to achieve the expected power levels. The external clock frequency must follow the guidance provided in the [Recommended Operating Conditions](#) table corresponding to the intended power mode in order for the device to perform according to the specification.

### 8.3.6 $\Delta\Sigma$ Modulator

The ADS131M04-Q1 uses a delta-sigma ( $\Delta\Sigma$ ) modulator to convert the analog input voltage to a one's density modulated digital bit-stream. The  $\Delta\Sigma$  modulator oversamples the input voltage at a frequency many times greater than the output data rate. The modulator frequency,  $f_{\text{MOD}}$ , of the ADS131M04-Q1 is equal to half the controller clock frequency, that is,  $f_{\text{MOD}} = f_{\text{CLKIN}} / 2$ .

The output of the modulator is fed back to the modulator input through a digital-to-analog converter (DAC) as a means of error correction. This feedback mechanism shapes the modulator quantization noise in the frequency domain to make the noise more dense at higher frequencies and less dense in the band of interest. The digital decimation filter following the  $\Delta\Sigma$  modulator significantly attenuates the out-of-band modulator quantization noise, allowing the device to provide excellent dynamic range.

### 8.3.7 Digital Filter

The  $\Delta\Sigma$  modulator bitstream feeds into a digital filter. The digital filter is a linear phase, finite impulse response (FIR), low-pass sinc-type filter that attenuates the out-of-band quantization noise of the  $\Delta\Sigma$  modulator. The digital filter demodulates the output of the  $\Delta\Sigma$  modulator by averaging. The data passing through the filter is decimated and downsampled, to reduce the rate at which data come out of the modulator ( $f_{\text{MOD}}$ ) to the output data rate ( $f_{\text{DATA}}$ ). The decimation factor is defined as per [Equation 5](#) and is called the *oversampling ratio (OSR)*.

$$\text{OSR} = f_{\text{MOD}} / f_{\text{DATA}} \quad (5)$$

The OSR is configurable and set by the OSR[2:0] bits in the CLOCK register. There are eight OSR settings in the ADS131M04-Q1, allowing eight different data rate settings for any given controller clock frequency. [Table 8-2](#) lists the OSR settings and their corresponding output data rates for the nominal CLKIN frequencies mentioned.

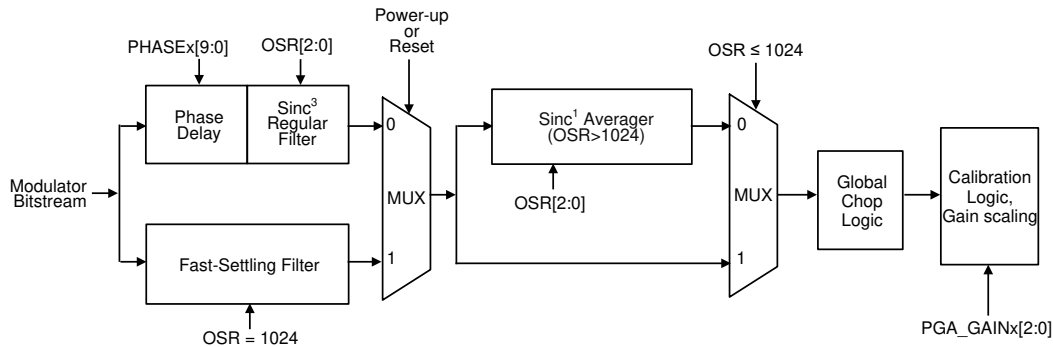
The OSR determines the amount of averaging of the modulator output in the digital filter and therefore also the filter bandwidth. The filter bandwidth directly affects the noise performance of the ADC because lower bandwidth results in lower noise whereas higher bandwidth results in higher noise. See [Table 7-1](#) for the noise specifications for various OSR settings.

**Table 8-2. OSR Settings and Data Rates for Nominal Controller Clock Frequencies**

| POWER MODE | NOMINAL CONTROLLER CLOCK FREQUENCY | $f_{MOD}$ | OSR   | OUTPUT DATA RATE |
|------------|------------------------------------|-----------|-------|------------------|
| HR         | 8.192 MHz                          | 4.096 MHz | 64    | 64 kSPS          |
|            |                                    |           | 128   | 32 kSPS          |
|            |                                    |           | 256   | 16 kSPS          |
|            |                                    |           | 512   | 8 kSPS           |
|            |                                    |           | 1024  | 4 kSPS           |
|            |                                    |           | 2048  | 2 kSPS           |
|            |                                    |           | 4096  | 1 kSPS           |
|            |                                    |           | 8192  | 500 SPS          |
|            |                                    |           | 16384 | 250 SPS          |
| LP         | 4.096 MHz                          | 2.048 MHz | 64    | 32 kSPS          |
|            |                                    |           | 128   | 16 kSPS          |
|            |                                    |           | 256   | 8 kSPS           |
|            |                                    |           | 512   | 4 kSPS           |
|            |                                    |           | 1024  | 2 kSPS           |
|            |                                    |           | 2048  | 1 kSPS           |
|            |                                    |           | 4096  | 500 SPS          |
|            |                                    |           | 8192  | 250 SPS          |
|            |                                    |           | 16384 | 125 SPS          |
| VLP        | 2.048 MHz                          | 1.024 MHz | 64    | 16 kSPS          |
|            |                                    |           | 128   | 8 kSPS           |
|            |                                    |           | 256   | 4 kSPS           |
|            |                                    |           | 512   | 2 kSPS           |
|            |                                    |           | 1024  | 1 kSPS           |
|            |                                    |           | 2048  | 500 SPS          |
|            |                                    |           | 4096  | 250 SPS          |
|            |                                    |           | 8192  | 125 SPS          |
|            |                                    |           | 16384 | 62.5 SPS         |

### 8.3.7.1 Digital Filter Implementation

Figure 8-3 shows the digital filter implementation of the ADS131M04-Q1. The modulator bit-stream feeds two parallel filter paths, a sinc<sup>3</sup> filter, and a fast-settling filter path.



**Figure 8-3. Digital Filter Implementation**

### 8.3.7.1.1 Fast-Settling Filter

At power-up or after a device reset, the ADS131M04-Q1 selects the fast-settling filter to allow for settled output data generation with minimal latency. The fast-settling filter has the characteristic of a first-order sinc filter ( $\text{sinc}^1$ ). After two conversions, the device switches to and remains in the  $\text{sinc}^3$  filter path until the next time the device is reset or powered cycled.

The fast-settling filter exhibits wider bandwidth and less stop-band attenuation than the  $\text{sinc}^3$  filter. Consequently, the noise performance when using the fast-settling filter is not as high as with the  $\text{sinc}^3$  filter. The first two samples available from the ADS131M04-Q1 after a supply ramp or reset have the noise performance and frequency response corresponding to the fast-settling filter as specified in the *Electrical Characteristics* table in the [Specifications](#) section, whereas subsequent samples have the noise performance and frequency response consistent with the  $\text{sinc}^3$  filter. See the [Fast Start-Up Behavior](#) section for more details regarding the fast start-up capabilities of the ADS131M04-Q1.

### 8.3.7.1.2 $\text{SINC}^3$ and $\text{SINC}^3 + \text{SINC}^1$ Filter

The ADS131M04-Q1 selects the  $\text{sinc}^3$  filter path two conversion after power-up or device reset. For OSR settings of 64 to 1024 the  $\text{sinc}^3$  filter output directly feeds into the global-chop and calibration logic. For OSR settings of 2048 and higher the  $\text{sinc}^3$  filter is followed by a  $\text{sinc}^1$  filter. As shown in [Table 8-3](#), the  $\text{sinc}^3$  filter operates at a fixed OSR of 1024 in this case while the  $\text{sinc}^1$  filter implements the additional OSRs of 2 to 16. That means when an OSR of 4096 (for example) is selected, the  $\text{sinc}^3$  filter operates at an OSR of 1024 and the  $\text{sinc}^1$  filter at an OSR of 4.

The filter has infinite attenuation at integer multiples of the data rate except for integer multiples of  $f_{\text{MOD}}$ . Like all digital filters, the digital filter response of the ADS131M04-Q1 repeats at integer multiples of the modulator frequency,  $f_{\text{MOD}}$ . The data rate and filter notch frequencies scale with  $f_{\text{MOD}}$ .

When possible, plan frequencies for unrelated periodic processes in the application for integer multiples of the data rate such that any parasitic effect they have on data acquisition is effectively canceled by the notches of the digital filter. Avoid frequencies near integer multiples of  $f_{\text{MOD}}$  whenever possible because tones in these bands can alias to the band of interest.

The  $\text{sinc}^3$  and  $\text{sinc}^3 + \text{sinc}^1$  filters for a given channel require time to settle after a channel is enabled, the channel multiplexer or gain setting is changed, or a resynchronization event occurs. See the [Synchronization](#) section for more details on resynchronization. [Table 8-3](#) lists the settling times of the  $\text{sinc}^3$  and  $\text{sinc}^3 + \text{sinc}^1$  filters for each OSR setting. The ADS131M04-Q1 does not gate unsettled data. Therefore, the host must account for the filter settling time and disregard unsettled data if any are read. The data at the next  $\overline{\text{DRDY}}$  falling edge after the filter settling time listed in [Table 8-3](#) has expired can be considered fully settled.

**Table 8-3. Digital Filter Start-Up Times After Power-Up or Resynchronization**

| OSR (OVERALL) | OSR ( $\text{SINC}^3$ ) | OSR ( $\text{SINC}^1$ ) | SETTLING TIME ( $t_{\text{CLKIN}}$ ) |
|---------------|-------------------------|-------------------------|--------------------------------------|
| 64            | 64                      | N/A                     | 728                                  |
| 128           | 128                     | N/A                     | 856                                  |
| 256           | 256                     | N/A                     | 1112                                 |
| 512           | 512                     | N/A                     | 1624                                 |
| 1024          | 1024                    | N/A                     | 2648                                 |
| 2048          | 1024                    | 2                       | 4696                                 |
| 4096          | 1024                    | 4                       | 8792                                 |
| 8192          | 1024                    | 8                       | 16984                                |
| 16384         | 1024                    | 16                      | 33368                                |

### 8.3.7.2 Digital Filter Characteristic

Equation 6 calculates the z-domain transfer function of a sinc<sup>3</sup> filter that is used for OSRs of 1024 and lower.

$$|H(z)| = \left| \frac{1 - Z^{-N}}{N(1 - Z^{-1})} \right|^3 \quad (6)$$

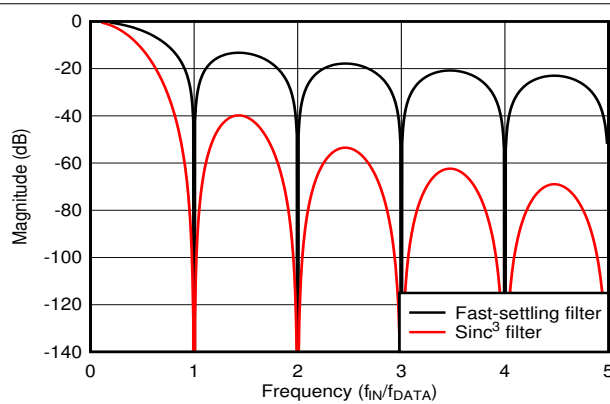
where N is the OSR.

Equation 7 calculates the transfer function of a sinc<sup>3</sup> filter in terms of the continuous-time frequency parameter f.

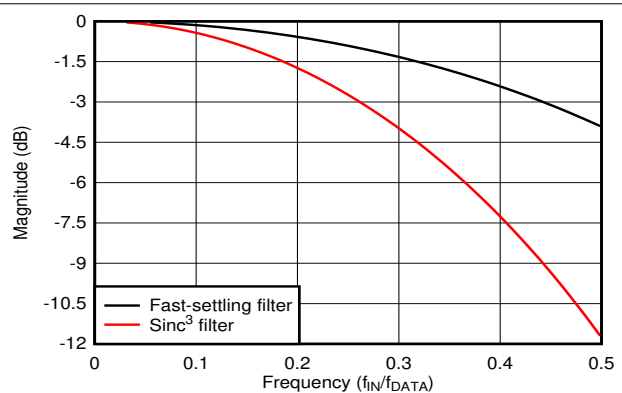
$$|H(f)| = \left| \frac{\sin \left[ \frac{N\pi f}{f_{MOD}} \right]}{N \times \sin \left[ \frac{\pi f}{f_{MOD}} \right]} \right|^3 \quad (7)$$

where N is the OSR.

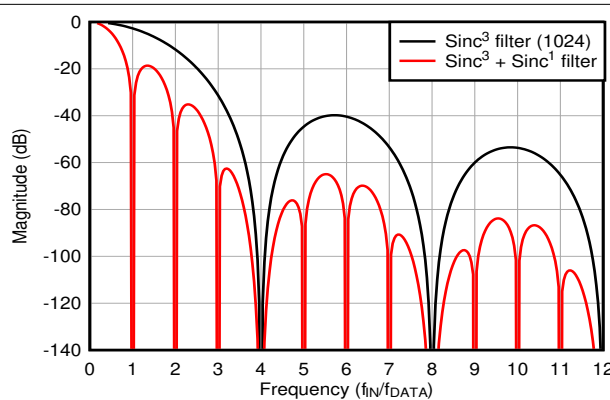
Figure 8-4 and Figure 8-5 show the digital filter response of the fast-settling filter and the sinc<sup>3</sup> filter for OSRs of 1024 and lower. Figure 8-6 and Figure 8-7 show the digital filter response of the sinc<sup>3</sup> + sinc<sup>1</sup> filter for an OSR of 4096.



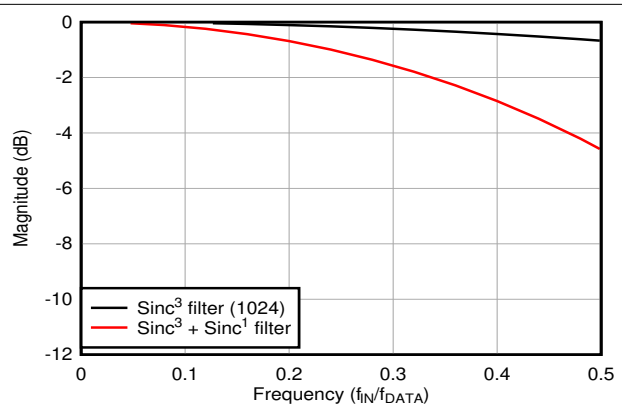
**Figure 8-4. Fast-Settling and Sinc<sup>3</sup> Digital Filter Response**



**Figure 8-5. Fast-Settling and Sinc<sup>3</sup> Digital Filter Response, Pass-Band Detail**



**Figure 8-6. Digital Filter Response for OSR = 1024 and OSR = 4096**



**Figure 8-7. Digital Filter Response for OSR = 1024 and OSR = 4096, Pass-Band Detail**

### 8.3.8 DC Block Filter

The ADS131M04-Q1 includes an optional high-pass filter to eliminate any systematic offset or low-frequency noise. The filter is enabled by writing any value in the DCBLOCK[3:0] bits in the CD\_TH\_LSB register besides 0h. The DC block filter can be enabled and disabled on a channel-by-channel basis by the DCBLK<sub>n</sub>\_DIS bit in the CH<sub>n</sub>\_CFG register for each respective channel.

Figure 8-8 shows the topology of the DC block filter. Coefficient *a* represents a register configurable value that configures the cutoff frequency of the filter. The cutoff frequency is configured using the DCBLOCK[3:0] bits in the CD\_TH\_LSB register. Table 8-4 describes the characteristics of the filter for various DCBLOCK[3:0] settings. The data provided in Table 8-4 is provided for an 8.192-MHz CLKIN frequency and a 4-kSPS data rate. The frequency response of the filter response scales directly with the frequency of CLKIN and the data rate.

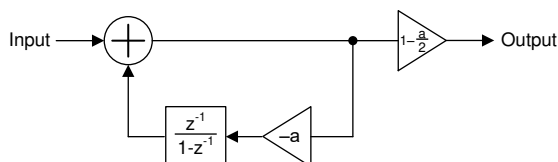


Figure 8-8. DC Block Filter Topology

Table 8-4. DC Block Filter Characteristics

| DCBLOCK[3:0] | a COEFFICIENT | -3-dB<br>CORNER <sup>(1)</sup> | PASS-BAND ATTENUATION <sup>(1)</sup> |          | SETTLING TIME (Samples) |               |
|--------------|---------------|--------------------------------|--------------------------------------|----------|-------------------------|---------------|
|              |               |                                | 50 Hz                                | 60 Hz    | SETTLED >99%            | FULLY SETTLED |
| 0h           |               | DC block filter disabled       |                                      |          |                         |               |
| 1h           | 1/4           | 181 Hz                         | 11.5 dB                              | 10.1 dB  | 17                      | 88            |
| 2h           | 1/8           | 84.8 Hz                        | 5.89 dB                              | 4.77 dB  | 36                      | 187           |
| 3h           | 1/16          | 41.1 Hz                        | 2.24 dB                              | 1.67 dB  | 72                      | 387           |
| 4h           | 1/32          | 20.2 Hz                        | 657 mdB                              | 466 mdB  | 146                     | 786           |
| 5h           | 1/64          | 10.0 Hz                        | 171 mdB                              | 119 mdB  | 293                     | 1585          |
| 6h           | 1/128         | 4.99 Hz                        | 43.1 mdB                             | 29.9 mdB | 588                     | 3182          |
| 7h           | 1/256         | 2.49 Hz                        | 10.8 mdB                             | 7.47 mdB | 1178                    | 6376          |
| 8h           | 1/512         | 1.24 Hz                        | 2.69 mdB                             | 1.87 mdB | 2357                    | 12764         |
| 9h           | 1/1024        | 622 mHz                        | 671 μdB                              | 466 μdB  | 4714                    | 25540         |
| Ah           | 1/2048        | 311 mHz                        | 168 μdB                              | 116 μdB  | 9430                    | 51093         |
| Bh           | 1/4096        | 155 mHz                        | 41.9 μdB                             | 29.1 μdB | 18861                   | 102202        |
| Ch           | 1/8192        | 77.7 mHz                       | 10.5 μdB                             | 7.27 μdB | 37724                   | 204447        |
| Dh           | 1/16384       | 38.9 mHz                       | 2.63 μdB                             | 1.82 μdB | 75450                   | 409156        |
| Eh           | 1/32768       | 19.4 mHz                       | 655 ndB                              | 455 ndB  | 150901                  | 820188        |
| Fh           | 1/65536       | 9.70 mHz                       | 164 ndB                              | 114 ndB  | 301803                  | 1627730       |

(1) Values given are for a 4-kSPS data rate with a 8.192-MHz CLKIN frequency.

### 8.3.9 Internal Test Signals

The ADS131M04-Q1 features an internal analog test signal that is useful for troubleshooting and diagnosis. A positive or negative DC test signal can be applied to the channel inputs through the input multiplexer. The multiplexer is controlled through the MUX<sub>n</sub>[1:0] bits in the CH<sub>n</sub>\_CFG register. The test signals are created by internally dividing the internal reference voltage. The same signal is shared by all channels.

The test signal is nominally  $2 / 15 \times V_{REF}$ . The test signal automatically adjusts the voltage level with the gain setting such that the ADC always measures a signal that is  $2 / 15 \times V_{Diff\ Max}$ . For example, at a gain of 1, this voltage equates to 160 mV. At a gain of 2, this voltage is 80 mV.

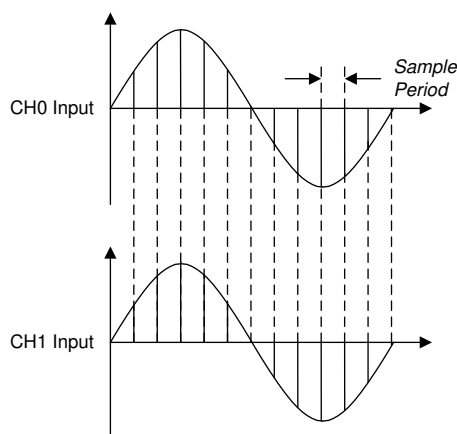


### 8.3.10 Channel Phase Calibration

The ADS131M04-Q1 allows fine adjustment of the sample phase between channels through the use of channel phase calibration. This feature is helpful when different channels are measuring the outputs of different types of sensors that have different phase responses. For example, in power metrology applications, voltage can be measured by a voltage divider, whereas current is measured using a current transformer that exhibits a phase difference between the input and output signals. The differences in phase between the voltage and current measurement must be compensated to measure the power and related parameters accurately.

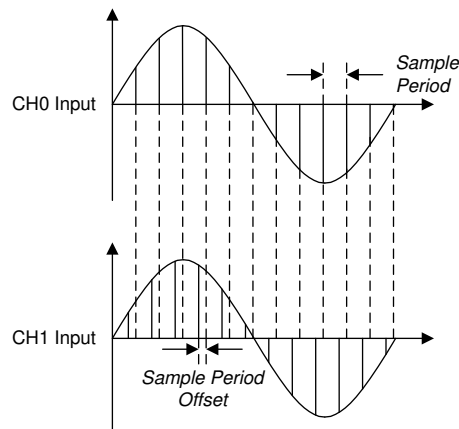
The phase setting of the different channels is configured by the PHASEn[9:0] bits in the CHn\_CFG register corresponding to the channel whose phase adjustment is desired. The register value is a 10-bit two's complement value corresponding to the number of modulator clock cycles of phase offset compared to a reference phase of 0 degrees.

The mechanism for achieving phase adjustment derives from the  $\Delta\Sigma$  architecture. The  $\Delta\Sigma$  modulator produces samples continuously at the modulator frequency,  $f_{MOD}$ . These samples are filtered and decimated to the output data rate by the digital filter. The ratio between  $f_{MOD}$  and the data rate is the oversampling ratio (OSR). Each conversion result corresponds to an OSR number of modulator samples provided to the digital filter. When the different channels of the ADS131M04-Q1 have no programmed phase offset between them, the modulator clock cycles corresponding to the conversion results of the different channels are aligned in the time domain. [Figure 8-9](#) depicts an example scenario where the voltage input to channel 1 has no phase offset from channel 0.

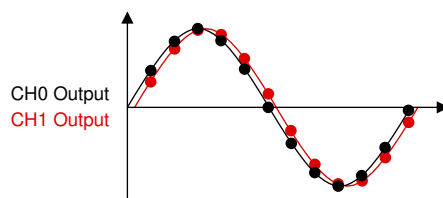


**Figure 8-9. Two Channel Outputs With Equal Phase Settings**

However, the sample period of one channel can be shifted with respect to another. If the inputs to both channels are sinusoids of the same frequency and the samples for these channels are retrieved by the host at the same time, the effect is that the phase of the channel with the modified sample period appears *shifted*. [Figure 8-10](#) depicts how the period corresponding to the samples are shifted between channels. [Figure 8-11](#) illustrates how the samples appear as having generated a phase shift when they are retrieved by the host.



**Figure 8-10. Channel 1 With a Positive Sample Phase Shift With Respect to Channel 0**



**Figure 8-11. Channels 1 and 0 From the Perspective of the Host**

The valid setting range is from  $-\text{OSR} / 2$  to  $(\text{OSR} / 2) - 1$ , except for OSRs greater than 1024, where the phase calibration setting is limited to  $-512$  to  $511$ . If a value outside of  $-\text{OSR} / 2$  and  $(\text{OSR} / 2) - 1$  is programmed, the device internally clips the value to the nearest limit. For example, if the OSR setting is programmed to 128 and the PHASEn[9:0] bits are programmed to 0001100100b corresponding to 100 modulator clock cycles, the device sets the phase of the channel to 63 because that value is the upper limit of phase calibration for that OSR setting. [Table 8-5](#) gives the range of phase calibration settings for various OSR settings.

**Table 8-5. Phase Calibration Setting Limits for Different OSR Settings**

| OSR SETTING | PHASE OFFSET RANGE ( $t_{\text{MOD}}$ ) | PHASEn[9:0] BITS RANGE         |
|-------------|-----------------------------------------|--------------------------------|
| 64          | -32 to 31                               | 11 1110 0000b to 00 0001 1111b |
| 128         | -64 to 63                               | 11 1100 0000b to 00 0011 1111b |
| 256         | -128 to 127                             | 11 1000 0000b to 00 0111 1111b |
| 512         | -256 to 255                             | 11 0000 0000b to 00 1111 1111b |
| 1024        | -512 to 511                             | 10 0000 0000b to 01 1111 1111b |
| 2048        | -512 to 511                             | 10 0000 0000b to 01 1111 1111b |
| 4096        | -512 to 511                             | 10 0000 0000b to 01 1111 1111b |
| 8192        | -512 to 511                             | 10 0000 0000b to 01 1111 1111b |
| 16384       | -512 to 511                             | 10 0000 0000b to 01 1111 1111b |

Follow these steps to create a phase shift larger than half the sample period for OSRs less than 2048:

- Create a phase shift corresponding to an integer number of sample periods by modifying the indices between channel data in software
- Use the phase calibration function of the ADS131M04-Q1 to create the remaining fractional sample period phase shift

For example, to create a phase shift of 2.25 samples between channels 0 and 1, create a phase shift of two samples by aligning sample N in the channel 0 output data stream with sample N+2 in the channel 1 output

data stream in the host software. Make the remaining 0.25 sample adjustment using the ADS131M04-Q1 phase calibration function.

The phase calibration settings of the channels affect the timing of the data-ready interrupt signal,  $\overline{DRDY}$ . See the [Data Ready \(DRDY\)](#) section for more details regarding how phase calibration affects the DRDY signal.

### 8.3.11 Calibration Registers

The calibration registers allow for the automatic computation of calibrated ADC conversion results from pre-programmed values. The host can rely on the device to automatically correct for system gain and offset after the error correction terms are programmed into the corresponding device registers. The measured calibration coefficients must be store in external non-volatile memory and programmed into the registers each time the ADS131M04-Q1 powers up because the ADS131M04-Q1 registers are volatile.

The offset calibration registers are used to correct for system offset error, otherwise known as *zero error*. Offset error corresponds to the ADC output when the input to the system is zero. The ADS131M04-Q1 corrects for offset errors by subtracting the contents of the OCALn[23:0] register bits in the CHn\_OCAL\_MSB and CHn\_OCAL\_LSB registers from the conversion result for that channel before being output. There are separate CHn\_OCAL\_MSB and CHn\_OCAL\_LSB registers for each channel, which allows separate offset calibration coefficients to be programmed for each channel. The contents of the OCALn[23:0] bits are interpreted by the device as 24-bit two's complement values, which is the same format as the ADC data.

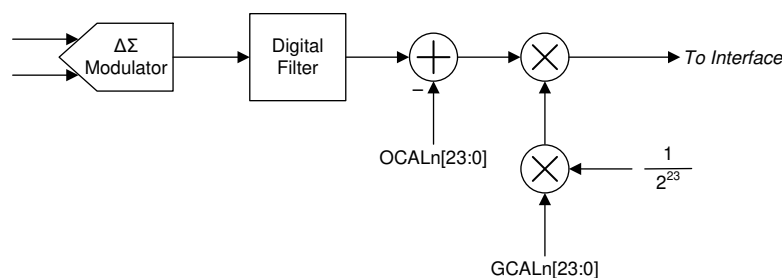
The gain calibration registers are used to correct for system gain error. Gain error corresponds to the deviation of gain of the system from the ideal value. The ADS131M04-Q1 corrects for gain errors by multiplying the ADC conversion result by the value given by the contents of the GCALn[23:0] register bits in the CHn\_GCAL\_MSB and CHn\_GCAL\_LSB registers before being output. There are separate CHn\_GCAL\_MSB and CHn\_GCAL\_LSB registers for each channel, which allows separate gain calibration coefficients to be programmed for each channel. The contents of the GCALn[23:0] bits are interpreted by the device as 24-bit unsigned values corresponding to linear steps ranging from gains of 0 to  $2 - (1 / 2^{23})$ . [Table 8-6](#) describes the relationship between the GCALn[23:0] bit values and the gain calibration factor.

**Table 8-6. GCALn[23:0] Bit Mapping**

| GCALn[23:0] VALUE | GAIN CALIBRATION FACTOR   |
|-------------------|---------------------------|
| 000000h           | 0                         |
| 000001h           | $1.19 \times 10^{-7}$     |
| 800000h           | 1                         |
| FFFFFFEh          | $2 - 2.38 \times 10^{-7}$ |
| FFFFFFFh          | $2 - 1.19 \times 10^{-7}$ |

The calibration registers do not need to be enabled because they are always in use. The OCALn[23:0] bits have a default value of 000000h resulting in no offset correction. Similarly, the GCALn[23:0] bits default to 800000h resulting in a gain calibration factor of 1.

[Figure 8-12](#) depicts a block diagram illustrating the mechanics of the calibration registers on one channel of the ADS131M04-Q1.



**Figure 8-12. Calibration Block Diagram**

### 8.3.12 Communication Cyclic Redundancy Check (CRC)

The ADS131M04-Q1 features a cyclic redundancy check (CRC) engine on both input and output data to mitigate SPI communication errors. The CRC word is 16 bits wide for either input or output CRC. Coverage includes all words in the SPI frame where the CRC is enabled, including padded bits in a 32-bit word size.

CRC on the SPI input is optional and can be enabled and disabled by writing the RX\_CRC\_EN bit in the MODE register. Input CRC is disabled by default. When the input CRC is enabled, the device checks the provided input CRC against the CRC generated based on the input data. A CRC error occurs if the CRC words do not match. The device does not execute any commands, except for the WREG command, if the input CRC check fails. A WREG command always executes even when the CRC check fails. The device sets the CRC\_ERR bit in the STATUS register for all cases of a CRC error. The response on the output in the SPI frame following the frame where the CRC error occurred is that of a NULL command, which means the STATUS register plus the conversion data are output in the following SPI frame. The CRC\_ERR bit is cleared when the STATUS register is output.

The output CRC cannot be disabled and always appears at the end of the output frame. The host can ignore the data if the output CRC is not used.

There are two types of CRC polynomials available: CCITT CRC and ANSI CRC (CRC-16). The CRC setting determines the algorithm for both the input and output CRC. The CRC type is programmed by the CRC\_TYPE bit in the MODE register. [Table 8-7](#) lists the details of the two CRC types.

The seed value of the CRC calculation is FFFFh.

**Table 8-7. CRC Types**

| CRC TYPE  | POLYNOMIAL                  | BINARY POLYNOMIAL   |
|-----------|-----------------------------|---------------------|
| CCITT CRC | $x^{16} + x^{12} + x^5 + 1$ | 0001 0000 0010 0001 |
| ANSI CRC  | $x^{16} + x^{15} + x^2 + 1$ | 1000 0000 0000 0101 |

### 8.3.13 Register Map CRC

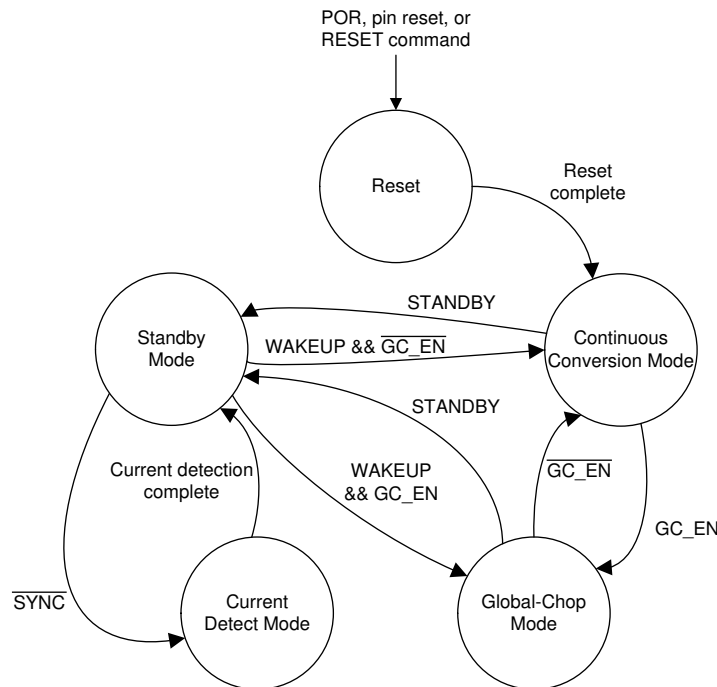
The ADS131M04-Q1 performs a CRC on the register map as a means to check for unintended changes to the registers. Enable the register map CRC by setting the REG\_CRC\_EN bit in the MODE register. When enabled, the device constantly calculates the register map CRC using each bit in the writable register space. The register addresses covered by the register map CRC on the ADS131M04-Q1 are 02h through 1Ch. The CRC is calculated beginning with the MSB of register 02h and ending with the LSB of register 1Ch using the polynomial selected in the CRC\_TYPE bit in the MODE register.

The CRC calculation is initialized with the seed value of FFFFh.

The calculated CRC is a 16-bit value and is stored in the REGMAP\_CRC register. The calculation is done using one register map bit per CLKIN period and constantly checks the result against the previous calculation. The REG\_MAP bit in the STATUS register is set to flag the host if the register map CRC changes, including changes resulting from register writes. The bit is cleared by reading the STATUS register, or by the STATUS register being output as a response to the NULL command.

## 8.4 Device Functional Modes

Figure 8-13 shows a state diagram depicting the major functional modes of the ADS131M04-Q1 and the transitions between them.



**Figure 8-13. State Diagram Depicting Device Functional Modes**

### 8.4.1 Power-Up and Reset

The ADS131M04-Q1 is reset in one of three ways: by a power-on reset (POR), by the  $\overline{\text{SYNC/RESET}}$  pin, or by a RESET command. After a reset occurs, the configuration registers are reset to the default values and the device begins generating conversion data as soon as a valid MCLK is provided. In all three cases a low to high transition on the  $\overline{\text{DRDY}}$  pin indicates that the SPI interface is ready for communication. The device ignores any SPI communication before this point.

#### 8.4.1.1 Power-On Reset

Power-on reset (POR) is the reset that occurs when a valid supply voltage is first applied. The POR process requires  $t_{\text{POR}}$  from when the supply voltages reach 90% of their nominal value. Internal circuitry powers up and the registers are set to their default state during this time. The  $\overline{\text{DRDY}}$  pin transitions from low to high immediately after  $t_{\text{POR}}$  indicating the SPI interface is ready for communication. The device ignores any SPI communication before this point.

#### 8.4.1.2 $\overline{\text{SYNC/RESET}}$ Pin

The  $\overline{\text{SYNC/RESET}}$  pin is an active low, dual-function pin that generates a reset if the pin is held low longer than  $t_{\text{W(RSL)}}$ . The device maintains a reset state until  $\overline{\text{SYNC/RESET}}$  is returned high. The host must wait for at least  $t_{\text{REGACQ}}$  after  $\overline{\text{SYNC/RESET}}$  is brought high or for the  $\overline{\text{DRDY}}$  rising edge before communicating with the device. Conversion data are generated immediately after the registers are reset to their default values, as described in the [Fast Start-Up Behavior](#) section.

#### 8.4.1.3 RESET Command

The ADS131M04-Q1 can be reset via the SPI RESET command (0011h). The device communicates in frames of a fixed length. See the [SPI Communication Frames](#) section for details regarding SPI data framing on the ADS131M04-Q1. The RESET command occurs in the first word of the data frame, but the command is not latched by the device until the entire frame is complete. After the response completes channel data and CRC

words are clocked out. Terminating the frame early causes the RESET command to be ignored. Six words are required to complete a frame on the ADS131M04-Q1.

A reset occurs immediately after the command is latched. The host must wait for  $t_{\text{REGACQ}}$  before communicating with the device to ensure the registers have assumed their default settings. Conversion data are generated immediately after the registers are reset to their default values, as described in the [Fast Start-Up Behavior](#) section.

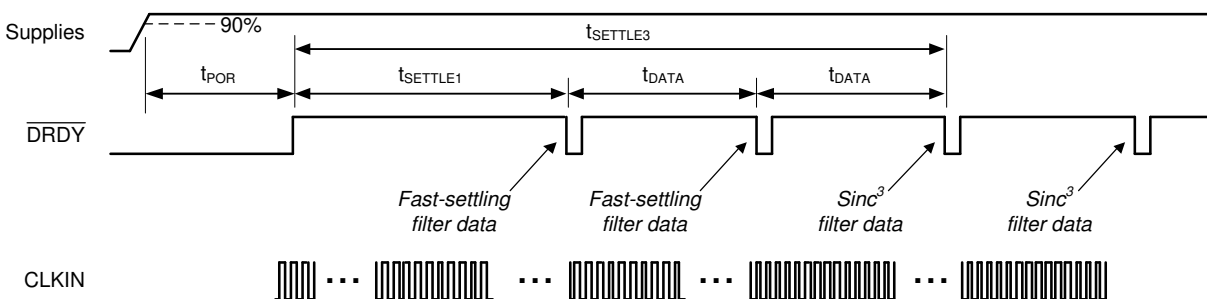
### 8.4.2 Fast Start-Up Behavior

The ADS131M04-Q1 begins generating conversion data shortly after startup as soon as a valid CLKIN signal is provided to the  $\Delta\Sigma$  modulators. The fast start-up feature is useful for applications such as circuit breakers powered from the mains that require a fast determination of the input voltage soon after power is applied to the device. Fast start up is accomplished via two mechanisms. First, the device internal power-supply circuitry is designed specifically to enable fast start up. Second, the digital decimation filter dynamically switches from a fast-settling filter to a sinc<sup>3</sup> filter when the sinc<sup>3</sup> filter has had time to settle.

After the supplies are ramped to 90% of their final values, the device requires  $t_{\text{POR}}$  for the internal circuitry to settle. The end of  $t_{\text{POR}}$  is indicated by a transition of  $\overline{\text{DRDY}}$  from low to high. The transition of  $\overline{\text{DRDY}}$  from low to high also indicates the SPI interface is ready to accept commands.

The  $\Delta\Sigma$  modulators of the ADS131M04-Q1 require CLKIN to toggle after  $t_{\text{POR}}$  to begin working. The modulators begin sampling the input signal after an initial wait time delay of  $(256 + 44) \times t_{\text{MOD}}$  when CLKIN begins toggling. Therefore, provide a valid clock signal on CLKIN as soon as possible after the supply ramp to achieve the fastest possible startup time.

The data generated by the  $\Delta\Sigma$  modulators are fed to the digital filter blocks. The data are provided to both the fast-settling filter and the sinc<sup>3</sup> filter paths. The fast-settling filter requires only one data rate period to provide settled data. Meanwhile, the sinc<sup>3</sup> filter requires three data rate periods to settle. The fast-settling filter generates the output data for the two interim ADC output samples indicated by  $\overline{\text{DRDY}}$  transitioning from high to low while the sinc<sup>3</sup> filter is settling. The device disables the fast-settling filter and provides conversion data from the sinc<sup>3</sup> filter path for the third and following samples. [Figure 8-14](#) shows the behavior of the fast start-up feature when using an external clock that is provided to the device right after the supplies have ramped. [Table 8-8](#) shows the values for the various start-up and settling times relevant to the device start up.



**Figure 8-14. Fast Startup Behavior and Settling Times**

**Table 8-8. Fast Startup Settling Times for Default OSR = 1024**

| PARAMETER                             | VALUE (DETAILS)<br>( $t_{\text{MOD}}$ ) | VALUE<br>( $t_{\text{MOD}}$ ) | VALUE AT<br>$f_{\text{CLKIN}} = 8.192 \text{ MHz}$ (ms) |
|---------------------------------------|-----------------------------------------|-------------------------------|---------------------------------------------------------|
| $t_{\text{DATA}} = 1/f_{\text{DATA}}$ | 1024                                    | 1024                          | 0.250                                                   |
| $t_{\text{SETTLE1}}$                  | $256 + 44 + 1024$                       | 1324                          | 0.323                                                   |
| $t_{\text{SETTLE3}}$                  | $256 + 44 + 3 \times 1024$              | 3372                          | 0.823                                                   |

The fast-settling filter provides conversion data that are significantly noisier than the data that comes from the sinc<sup>3</sup> filter path, but allows the device to provide settled conversion data during the longer settling time of the more accurate sinc<sup>3</sup> digital filter. If the level of precision provided by the fast-settling filter is insufficient even for

the first samples immediately following start up, ignore the first two instances of  $\overline{\text{DRDY}}$  toggling from high to low and begin collecting data on the third instance.

The start-up process following a RESET command or a pin reset using the  $\overline{\text{SYNC/RESET}}$  pin is similar to what occurs after power up. However there is no  $t_{\text{POR}}$  in the case of a command or pin reset because the supplies are already ramped. After reset, the device waits for the initial wait time delay of  $(256 + 44) \times t_{\text{MOD}}$  before providing modulator samples to the two digital filters. The fast-settling filter is enabled for the first two output samples.

### 8.4.3 Conversion Modes

There are two ADC conversion modes on the ADS131M04-Q1: continuous-conversion and global-chop mode. Continuous-conversion mode is a mode where ADC conversions are generated constantly by the ADC at a rate defined by  $f_{\text{MOD}} / \text{OSR}$ . Global-chop mode differs from continuous-conversion mode because global-chop periodically chops (or swaps) the inputs, which reduces system offset errors at the cost of settling time between the points when the inputs are swapped. In either continuous-conversion or global-chop mode, there are three power modes that provide flexible options to scale power consumption with bandwidth and dynamic range. The [Power Modes](#) section discusses these power modes in further detail.

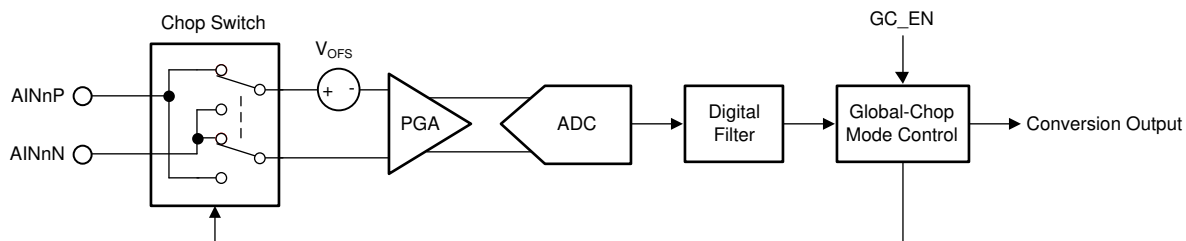
#### 8.4.3.1 Continuous-Conversion Mode

Continuous-conversion mode is the mode in which ADC data are generated constantly at the rate of  $f_{\text{MOD}} / \text{OSR}$ . New data are indicated by a  $\overline{\text{DRDY}}$  falling edge at this rate. Continuous-conversion mode is intended for measuring AC signals because this mode allows for higher output data rates than global-chop mode.

#### 8.4.3.2 Global-Chop Mode

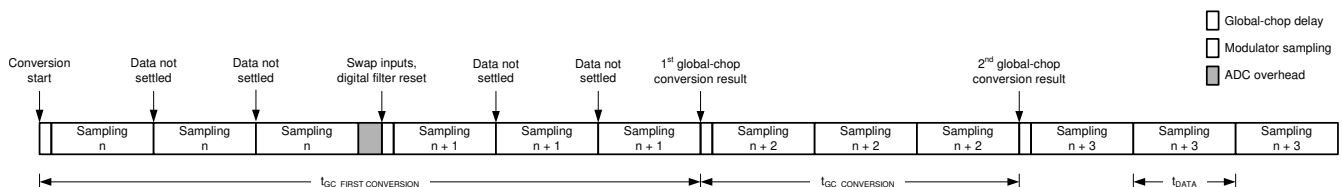
The ADS131M04-Q1 incorporates a global-chop mode option to reduce offset error and offset drift inherent to the device resulting from mismatch in the internal circuitry to very low levels. When global-chop mode is enabled by setting the GC\_EN bit in the GLOBAL\_CHOP\_CFG register, the device uses the conversion results from two consecutive internal conversions taken with opposite input polarity to cancel the device offset voltage. Conversion  $n$  is taken with normal input polarity. The device then reverses the internal input polarity for conversion  $n + 1$ . The average of two consecutive conversions ( $n$  and  $n + 1$ ,  $n + 1$  and  $n + 2$  and so on) yields the final offset compensated result.

[Figure 8-15](#) shows a block diagram of the global-chop mode implementation. The combined PGA and ADC internal offset voltage is modeled as  $V_{\text{OFS}}$ . Only this device inherent offset voltage is reduced by global-chop mode. Offset in the external circuitry connected to the analog inputs is not affected by global-chop mode.



**Figure 8-15. Global-Chop Mode Implementation**

The conversion period in global-chop mode differs from the conversion time when global-chop mode is disabled ( $t_{\text{DATA}} = \text{OSR} \times t_{\text{MOD}}$ ). [Figure 8-16](#) shows the conversion timing for an ADC channel using global-chop mode.



**Figure 8-16. Conversion Timing With Global-Chop Mode Enabled**



Every time the device swaps the input polarity, the digital filter is reset. The ADC then always takes three internal conversions to produce one settled global-chop conversion result.

The ADS131M04-Q1 provides a programmable delay ( $t_{GC\_DLY}$ ) between the end of the previous conversion period and the beginning of the subsequent conversion period after the input polarity is swapped. This delay allows external input circuitry to settle because the chopping switches interface directly with the analog inputs. The GC\_DLY[3:0] bits in the GLOBAL\_CHOP\_CFG register configure the delay after chopping the inputs. The global-chop delay is selected in terms of modulator clock periods from 2 to  $65,536 \times t_{MOD}$ .

The effective conversion period in global-chop mode follows [Equation 8](#). A  $\overline{DRDY}$  falling edge is generated each time a new global-chop conversion becomes available to the host.

The conversion process of all ADC channels in global-chop mode is restarted in the following two conditions so that all channels start sampling at the same time:

- Falling edge of the  $\overline{SYNC/RESET}$  pin
- Change of OSR setting

The conversion period of the first conversion after the ADC channels are reset is considerably longer than the conversion period of all subsequent conversions mentioned in [Equation 8](#), because the device must first perform two fully settled internal conversions with the input polarity swapped. The conversion period for the first conversion in global-chop mode follows [Equation 9](#).

$$t_{GC\_CONVERSION} = t_{GC\_DLY} + 3 \times OSR \times t_{MOD} \quad (8)$$

$$t_{GC\_FIRST\_CONVERSION} = t_{GC\_DLY} + 3 \times OSR \times t_{MOD} + t_{GC\_DLY} + 3 \times OSR \times t_{MOD} + 44 \times t_{MOD} \quad (9)$$

Using global-chop mode reduces the ADC noise shown in [Table 7-1](#) at a given OSR by a factor of  $\sqrt{2}$  because two consecutive internal conversions are averaged to yield one global-chop conversion result. The DC test signal cannot be measured in global-chop mode.

Phase calibration is automatically disabled in global-chop mode.

#### 8.4.4 Power Modes

In both continuous-conversion and global-chop mode, there are three selectable power modes that allow scaling of power with bandwidth and performance: high-resolution (HR) mode, low-power (LP) mode, and very-low-power (VLP) mode. The mode is selected by the PWR[1:0] bits in the CLOCK register. See the [Recommended Operating Conditions](#) table for restrictions on the CLKIN frequency for each power mode.

#### 8.4.5 Standby Mode

Standby mode is a low-power state in which all channels are disabled, and the reference and other non-essential circuitry are powered down. This mode differs from completely powering down the device because the device retains the register settings. Enter standby mode by sending the STANDBY command (0022h). Stop toggling CLKIN when the device is in standby mode to minimize device power consumption. Exit standby mode by sending the WAKEUP command (0033h). After exiting standby mode, the modulators begin sampling the input signal after a modulator settling time of  $8 \times t_{MOD}$  when CLKIN begins toggling.

#### 8.4.6 Current-Detect Mode

Current-detect mode is a special mode that is helpful for applications requiring tamper detection when the equipment is in a low-power state. In this mode, the ADS131M04-Q1 collects a configurable number of samples at a nominal data rate of 2.7 kSPS and compares the absolute value of the results to a programmable threshold. If a configurable number of results exceed the threshold, the host is notified via a  $\overline{DRDY}$  falling edge and the device returns to standby mode. Enter current-detect mode by providing a negative pulse on  $\overline{SYNC/RESET}$  with a pulse duration less than  $t_{w(RSL)}$  when in standby mode. Current-detect mode can only be entered from standby mode.

The device uses a limited power operating mode to generate conversions in current-detect mode. The conversion results are only used for comparison by the internal digital threshold comparator and are not accessible by the host. The device uses an internal oscillator that enables the device to capture the data without



the use of the external clock input. Do not toggle CLKIN when in current-detect mode to minimize device power consumption.

Current-detect mode is configured in the CFG, THRSHLD\_MSB, and THRSHLD\_LSB registers. Enable and disable current-detect mode by toggling the CD\_EN bit in the CFG register. The THRSHLD\_MSB and THRSHLD\_LSB registers contain the CD\_THRSH[23:0] bits that represent the digital comparator threshold value during current detection.

The number of samples used for current detection are programmed by the CD\_LEN[2:0] bits in the CFG register. The number of samples used for current detection range from 128 to 3584.

The programmable values in CD\_NUM[2:0] configure the number of samples that must exceed the threshold for a detection to occur. The purpose of requiring multiple samples for detection is to control noisy values that may exceed the threshold, but do not represent a high enough power level to warrant action by the host. In summary, the conversion result must exceed the value programmed in CD\_THRSH[23:0] a number of times as represented by the value stored in CD\_NUM[2:0].

The device can be configured to notify the host based on any of the results from individual channels, all channels, or any combination of channels. The CD\_ALLCH bit in the CFG register determines how many channels are required to exceed the programmed thresholds to trigger a current detection. When the bit is 1, all enabled channels are required to meet the current detection requirements in order for the host to be notified. If the bit is 0, any enabled channel triggers a current detection notification if the requirements are met. Enable and disable channels using the CHn\_EN bits in the CLK register to control which combination of channels must meet the requirements to trigger a current-detection notification.

[Figure 8-17](#) illustrates a flow chart depicting the current-detection process on the ADS131M04-Q1.

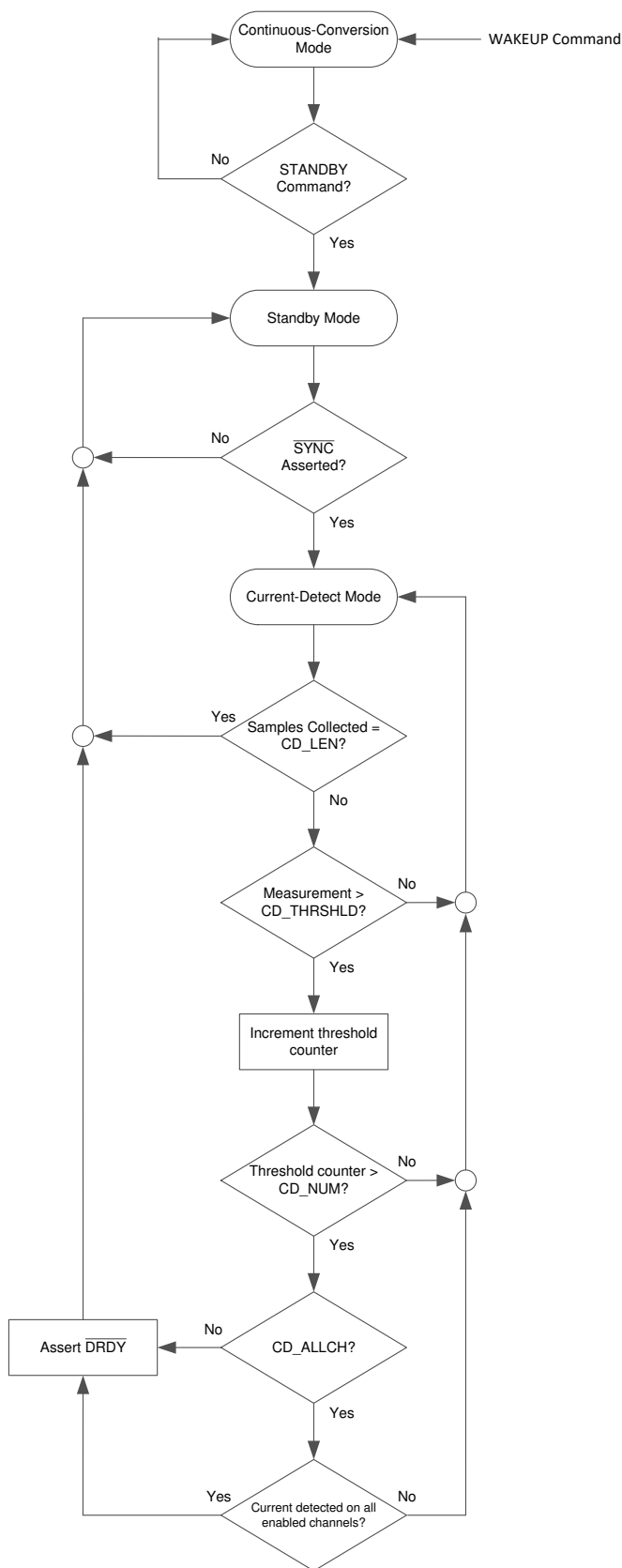


Figure 8-17. Current-Detect Mode Flow Chart

## 8.5 Programming

### 8.5.1 Interface

The ADS131M04-Q1 uses an SPI-compatible interface to configure the device and retrieve conversion data. The device always acts as an SPI peripheral; SCLK and  $\overline{CS}$  are inputs to the interface. The interface operates in SPI mode 1 where CPOL = 0 and CPHA = 1. In SPI mode 1, the SCLK idles low and data are launched or changed only on SCLK rising edges; data are latched or read by the controller and peripheral on SCLK falling edges. The interface is full-duplex, meaning data can be sent and received simultaneously by the interface. The device includes the typical SPI signals: SCLK,  $\overline{CS}$ , DIN (PICO), and DOUT (POCI). In addition, there are two other digital pins that provide additional functionality. The  $\overline{DRDY}$  pin serves as a flag to the host to indicate new conversion data are available. The  $\overline{SYNC}/\overline{RESET}$  pin is a dual-function pin that allows synchronization of conversions to an external event and allows for a hardware device reset.

#### 8.5.1.1 Chip Select ( $\overline{CS}$ )

The  $\overline{CS}$  pin is an active low input signal that selects the device for communication. The device ignores any communication and DOUT is high impedance when  $\overline{CS}$  is held high. Hold  $\overline{CS}$  low for the duration of a communication frame to ensure proper communication. The interface is reset each time  $\overline{CS}$  is taken high.

#### 8.5.1.2 Serial Data Clock (SCLK)

The SCLK pin is an input that serves as the serial clock for the interface. Output data on the DOUT pin transition on the rising edge of SCLK and input data on DIN are latched on the falling edge of SCLK.

#### 8.5.1.3 Serial Data Input (DIN)

The DIN pin is the serial data input pin for the device. Serial commands are shifted in through the DIN pin by the device with each SCLK falling edge when the  $\overline{CS}$  pin is low.

#### 8.5.1.4 Serial Data Output (DOUT)

The DOUT pin is the serial data output pin for the device. The device shifts out command responses and ADC conversion data serially with each rising SCLK edge when the  $\overline{CS}$  pin is low. This pin assumes a high-impedance state when  $\overline{CS}$  is high.

#### 8.5.1.5 Data Ready ( $\overline{DRDY}$ )

The  $\overline{DRDY}$  pin is an active low output that indicates when new conversion data are ready in conversion mode or that the requirements are met for current detection when in current-detect mode. Connect the  $\overline{DRDY}$  pin to a digital input on the host to trigger periodic data retrieval in conversion mode.

The timing of  $\overline{DRDY}$  with respect to the sampling of a given channel on the ADS131M04-Q1 depends on the phase calibration setting of the channel and the state of the  $\overline{DRDY\_SEL}[1:0]$  bits in the MODE register. Setting the  $\overline{DRDY\_SEL}[1:0]$  bits to 00b configures  $\overline{DRDY}$  to assert when the channel with the largest positive phase calibration setting, or the most lagging, has a new conversion result. When the bits are 01b, the device asserts  $\overline{DRDY}$  each time any channel data are ready. Finally, setting the bits to either 10b or 11b configures the device to assert  $\overline{DRDY}$  when the channel with the most negative phase calibration setting, or the most leading, has new conversion data. Changing the  $\overline{DRDY\_SEL}[1:0]$  bits has no effect on  $\overline{DRDY}$  behavior in global-chop mode because phase calibration is automatically disabled in global-chop mode.

The timing of the first  $\overline{DRDY}$  assertion after channels are enabled or after a synchronization pulse is provided depends on the phase calibration setting. If the channel that causes  $\overline{DRDY}$  to assert has a phase calibration setting less than zero, the first  $\overline{DRDY}$  assertion can be less than one sample period from the channel being enabled or the occurrence of the synchronization pulse. However,  $\overline{DRDY}$  asserts in the next sample period if the phase setting puts the output timing too close to the beginning of the sample period.

Table 8-9 lists the phase calibration setting boundary at which  $\overline{DRDY}$  either first asserts within a sample period, or in the next sample period. If the setting for the channel configured to control  $\overline{DRDY}$  assertion is greater than the value listed in Table 8-9 for each OSR,  $\overline{DRDY}$  asserts for the first time within a sample period of the channel being enabled or the synchronization pulse. If the phase setting value is equal to or more negative than the value

in Table 8-9,  $\overline{\text{DRDY}}$  asserts in the following sample period. See the [Synchronization](#) section for more information about synchronization.

**Table 8-9. Phase Setting First  $\overline{\text{DRDY}}$  Assertion Boundary**

| OSR   | PHASE SETTING BOUNDARY | PHASEn[9:0] BIT SETTING BOUNDARY |
|-------|------------------------|----------------------------------|
| 64    | +13                    | 00Dh                             |
| 128   | –19                    | 3EDh                             |
| 256   | –83                    | 3ADh                             |
| 512   | –211                   | 32Dh                             |
| 1024  | –467                   | 22Dh                             |
| >1024 | None                   | N/A                              |

The  $\overline{\text{DRDY\_HIZ}}$  bit in the MODE register configures the state of the  $\overline{\text{DRDY}}$  pin when deasserted. By default the bit is 0b, meaning the pin is actively driven high using a push-pull output stage. When the bit is 1b,  $\overline{\text{DRDY}}$  behaves like an open-drain digital output. Use a 100-k $\Omega$  pullup resistor to pull the pin high when  $\overline{\text{DRDY}}$  is not asserted.

The  $\overline{\text{DRDY\_FMT}}$  bit in the MODE register determines the format of the  $\overline{\text{DRDY}}$  signal. When the bit is 0b, new data are indicated by  $\overline{\text{DRDY}}$  changing from high to low and remaining low until either all of the conversion data are shifted out of the device, or remaining low and going high briefly before the next time  $\overline{\text{DRDY}}$  transitions low. When the  $\overline{\text{DRDY\_FMT}}$  bit is 1b, new data are indicated by a short negative pulse on the  $\overline{\text{DRDY}}$  pin. If the host does not read conversion data after the  $\overline{\text{DRDY}}$  pulse when  $\overline{\text{DRDY\_FMT}}$  is 1b, the device skips a conversion result and does not provide another  $\overline{\text{DRDY}}$  pulse until the second following instance when data are ready because of how the pulse is generated. See the [Collecting Data for the First Time or After a Pause in Data Collection](#) section for more information about the behavior of  $\overline{\text{DRDY}}$  when data are not consistently read.

The  $\overline{\text{DRDY}}$  pulse is blocked when new conversions complete while conversion data are read. Therefore, avoid reading ADC data during the time where new conversions complete in order to achieve consistent  $\overline{\text{DRDY}}$  behavior.

#### 8.5.1.6 Conversion Synchronization or System Reset ( $\overline{\text{SYNC/RESET}}$ )

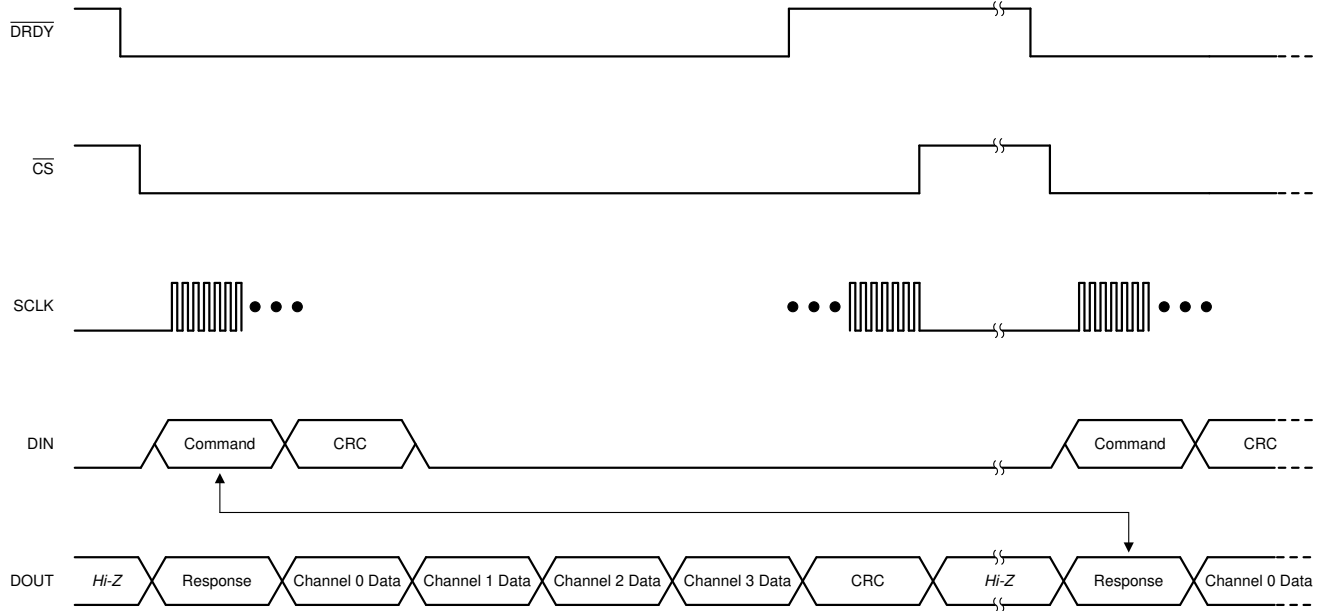
The  $\overline{\text{SYNC/RESET}}$  pin is a multifunction digital input pin that serves primarily to allow the host to synchronize conversions to an external process or to reset the device. See the [Synchronization](#) section for more details regarding the synchronization function. See the  [\$\overline{\text{SYNC/RESET}}\$  Pin](#) section for more details regarding how the device is reset.

#### 8.5.1.7 SPI Communication Frames

SPI communication on the ADS131M04-Q1 is performed in frames. Each SPI communication frame consists of several words. The word size is configurable as either 16 bits, 24 bits, or 32 bits by programming the  $\text{WLENGTH}[1:0]$  bits in the MODE register.

The ADS131M04-Q1 implements a timeout feature for SPI communication. Enable or disable the timeout using the  $\overline{\text{TIMEOUT}}$  bit in the MODE register. When enabled, the entire SPI frame (first SCLK to last SCLK) must complete within  $2^{15}$  CLKIN cycles otherwise the SPI resets. This feature is provided as a means to recover SPI synchronization for cases where CS is tied low.

The interface is full duplex, meaning that the interface is capable of transmitting data on DOUT while simultaneously receiving data on DIN. The input frame that the host sends on DIN always begins with a command. The first word on the output frame that the device transmits on DOUT always begins with the response to the command that was written on the previous input frame. The number of words in a command depends on the command provided. For most commands, there are six words in a frame. On DIN, the host provides the command, the command CRC if input CRC is enabled or a word of zeros if input CRC is disabled, and four additional words of zeros. Simultaneously on DOUT, the device outputs the response from the previous frame command, four words of ADC data representing the four ADC channels, and a CRC word. [Figure 8-18](#) illustrates a typical command frame structure.



**Figure 8-18. Typical Communication Frame**

There are some commands that require more than six words. In the case of a read register (RREG) command where more than a single register is read, the response to the command contains the acknowledgment of the command followed by the register contents requested, which may require a larger frame depending on how many registers are read. See the [RREG \(010a aaaa annn nnnn\)](#) section for more details on the RREG command.

In the case of a write register (WREG) command where more than a single register is written, the frame extends to accommodate the additional data. See the [WREG \(011a aaaa annn nnnn\)](#) section for more details on the WREG command.

See the [Commands](#) section for a list of all valid commands and their corresponding responses on the ADS131M04-Q1.

Under special circumstances, a data frame can be shortened by the host. See the [Short SPI Frames](#) section for more information about artificially shortening communication frames.

### 8.5.1.8 SPI Communication Words

An SPI communication frame with the ADS131M04-Q1 is made of words. Words on DIN can contain commands, register settings during a register write, or a CRC of the input data. Words on DOUT can contain command responses, register settings during a register read, ADC conversion data, or CRC of the output data.

Words can be 16, 24, or 32 bits. The word size is configured by the WLENGTH[1:0] bits in the MODE register. The device defaults to a 24-bit word size. Commands, responses, CRC, and registers always contain 16 bits of actual data. These words are always most significant bit (MSB) aligned, and therefore the least significant bits (LSBs) are zero-padded to accommodate 24- or 32-bit word sizes. ADC conversion data are nominally 24 bits. The ADC truncates eight LSBs when the device is configured for 16-bit communication. There are two options for 32-bit communication available for ADC data that are configured by the WLENGTH[1:0] bits in the MODE register. Either the ADC data can be LSB padded with zeros or the data can be MSB sign extended.

### 8.5.1.9 ADC Conversion Data

The device provides conversion data for each channel at the data rate. The time when data are available relative to  $\overline{\text{DRDY}}$  asserting is determined by the channel phase calibration setting and the DRDY\_SEL[1:0] bits in the MODE register when in continuous-conversion mode. All data are available immediately following  $\overline{\text{DRDY}}$  assertion in global-chop mode. The conversion status of all channels is available as the DRDY[3:0] bits in the STATUS register. The STATUS register content is automatically output as the response to the NULL command.

Conversion data are 24 bits. The data LSBs are truncated when the device operates with a 16-bit word size. The LSBs are zero padded or the MSBs sign extended when operating with a 32-bit word size depending on the setting of the WLENGTH[1:0] bits in the MODE register.

Data are given in binary two's complement format. Use [Equation 10](#) to calculate the size of one code (LSB).

$$1 \text{ LSB} = (2.4 / \text{Gain}) / 2^{24} = +\text{FSR} / 2^{23} \quad (10)$$

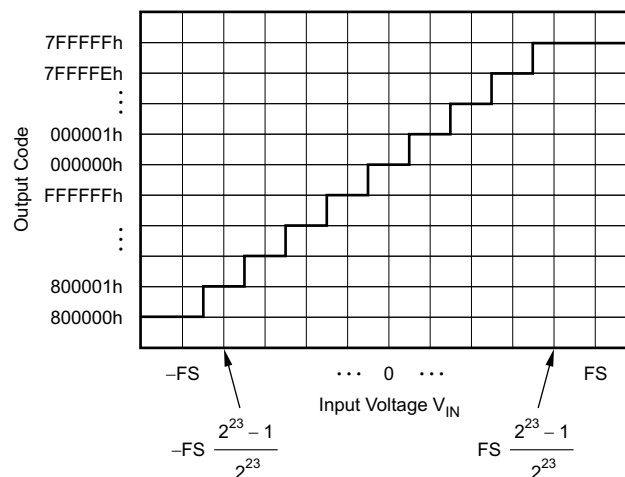
A positive full-scale input  $V_{\text{IN}} \geq +\text{FSR} - 1 \text{ LSB} = 1.2 / \text{Gain} - 1 \text{ LSB}$  produces an output code of 7FFFFFFh and a negative full-scale input ( $V_{\text{IN}} \leq -\text{FSR} = -1.2 / \text{Gain}$ ) produces an output code of 800000h. The output clips at these codes for signals that exceed full-scale.

[Table 8-10](#) summarizes the ideal output codes for different input signals.

**Table 8-10. Ideal Output Code versus Input Signal**

| INPUT SIGNAL,<br>$V_{\text{IN}} = V_{\text{AINP}} - V_{\text{AINN}}$ | IDEAL OUTPUT CODE |
|----------------------------------------------------------------------|-------------------|
| $\geq \text{FSR} (2^{23} - 1) / 2^{23}$                              | 7FFFFFFh          |
| $\text{FSR} / 2^{23}$                                                | 000001h           |
| 0                                                                    | 000000h           |
| $-\text{FSR} / 2^{23}$                                               | FFFFFFh           |
| $\leq -\text{FSR}$                                                   | 800000h           |

[Figure 8-19](#) shows the mapping of the analog input signal to the output codes.

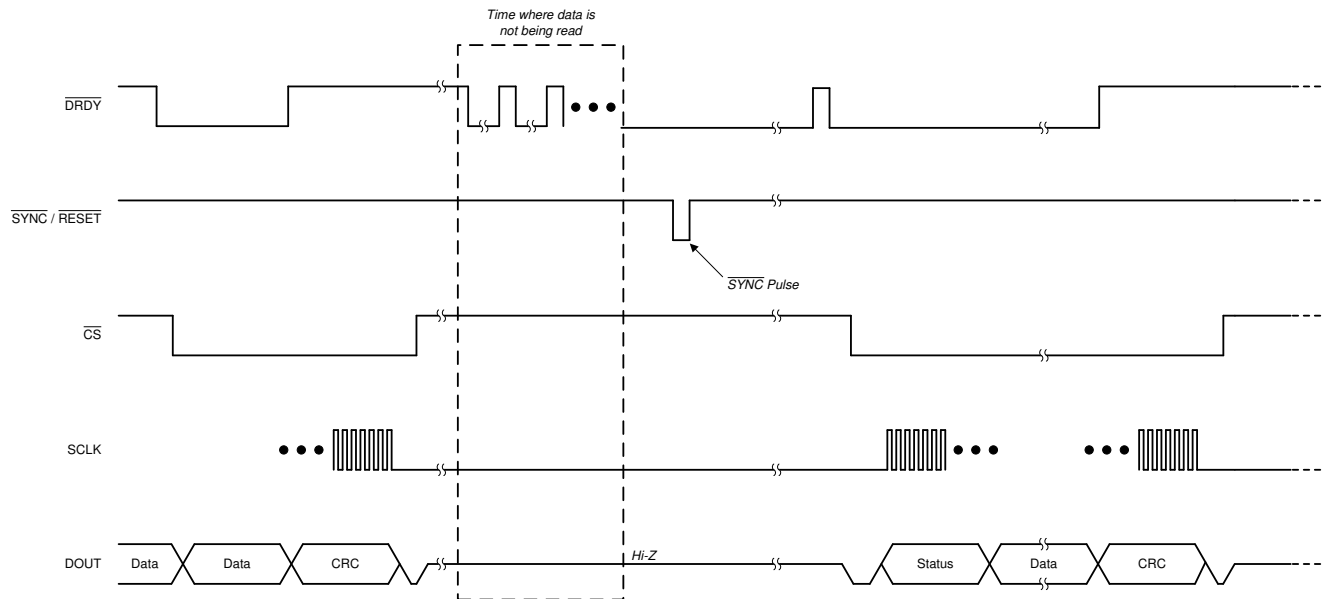


**Figure 8-19. Code Transition Diagram**

#### 8.5.1.9.1 Collecting Data for the First Time or After a Pause in Data Collection

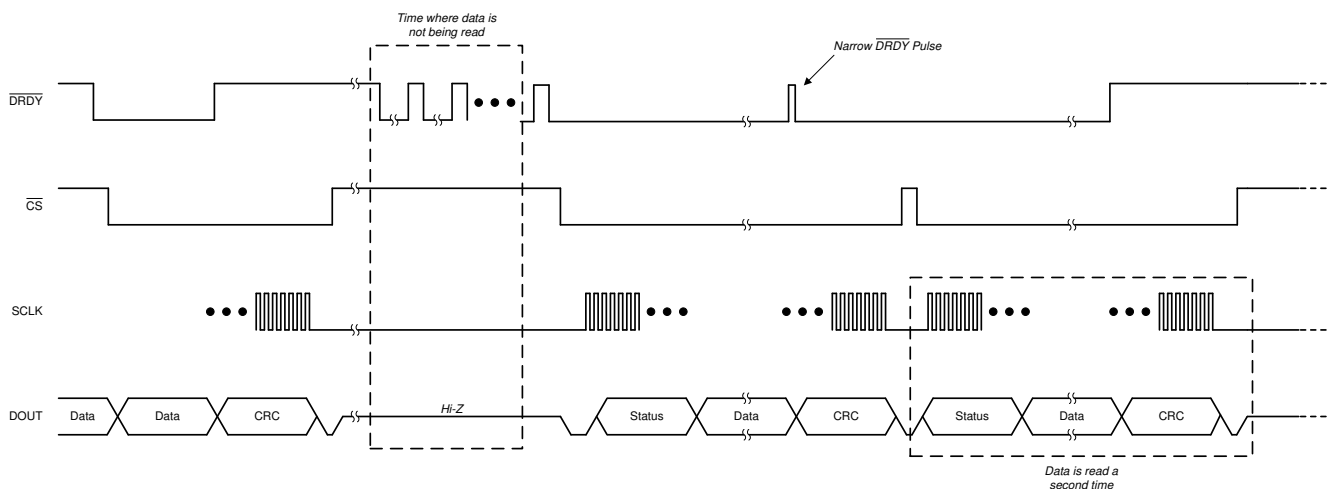
Take special precaution when collecting data for the first time or when beginning to collect data again after a pause. The internal mechanism that outputs data contains a first-in-first-out (FIFO) buffer that can store two samples of data per channel at a time. The DRDY flag for each channel in the STATUS register remains set until both samples for each channel are read from the device. This condition is not obvious under normal circumstances when the host is reading each consecutive sample from the device. In that case, the samples are cleared from the device each time new data are generated so the DRDY flag for each channel in the STATUS register is cleared with each read. However, both slots of the FIFO are full if a sample is missed or if data are not read for a period of time. Either strobe the SYNC/RESET pin to re-synchronize conversions and clear the FIFOs, or quickly read two data packets when data are read for the first time or after a gap in reading data. This process ensures predictable DRDY pin behavior. See the [Synchronization](#) section for information about the synchronization feature. These methods do not need to be employed if each channel data was read for each output data period from when the ADC was enabled.

Figure 8-20 depicts an example of how to collect data after a period of the ADC running, but where no data are being retrieved. In this instance, the SYNC/RESET pin is used to clear the internal FIFOs and realign the ADS131M04-Q1 output data with the host.



**Figure 8-20. Collecting Data After a Pause in Data Collection Using the SYNC/RESET Pin**

Another functionally equivalent method for clearing the FIFO after a pause in collecting data is to begin by reading two samples in quick succession. Figure 8-21 depicts this method. This example shows when the DRDY\_FMT bit in the MODE register is set to 0b indicating DRDY is a level output. There is a very narrow pulse on DRDY immediately after the first set of data are shifted out of the device. This pulse may be too narrow for some microcontrollers to detect. Therefore, do not rely upon this pulse but instead immediately read out the second data set after the first data set. The host operates synchronous to the device after the second word is read from the device.



**Figure 8-21. Collecting Data After a Pause in Data Collection by Reading Data Twice**

### 8.5.1.10 Commands

Table 8-11 contains a list of all valid commands, a short description of their functionality, their binary command word, and the expected response that appears in the following frame.

**Table 8-11. Command Definitions**

| COMMAND | DESCRIPTION                                                                     | COMMAND WORD        | RESPONSE                                                       |
|---------|---------------------------------------------------------------------------------|---------------------|----------------------------------------------------------------|
| NULL    | No operation                                                                    | 0000 0000 0000 0000 | STATUS register                                                |
| RESET   | Reset the device                                                                | 0000 0000 0001 0001 | 1111 1111 0010 0100                                            |
| STANDBY | Place the device into standby mode                                              | 0000 0000 0010 0010 | 0000 0000 0010 0010                                            |
| WAKEUP  | Wake the device from standby mode to conversion mode                            | 0000 0000 0011 0011 | 0000 0000 0011 0011                                            |
| LOCK    | Lock the interface such that only the NULL, UNLOCK, and RREG commands are valid | 0000 0101 0101 0101 | 0000 0101 0101 0101                                            |
| UNLOCK  | Unlock the interface after the interface is locked                              | 0000 0110 0101 0101 | 0000 0110 0101 0101                                            |
| RREG    | Read <i>nnn nnnn</i> plus 1 registers beginning at address <i>a aaaa a</i>      | 101a aaaa annn nnnn | dddd dddd dddd dddd<br>or<br>111a aaa annn nnnn <sup>(1)</sup> |
| WREG    | Write <i>nnn nnnn</i> plus 1 registers beginning at address <i>a aaaa a</i>     | 011a aaaa annn nnnn | 010a aaaa ammm mmmm <sup>(2)</sup>                             |

(1) When *nnn nnnn* is 0, the response is the requested register data *dddd dddd dddd dddd*. When *nnn nnnn* is greater than 0, the response begins with 111a aaaa annn nnnn, followed by the register data.

(2) In this case *mmm mmmm* represents the number of registers that are actually written minus one. This value may be less than *nnn nnnn* in some cases.

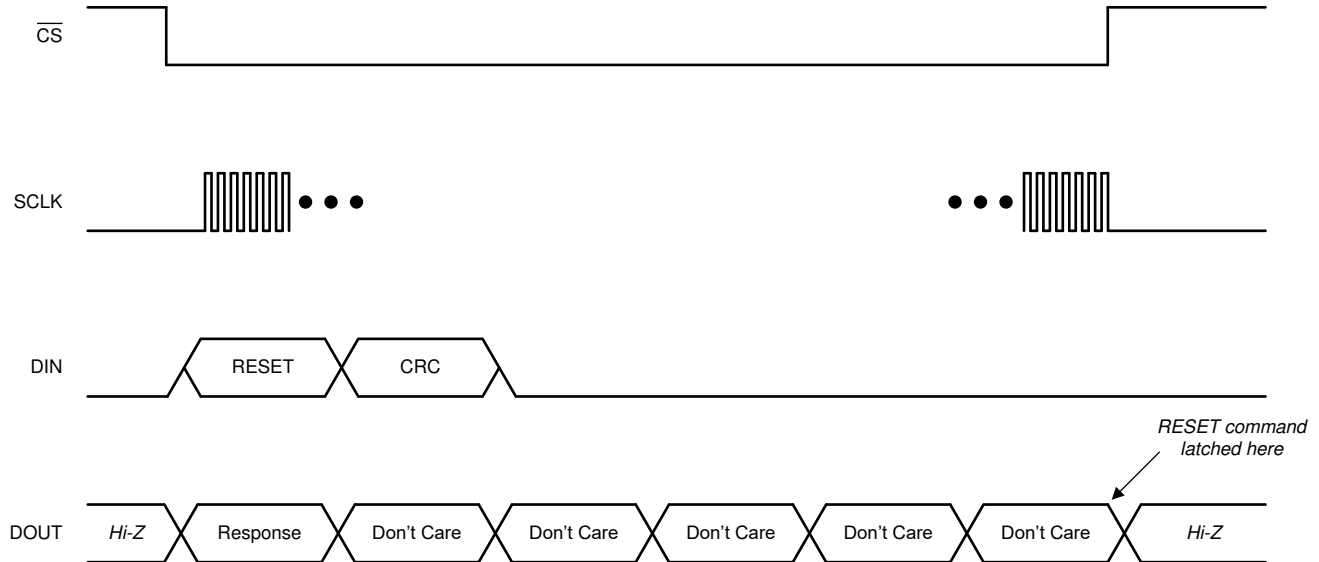
#### 8.5.1.10.1 NULL (0000 0000 0000 0000)

The NULL command is the *no-operation* command that results in no registers read or written, and the state of the device remains unchanged. The intended use case for the NULL command is during ADC data capture. The command response for the NULL command is the contents of the STATUS register. Any invalid command also gives the NULL response.

#### 8.5.1.10.2 RESET (0000 0000 0001 0001)

The RESET command resets the ADC to the register defaults. The command is latched by the device at the end of the frame. A reset occurs immediately after the command is latched. The host must wait for  $t_{\text{REGACQ}}$  after reset before communicating with the device to ensure the registers have assumed their default settings. The device sends an acknowledgment of FF24h when the ADC is properly RESET. The device responds with 0011h if the command word is sent but the frame is not completed and therefore the device is not reset. See the [RESET Command](#) section for more information regarding the operation of the reset command. [Figure 8-22](#) illustrates a properly sent RESET command frame.





**Figure 8-22. RESET Command Frame**

#### 8.5.1.10.3 STANDBY (0000 0000 0010 0010)

The STANDBY command places the device in a low-power standby mode. The command is latched by the device at the end of the frame. The device enters standby mode immediately after the command is latched. See the [Standby Mode](#) section for more information. This command has no effect if the device is already in standby mode.

#### 8.5.1.10.4 WAKEUP (0000 0000 0011 0011)

The WAKEUP command returns the device to conversion mode from standby mode. This command has no effect if the device is already in conversion mode.

#### 8.5.1.10.5 LOCK (0000 0101 0101 0101)

The LOCK command locks the interface, preventing the device from accidentally latching unwanted commands that can change the state of the device. When the interface is locked, the device only responds to the NULL, RREG, and UNLOCK commands. The device continues to output conversion data even when locked.

#### 8.5.1.10.6 UNLOCK (0000 0110 0101 0101)

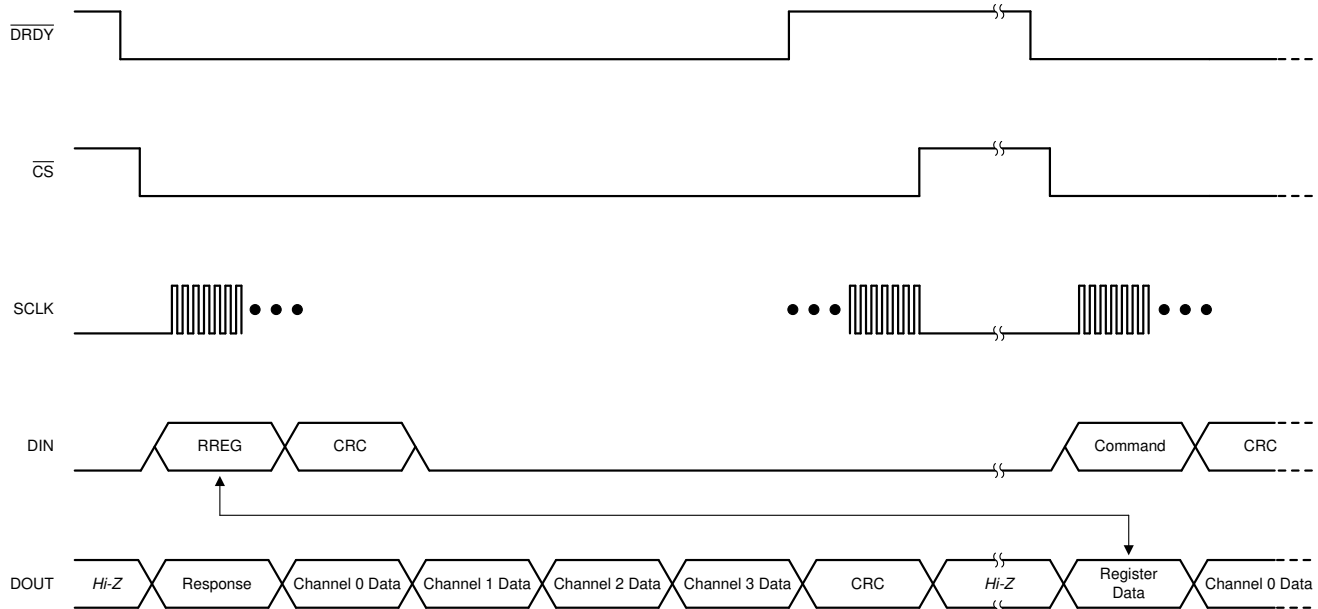
The UNLOCK command unlocks the interface if previously locked by the LOCK command.

#### 8.5.1.10.7 RREG (101a aaaa annn nnnn)

The RREG is used to read the device registers. The binary format of the command word is 101a aaaa annn nnnn, where a aaaa a is the binary address of the register to begin reading and nnn nnnn is the unsigned binary number of consecutive registers to read minus one. There are two cases for reading registers on the ADS131M04-Q1. When reading a single register (nnn nnnn = 000 0000b), the device outputs the register contents in the command response word of the following frame. If multiple registers are read using a single command (nnn nnnn > 000 0000b), the device outputs the requested register data sequentially in order of addresses.

#### 8.5.1.10.7.1 Reading a Single Register

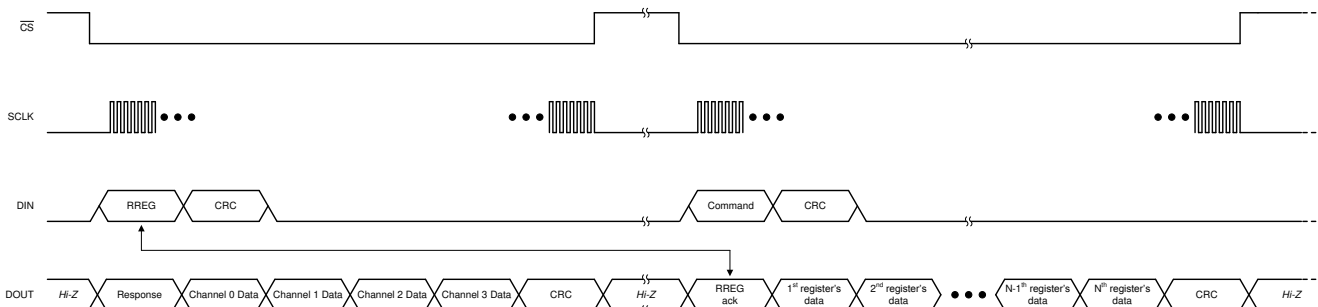
Read a single register from the device by specifying *nnn nnnn* as zero in the RREG command word. As with all SPI commands on the ADS131M04-Q1, the response occurs on the output in the frame following the command. Instead of a unique acknowledgment word, the response word is the contents of the register whose address is specified in the command word. [Figure 8-23](#) shows an example of reading a single register.



**Figure 8-23. Reading a Single Register**

#### 8.5.1.10.7.2 Reading Multiple Registers

Multiple registers are read from the device when *nnn nnnn* is specified as a number greater than zero in the RREG command word. Like all SPI commands on the ADS131M04-Q1, the response occurs on the output in the frame following the command. Instead of a single acknowledgment word, the response spans multiple words in order to shift out all requested registers. Continue toggling  $\text{SCLK}$  to accommodate outputting the entire data stream. ADC conversion data are not output in the frame following an RREG command to read multiple registers. [Figure 8-24](#) shows an example of reading multiple registers.



**Figure 8-24. Reading Multiple Registers**

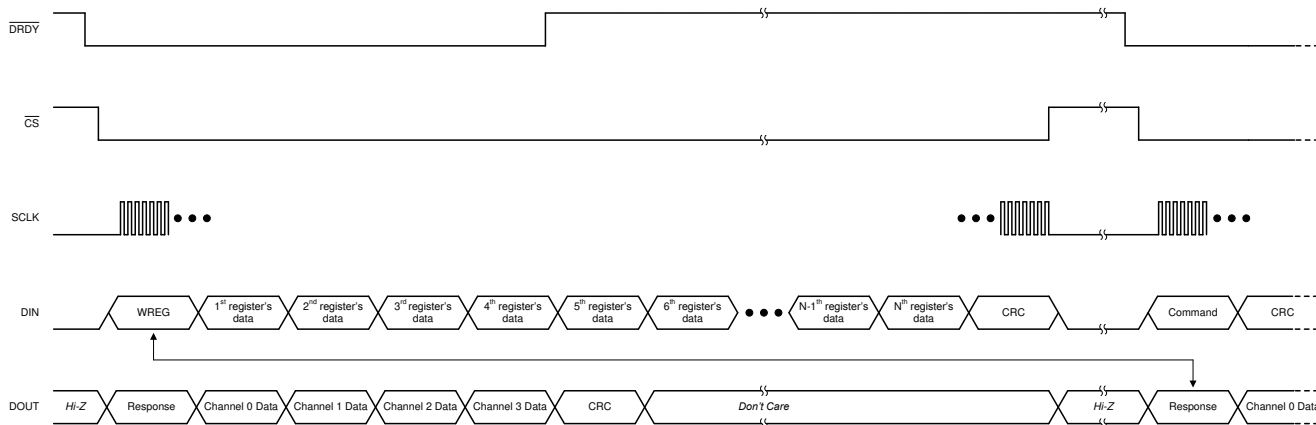
#### 8.5.1.10.8 WREG (011a aaaa annn nnnn)

The WREG command allows writing an arbitrary number of contiguous device registers. The binary format of the command word is 011a aaaa annn nnnn, where a aaaa a is the binary address of the register to begin writing and nnn nnnn is the unsigned binary number of consecutive registers to write minus one. Send the data to be written immediately following the command word. Write the intended contents of each register into individual words, MSB aligned.

If the input CRC is enabled, write this CRC after the register data. The registers are written to the device as they are shifted into DIN. Therefore, a CRC error does not prevent an erroneous value from being written to a register. An input CRC error during a WREG command sets the CRC\_ERR bit in the STATUS register.

The device ignores writes to read-only registers or to out-of-bounds addresses. Gaps in the register map address space are still included in the parameter nnn nnnn, but are not writeable so no change is made to them. The response to the WREG command that occurs in the following frame appears as 010a aaaa ammm mmmm where mmm mmmm is the number of registers actually written minus one. This number can be checked by the host against nnn nnnn to ensure the expected number of registers are written.

Figure 8-25 shows a typical WREG sequence. In this example, the number of registers to write is larger than the number of ADC channels and, therefore, the frame is extended beyond the ADC channels and output CRC word. Ensure all of the ADC data and output CRC are shifted out during each transaction where new data are available. Therefore, the frame must be extended beyond the number of words required to send the register data in some cases.



**Figure 8-25. Writing Registers**

#### 8.5.1.11 Short SPI Frames

The SPI frame can be shortened to only send commands and receive responses if the ADCs are disabled and no ADC data are being output by the device. Read out all of the expected output data words from each sample period if the ADCs are enabled. Reading all of the data output with each frame ensures predictable DRDY pin behavior. If reading out all the data on each output data period is not feasible, see the [Collecting Data for the First Time or After a Pause in Data Collection](#) section on how to begin reading data again after a pause from when the ADCs were last enabled.

A short frame is not possible when using the RESET command. A full frame must be provided for a device reset to take place when providing the RESET command.

### 8.5.2 Synchronization

Synchronization can be performed by the host to ensure the ADC conversions are synchronized to an external event. For example, synchronization can realign the data capture to the expected timing of the host if a glitch on the clock causes the host and device to become out of synchronization.

Provide a negative pulse on the  $\overline{\text{SYNC/RESET}}$  pin with a duration less than  $t_{w(RSL)}$  but greater than a CLKIN period to trigger synchronization. The device internally compares the leading negative edge of the pulse to the internal clock that tracks the data rate. The internal data rate clock has timing equivalent to the  $\overline{\text{DRDY}}$  pin if configured to assert with a phase calibration setting of 0b. If the negative edge on  $\overline{\text{SYNC/RESET}}$  aligns with the internal data rate clock, the device is determined to be synchronized and therefore no action is taken. If there is misalignment, the digital filters on the device are reset to be synchronized with the  $\overline{\text{SYNC/RESET}}$  pulse. Conversions are immediately restarted when the  $\overline{\text{SYNC/RESET}}$  pin is toggled in global-chop mode.

The phase calibration settings on all channels are retained during synchronization. Thus, channels with non-zero phase calibration settings generate conversion results less than a data rate period after the synchronization event occurs. However, the results can be corrupted and are not settled until the respective channels have at least three conversion cycles for the sinc<sup>3</sup> filter to settle.

## 8.6 ADS131M04-Q1 Registers

Table 8-12 lists the ADS131M04-Q1 registers. All register offset addresses not listed in Table 8-12 should be considered as reserved locations and the register contents should not be modified.

**Table 8-12. Register Map**

| ADDRESS                                              | REGISTER     | RESET<br>VALUE | BIT 15          | BIT 14        | BIT 13    | BIT 12      | BIT 11        | BIT 10        | BIT 9        | BIT 8    |
|------------------------------------------------------|--------------|----------------|-----------------|---------------|-----------|-------------|---------------|---------------|--------------|----------|
|                                                      |              |                | BIT 7           | BIT 6         | BIT 5     | BIT 4       | BIT 3         | BIT 2         | BIT 1        | BIT 0    |
| DEVICE SETTINGS AND INDICATORS (Read-Only Registers) |              |                |                 |               |           |             |               |               |              |          |
| 00h                                                  | ID           | 24xxh          | RESERVED        |               |           |             | CHANCNT[3:0]  |               |              |          |
|                                                      |              |                | RESERVED        |               |           |             |               |               |              |          |
| 01h                                                  | STATUS       | 0500h          | LOCK            | F_RESYNC      | REG_MAP   | CRC_ERR     | CRC_TYPE      | RESET         | WLENGTH[1:0] |          |
|                                                      |              |                | RESERVED        |               |           |             | DRDY3         | DRDY2         | DRDY1        | DRDY0    |
| GLOBAL SETTINGS ACROSS CHANNELS                      |              |                |                 |               |           |             |               |               |              |          |
| 02h                                                  | MODE         | 0510h          | RESERVED        |               | REGCRC_EN | RX_CRC_EN   | CRC_TYPE      | RESET         | WLENGTH[1:0] |          |
|                                                      |              |                | RESERVED        |               |           | TIMEOUT     | DRDY_SEL[1:0] |               | DRDY_HIz     | DRDY_FMT |
| 03h                                                  | CLOCK        | 0F0Eh          | RESERVED        |               |           |             | CH3_EN        | CH2_EN        | CH1_EN       | CH0_EN   |
|                                                      |              |                | RESERVED        |               | TBM       | OSR[2:0]    |               |               | PWR[1:0]     |          |
| 04h                                                  | GAIN1        | 0000h          | RESERVED        | PGAGAIN3[2:0] |           |             | RESERVED      | PGAGAIN2[2:0] |              |          |
|                                                      |              |                | RESERVED        | PGAGAIN1[2:0] |           |             | RESERVED      | PGAGAIN0[2:0] |              |          |
| 06h                                                  | CFG          | 0600h          | RESERVED        |               |           | GC_DLY[3:0] |               |               |              | GC_EN    |
|                                                      |              |                | CD_ALLCH        | CD_NUM[2:0]   |           |             | CD_LEN[2:0]   |               |              | CD_EN    |
| 07h                                                  | THRSHLD_MSB  | 0000h          | CD_TH_MSB[15:8] |               |           |             |               |               |              |          |
|                                                      |              |                | CD_TH_MSB[7:0]  |               |           |             |               |               |              |          |
| 08h                                                  | THRSHLD_LSB  | 0000h          | CD_TH_LSB[7:0]  |               |           |             |               |               |              |          |
|                                                      |              |                | RESERVED        |               |           |             | DCBLOCK[3:0]  |               |              |          |
| CHANNEL-SPECIFIC SETTINGS                            |              |                |                 |               |           |             |               |               |              |          |
| 09h                                                  | CH0_CFG      | 0000h          | PHASE0[9:2]     |               |           |             |               |               |              |          |
|                                                      |              |                | PHASE0[1:0]     |               | RESERVED  |             |               | DCBLK0_DIS0   | MUX0[1:0]    |          |
| 0Ah                                                  | CH0_OCAL_MSB | 0000h          | OCAL0_MSB[15:8] |               |           |             |               |               |              |          |
|                                                      |              |                | OCAL0_MSB[7:0]  |               |           |             |               |               |              |          |
| 0Bh                                                  | CH0_OCAL_LSB | 0000h          | OCAL0_LSB[7:0]  |               |           |             |               |               |              |          |
|                                                      |              |                | RESERVED        |               |           |             |               |               |              |          |
| 0Ch                                                  | CH0_GCAL_MSB | 8000h          | GCAL0_MSB[15:8] |               |           |             |               |               |              |          |
|                                                      |              |                | GCAL0_MSB[7:0]  |               |           |             |               |               |              |          |
| 0Dh                                                  | CH0_GCAL_LSB | 0000h          | GCAL0_LSB[7:0]  |               |           |             |               |               |              |          |
|                                                      |              |                | RESERVED        |               |           |             |               |               |              |          |
| 0Eh                                                  | CH1_CFG      | 0000h          | PHASE1[9:2]     |               |           |             |               |               |              |          |
|                                                      |              |                | PHASE1[1:0]     |               | RESERVED  |             |               | DCBLK1_DIS0   | MUX1[1:0]    |          |
| 0Fh                                                  | CH1_OCAL_MSB | 0000h          | OCAL1_MSB[15:8] |               |           |             |               |               |              |          |
|                                                      |              |                | OCAL1_MSB[7:0]  |               |           |             |               |               |              |          |
| 10h                                                  | CH1_OCAL_LSB | 0000h          | OCAL1_LSB[7:0]  |               |           |             |               |               |              |          |
|                                                      |              |                | RESERVED        |               |           |             |               |               |              |          |
| 11h                                                  | CH1_GCAL_MSB | 8000h          | GCAL1_MSB[15:8] |               |           |             |               |               |              |          |
|                                                      |              |                | GCAL1_MSB[7:0]  |               |           |             |               |               |              |          |
| 12h                                                  | CH1_GCAL_LSB | 0000h          | GCAL1_LSB[7:0]  |               |           |             |               |               |              |          |
|                                                      |              |                | RESERVED        |               |           |             |               |               |              |          |
| 13h                                                  | CH2_CFG      | 0000h          | PHASE2[9:2]     |               |           |             |               |               |              |          |
|                                                      |              |                | PHASE2[1:0]     |               | RESERVED  |             |               | DCBLK2_DIS0   | MUX2[1:0]    |          |
| 14h                                                  | CH2_OCAL_MSB | 0000h          | OCAL2_MSB[15:8] |               |           |             |               |               |              |          |
|                                                      |              |                | OCAL2_MSB[7:0]  |               |           |             |               |               |              |          |
| 15h                                                  | CH2_OCAL_LSB | 0000h          | OCAL2_LSB[7:0]  |               |           |             |               |               |              |          |
|                                                      |              |                | RESERVED        |               |           |             |               |               |              |          |
| 16h                                                  | CH2_GCAL_MSB | 8000h          | GCAL2_MSB[15:8] |               |           |             |               |               |              |          |
|                                                      |              |                | GCAL2_MSB[7:0]  |               |           |             |               |               |              |          |
| 17h                                                  | CH2_GCAL_LSB | 0000h          | GCAL2_LSB[7:0]  |               |           |             |               |               |              |          |
|                                                      |              |                | RESERVED        |               |           |             |               |               |              |          |

**Table 8-12. Register Map (continued)**

| ADDRESS                                 | REGISTER     | RESET<br>VALUE | BIT 15          | BIT 14 | BIT 13   | BIT 12 | BIT 11 | BIT 10      | BIT 9     | BIT 8 |
|-----------------------------------------|--------------|----------------|-----------------|--------|----------|--------|--------|-------------|-----------|-------|
|                                         |              |                | BIT 7           | BIT 6  | BIT 5    | BIT 4  | BIT 3  | BIT 2       | BIT 1     | BIT 0 |
| 18h                                     | CH3_CFG      | 0000h          | PHASE3[9:2]     |        |          |        |        |             |           |       |
|                                         |              |                | PHASE3[1:0]     |        | RESERVED |        |        | DCBLK3_DIS0 | MUX3[1:0] |       |
| 19h                                     | CH3_OCAL_MSB | 0000h          | OCAL3_MSB[15:8] |        |          |        |        |             |           |       |
|                                         |              |                | OCAL3_MSB[7:0]  |        |          |        |        |             |           |       |
| 1Ah                                     | CH3_OCAL_LSB | 0000h          | OCAL3_LSB[7:0]  |        |          |        |        |             |           |       |
|                                         |              |                | RESERVED        |        |          |        |        |             |           |       |
| 1Bh                                     | CH3_GCAL_MSB | 8000h          | GCAL3_MSB[15:8] |        |          |        |        |             |           |       |
|                                         |              |                | GCAL3_MSB[7:0]  |        |          |        |        |             |           |       |
| 1Ch                                     | CH3_GCAL_LSB | 0000h          | GCAL3_LSB[7:0]  |        |          |        |        |             |           |       |
|                                         |              |                | RESERVED        |        |          |        |        |             |           |       |
| REGISTER MAP CRC AND RESERVED REGISTERS |              |                |                 |        |          |        |        |             |           |       |
| 3Eh                                     | REGMAP_CRC   | 0000h          | REG_CRC[15:8]   |        |          |        |        |             |           |       |
|                                         |              |                | REG_CRC[7:0]    |        |          |        |        |             |           |       |
| 3Fh                                     | RESERVED     | 0000h          | RESERVED        |        |          |        |        |             |           |       |
|                                         |              |                | RESERVED        |        |          |        |        |             |           |       |

Complex bit access types are encoded to fit into small table cells. [Table 8-13](#) shows the codes that are used for access types in this section.

**Table 8-13. Access Type Codes**

| Access Type            | Code | Description                            |
|------------------------|------|----------------------------------------|
| Read Type              |      |                                        |
| R                      | R    | Read                                   |
| Write Type             |      |                                        |
| W                      | W    | Write                                  |
| Reset or Default Value |      |                                        |
| -n                     |      | Value after reset or the default value |

### 8.6.1 ID Register (Address = 0h) [reset = 24xxh]

The ID register is shown in [Figure 8-26](#) and described in [Table 8-14](#).

Return to the [Summary Table](#).

**Figure 8-26. ID Register**

|           |    |    |    |              |    |   |   |
|-----------|----|----|----|--------------|----|---|---|
| 15        | 14 | 13 | 12 | 11           | 10 | 9 | 8 |
| RESERVED  |    |    |    | CHANCNT[3:0] |    |   |   |
| R-0010b   |    |    |    | R-0100b      |    |   |   |
| 7         | 6  | 5  | 4  | 3            | 2  | 1 | 0 |
| RESERVED  |    |    |    |              |    |   |   |
| R-xxxxxxx |    |    |    |              |    |   |   |

**Table 8-14. ID Register Field Descriptions**

| Bit   | Field        | Type | Reset   | Description                                              |
|-------|--------------|------|---------|----------------------------------------------------------|
| 15:12 | RESERVED     | R    | 0010b   | Reserved<br>Always reads 0010b                           |
| 11:8  | CHANCNT[3:0] | R    | 0100b   | Channel count. Always reads 0100b.                       |
| 7:0   | RESERVED     | R    | xxxxxxx | Reserved<br>Values are subject to change without notice. |

## 8.6.2 STATUS Register (Address = 1h) [reset = 0500h]

The STATUS register is shown in [Figure 8-27](#) and described in [Table 8-15](#).

Return to the [Summary Table](#).

**Figure 8-27. STATUS Register**

|          |          |         |         |          |       |              |       |
|----------|----------|---------|---------|----------|-------|--------------|-------|
| 15       | 14       | 13      | 12      | 11       | 10    | 9            | 8     |
| LOCK     | F_RESYNC | REG_MAP | CRC_ERR | CRC_TYPE | RESET | WLENGTH[1:0] |       |
| R-0b     | R-0b     | R-0b    | R-0b    | R-0b     | R-1b  | R-01b        |       |
| 7        | 6        | 5       | 4       | 3        | 2     | 1            | 0     |
| RESERVED |          |         |         | DRDY3    | DRDY2 | DRDY1        | DRDY0 |
| R-0000b  |          |         |         | R-0b     | R-0b  | R-0b         | R-0b  |

**Table 8-15. STATUS Register Field Descriptions**

| Bit | Field        | Type | Reset | Description                                                                                                                                                     |
|-----|--------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15  | LOCK         | R    | 0b    | SPI interface lock indicator<br>0b = Unlocked (default)<br>1b = Locked                                                                                          |
| 14  | F_RESYNC     | R    | 0b    | ADC resynchronization indicator.<br>This bit is set each time the ADC resynchronizes.<br>0b = No resynchronization (default)<br>1b = Resynchronization occurred |
| 13  | REG_MAP      | R    | 0b    | Register map CRC fault indicator<br>0b = No change in the register map CRC (default)<br>1b = Register map CRC changed                                           |
| 12  | CRC_ERR      | R    | 0b    | SPI input CRC error indicator<br>0b = No CRC error (default)<br>1b = Input CRC error occurred                                                                   |
| 11  | CRC_TYPE     | R    | 0b    | CRC type<br>0b = 16-bit CCITT (default)<br>1b = 16-bit ANSI                                                                                                     |
| 10  | RESET        | R    | 1b    | Reset status<br>0b = Not reset<br>1b = Reset occurred (default)                                                                                                 |
| 9:8 | WLENGTH[1:0] | R    | 01b   | Data word length<br>00b = 16 bits<br>01b = 24 bits (default)<br>10b = 32 bits; zero padding<br>11b = 32 bits; sign extension for 24-bit ADC data                |
| 7:4 | RESERVED     | R    | 0000b | Reserved<br>Always reads 0000b                                                                                                                                  |



**Table 8-15. STATUS Register Field Descriptions (continued)**

| Bit | Field | Type | Reset | Description                                                                                         |
|-----|-------|------|-------|-----------------------------------------------------------------------------------------------------|
| 3   | DRDY3 | R    | 0b    | Channel 3 ADC data available indicator<br>0b = No new data available<br>1b = New data are available |
| 2   | DRDY2 | R    | 0b    | Channel 2 ADC data available indicator<br>0b = No new data available<br>1b = New data are available |
| 1   | DRDY1 | R    | 0b    | Channel 1 ADC data available indicator<br>0b = No new data available<br>1b = New data are available |
| 0   | DRDY0 | R    | 0b    | Channel 0 ADC data available indicator<br>0b = No new data available<br>1b = New data are available |

### 8.6.3 MODE Register (Address = 2h) [reset = 0510h]

The MODE register is shown in [Figure 8-28](#) and described in [Table 8-16](#).

Return to the [Summary Table](#).

**Figure 8-28. MODE Register**

|          |    |            |           |               |        |              |          |
|----------|----|------------|-----------|---------------|--------|--------------|----------|
| 15       | 14 | 13         | 12        | 11            | 10     | 9            | 8        |
| RESERVED |    | REG_CRC_EN | RX_CRC_EN | CRC_TYPE      | RESET  | WLENGTH[1:0] |          |
| R/W-00b  |    | R/W-0b     | R/W-0b    | R/W-0b        | R/W-1b | R/W-01b      |          |
| 7        | 6  | 5          | 4         | 3             | 2      | 1            | 0        |
| RESERVED |    |            | TIMEOUT   | DRDY_SEL[1:0] |        | DRDY_HiZ     | DRDY_FMT |
| R/W-000b |    |            | R/W-1b    | R/W-00b       |        | R/W-0b       | R/W-0b   |

**Table 8-16. MODE Register Field Descriptions**

| Bit   | Field        | Type | Reset | Description                                                                                                                                    |
|-------|--------------|------|-------|------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:14 | RESERVED     | R/W  | 00b   | Reserved<br>Always write 00b                                                                                                                   |
| 13    | REG_CRC_EN   | R/W  | 0b    | Register map CRC enable<br>0b = Register CRC disabled (default)<br>1b = Register CRC enabled                                                   |
| 12    | RX_CRC_EN    | R/W  | 0b    | SPI input CRC enable<br>0b = Disabled (default)<br>1b = Enabled                                                                                |
| 11    | CRC_TYPE     | R/W  | 0b    | SPI input and output, register map CRC type<br>0b = 16-bit CCITT (default)<br>1b = 16-bit ANSI                                                 |
| 10    | RESET        | R/W  | 1b    | Reset<br>Write 0b to clear this bit in the STATUS register<br>0b = No reset<br>1b = Reset occurred (default by definition)                     |
| 9:8   | WLENGTH[1:0] | R/W  | 01b   | Data word length selection<br>00b = 16 bits<br>01b = 24 bits (default)<br>10b = 32 bits; LSB zero padding<br>11b = 32 bits; MSB sign extension |
| 7:5   | RESERVED     | R/W  | 000b  | Reserved<br>Always write 000b                                                                                                                  |
| 4     | TIMEOUT      | R/W  | 1b    | SPI Timeout enable<br>0b = Disabled<br>1b = Enabled (default)                                                                                  |

**Table 8-16. MODE Register Field Descriptions (continued)**

| Bit | Field         | Type | Reset | Description                                                                                                                                                                                                                   |
|-----|---------------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 3:2 | DRDY_SEL[1:0] | R/W  | 00b   | <p>DRDY pin signal source selection</p> <p>00b = Most lagging enabled channel (default)</p> <p>01b = Logic OR of all enabled channels</p> <p>10b = Most leading enabled channel</p> <p>11b = Most leading enabled channel</p> |
| 1   | DRDY_HiZ      | R/W  | 0b    | <p>DRDY pin state when conversion data are not available</p> <p>0b = Logic high (default)</p> <p>1b = High impedance</p>                                                                                                      |
| 0   | DRDY_FMT      | R/W  | 0b    | <p>DRDY signal format when conversion data are available</p> <p>0b = Logic low (default)</p> <p>1b = Low pulse with a fixed duration</p>                                                                                      |

### 8.6.4 CLOCK Register (Address = 3h) [reset = 0F0Eh]

The CLOCK register is shown in [Figure 8-29](#) and described in [Table 8-17](#).

Return to the [Summary Table](#).

**Figure 8-29. CLOCK Register**

| 15       | 14 | 13     | 12       | 11     | 10     | 9        | 8      |
|----------|----|--------|----------|--------|--------|----------|--------|
| RESERVED |    |        |          | CH3_EN | CH2_EN | CH1_EN   | CH0_EN |
| R-0000b  |    |        |          | R/W-1b | R/W-1b | R/W-1b   | R/W-1b |
| 7        | 6  | 5      | 4        | 3      | 2      | 1        | 0      |
| RESERVED |    | TBM    | OSR[2:0] |        |        | PWR[1:0] |        |
| R/W-00b  |    | R/W-0b | R/W-011b |        |        | R/W-10b  |        |

**Table 8-17. CLOCK Register Field Descriptions**

| Bit   | Field    | Type | Reset | Description                                                                                                                                                                |
|-------|----------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:12 | RESERVED | R    | 0000b | Reserved<br>Always reads 0000b                                                                                                                                             |
| 11    | CH3_EN   | R/W  | 1b    | Channel 3 ADC enable<br><br>0b = Disabled<br>1b = Enabled (default)                                                                                                        |
| 10    | CH2_EN   | R/W  | 1b    | Channel 2 ADC enable<br><br>0b = Disabled<br>1b = Enabled (default)                                                                                                        |
| 9     | CH1_EN   | R/W  | 1b    | Channel 1 ADC enable<br><br>0b = Disabled<br>1b = Enabled (default)                                                                                                        |
| 8     | CH0_EN   | R/W  | 1b    | Channel 0 ADC enable<br><br>0b = Disabled<br>1b = Enabled (default)                                                                                                        |
| 7:6   | RESERVED | R/W  | 00b   | Reserved<br>Always write 00b                                                                                                                                               |
| 5     | TBM      | R/W  | 0b    | Modulator oversampling ratio 64 selection (turbo mode)<br><br>0b = OSR set by bits 4:2 (that is, OSR[2:0])<br>1b = OSR of 64 is selected                                   |
| 4:2   | OSR[2:0] | R/W  | 011b  | Modulator oversampling ratio selection<br><br>000b = 128<br>001b = 256<br>010b = 512<br>011b = 1024 (default)<br>100b = 2048<br>101b = 4096<br>110b = 8192<br>111b = 16384 |

**Table 8-17. CLOCK Register Field Descriptions (continued)**

| Bit | Field    | Type | Reset | Description                                                                                                                 |
|-----|----------|------|-------|-----------------------------------------------------------------------------------------------------------------------------|
| 1:0 | PWR[1:0] | R/W  | 10b   | Power mode selection<br>00b = Very-low-power<br>01b = Low-power<br>10b = High-resolution (default)<br>11b = High-resolution |

### 8.6.5 GAIN1 Register (Address = 4h) [reset = 0000h]

The GAIN1 register is shown in [Figure 8-30](#) and described in [Table 8-18](#).

Return to the [Summary Table](#).

**Figure 8-30. GAIN1 Register**

|          |               |    |    |          |               |   |   |
|----------|---------------|----|----|----------|---------------|---|---|
| 15       | 14            | 13 | 12 | 11       | 10            | 9 | 8 |
| RESERVED | PGAGAIN3[2:0] |    |    | RESERVED | PGAGAIN2[2:0] |   |   |
| R/W-0b   | R/W-000b      |    |    | R/W-0b   | R/W-000b      |   |   |
| 7        | 6             | 5  | 4  | 3        | 2             | 1 | 0 |
| RESERVED | PGAGAIN1[2:0] |    |    | RESERVED | PGAGAIN0[2:0] |   |   |
| R/W-0b   | R/W-000b      |    |    | R/W-0b   | R/W-000b      |   |   |

**Table 8-18. GAIN1 Register Field Descriptions**

| Bit   | Field         | Type | Reset | Description                                                                                                                                                                     |
|-------|---------------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15    | RESERVED      | R/W  | 0b    | Reserved<br>Always write 0b                                                                                                                                                     |
| 14:12 | PGAGAIN3[2:0] | R/W  | 000b  | PGA gain selection for channel 3<br><br>000b = 1 (default)<br><br>001b = 2<br><br>010b = 4<br><br>011b = 8<br><br>100b = 16<br><br>101b = 32<br><br>110b = 64<br><br>111b = 128 |
| 11    | RESERVED      | R/W  | 0b    | Reserved<br>Always write 0b                                                                                                                                                     |
| 10:8  | PGAGAIN2[2:0] | R/W  | 000b  | PGA gain selection for channel 2<br><br>000b = 1 (default)<br><br>001b = 2<br><br>010b = 4<br><br>011b = 8<br><br>100b = 16<br><br>101b = 32<br><br>110b = 64<br><br>111b = 128 |
| 7     | RESERVED      | R/W  | 0b    | Reserved<br>Always write 0b                                                                                                                                                     |

**Table 8-18. GAIN1 Register Field Descriptions (continued)**

| Bit | Field         | Type | Reset | Description                                                                                                                                                                     |
|-----|---------------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 6:4 | PGAGAIN1[2:0] | R/W  | 000b  | PGA gain selection for channel 1<br><br>000b = 1 (default)<br><br>001b = 2<br><br>010b = 4<br><br>011b = 8<br><br>100b = 16<br><br>101b = 32<br><br>110b = 64<br><br>111b = 128 |
| 3   | RESERVED      | R/W  | 0b    | Reserved<br>Always write 0b                                                                                                                                                     |
| 2:0 | PGAGAIN0[2:0] | R/W  | 000b  | PGA gain selection for channel 0<br><br>000b = 1 (default)<br><br>001b = 2<br><br>010b = 4<br><br>011b = 8<br><br>100b = 16<br><br>101b = 32<br><br>110b = 64<br><br>111b = 128 |

### 8.6.6 RESERVED Register (Address = 5h) [reset = 0000h]

The RESERVED register is shown in [Figure 8-31](#) and described in [Table 8-19](#).

Return to the [Summary Table](#).

**Figure 8-31. RESERVED Register**

|               |    |    |    |    |    |   |   |
|---------------|----|----|----|----|----|---|---|
| 15            | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| RESERVED      |    |    |    |    |    |   |   |
| R/W-00000000b |    |    |    |    |    |   |   |
| 7             | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| RESERVED      |    |    |    |    |    |   |   |
| R/W-00000000b |    |    |    |    |    |   |   |

**Table 8-19. RESERVED Register Field Descriptions**

| Bit  | Field    | Type | Reset                 | Description                                |
|------|----------|------|-----------------------|--------------------------------------------|
| 15:0 | RESERVED | R/W  | 00000000<br>00000000b | Reserved<br>Always write 0000000000000000b |



### 8.6.7 CFG Register (Address = 6h) [reset = 0600h]

The CFG register is shown in [Figure 8-32](#) and described in [Table 8-20](#).

Return to the [Summary Table](#).

**Figure 8-32. CFG Register**

|          |             |    |             |             |    |        |        |
|----------|-------------|----|-------------|-------------|----|--------|--------|
| 15       | 14          | 13 | 12          | 11          | 10 | 9      | 8      |
| RESERVED |             |    | GC_DLY[3:0] |             |    | GC_EN  |        |
| R/W-000b |             |    | R/W-0011b   |             |    | R/W-0b |        |
| 7        | 6           | 5  | 4           | 3           | 2  | 1      | 0      |
| CD_ALLCH | CD_NUM[2:0] |    |             | CD_LEN[2:0] |    |        | CD_EN  |
| R/W-0b   | R/W-000b    |    |             | R/W-000b    |    |        | R/W-0b |

**Table 8-20. CFG Register Field Descriptions**

| Bit   | Field       | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                          |
|-------|-------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:13 | RESERVED    | R/W  | 000b  | Reserved<br>Always write 000b                                                                                                                                                                                                                                                                                                                                                                                        |
| 12:9  | GC_DLY[3:0] | R/W  | 0011b | Global-chop delay selection<br>Delay in modulator clock periods before measurement begins<br><br>0000b = 2<br><br>0001b = 4<br><br>0010b = 8<br><br>0011b = 16 (default)<br><br>0100b = 32<br><br>0101b = 64<br><br>0110b = 128<br><br>0111b = 256<br><br>1000b = 512<br><br>1001b = 1024<br><br>1010b = 2048<br><br>1011b = 4096<br><br>1100b = 8192<br><br>1101b = 16384<br><br>1110b = 32768<br><br>1111b = 65536 |
| 8     | GC_EN       | R/W  | 0b    | Global-chop enable<br><br>0b = Disabled (default)<br><br>1b = Enabled                                                                                                                                                                                                                                                                                                                                                |
| 7     | CD_ALLCH    | R/W  | 0b    | Current-detect channel selection<br>Channels required to trigger current-detect<br><br>0b = Any channel (default)<br><br>1b = All channels                                                                                                                                                                                                                                                                           |

**Table 8-20. CFG Register Field Descriptions (continued)**

| Bit | Field       | Type | Reset | Description                                                                                                                                                                                                                                  |
|-----|-------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 6:4 | CD_NUM[2:0] | R/W  | 000b  | Number of current-detect exceeded thresholds selection<br>Number of current-detect exceeded thresholds to trigger a detection<br>000b = 1 (default)<br>001b = 2<br>010b = 4<br>011b = 8<br>100b = 16<br>101b = 32<br>110b = 64<br>111b = 128 |
| 3:1 | CD_LEN[2:0] | R/W  | 000b  | Current-detect measurement length selection<br>Current-detect measurement length in conversion periods<br>000b = 128 (default)<br>001b = 256<br>010b = 512<br>011b = 768<br>100b = 1280<br>101b = 1792<br>110b = 2560<br>111b = 3584         |
| 0   | CD_EN       | R/W  | 0b    | Current-detect mode enable<br>0b = Disabled (default)<br>1b = Enabled                                                                                                                                                                        |

### 8.6.8 THRSHLD\_MSB Register (Address = 7h) [reset = 0000h]

The THRSHLD\_MSB register is shown in [Figure 8-33](#) and described in [Table 8-21](#).

Return to the [Summary Table](#).

**Figure 8-33. THRSHLD\_MSB Register**

|                 |    |    |    |    |    |   |   |
|-----------------|----|----|----|----|----|---|---|
| 15              | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| CD_TH_MSB[15:8] |    |    |    |    |    |   |   |
| R/W-00000000b   |    |    |    |    |    |   |   |
| 7               | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| CD_TH_MSB[7:0]  |    |    |    |    |    |   |   |
| R/W-00000000b   |    |    |    |    |    |   |   |

**Table 8-21. THRSHLD\_MSB Register Field Descriptions**

| Bit  | Field           | Type | Reset                 | Description                       |
|------|-----------------|------|-----------------------|-----------------------------------|
| 15:0 | CD_TH_MSB[15:0] | R/W  | 00000000<br>00000000b | Current-detect mode threshold MSB |

### 8.6.9 THRSHLD\_LSB Register (Address = 8h) [reset = 0000h]

The THRSHLD\_LSB register is shown in [Figure 8-34](#) and described in [Table 8-22](#).

Return to the [Summary Table](#).

**Figure 8-34. THRSHLD\_LSB Register**

|                |    |    |    |           |    |   |   |
|----------------|----|----|----|-----------|----|---|---|
| 15             | 14 | 13 | 12 | 11        | 10 | 9 | 8 |
| CD_TH_LSB[7:0] |    |    |    |           |    |   |   |
| R/W-00000000b  |    |    |    |           |    |   |   |
| 7              | 6  | 5  | 4  | 3         | 2  | 1 | 0 |
| RESERVED       |    |    |    | DCBLOCK   |    |   |   |
| R-0000b        |    |    |    | R/W-0000b |    |   |   |

**Table 8-22. THRSHLD\_LSB Register Field Descriptions**

| Bit  | Field          | Type | Reset     | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
|------|----------------|------|-----------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:8 | CD_TH_LSB[7:0] | R/W  | 00000000b | Current-detect mode threshold LSB                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| 7:4  | RESERVED       | R    | 0000b     | Reserved<br>Always write 0000b                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 3:0  | DCBLOCK[3:0]   | R/W  | 0000b     | DC block filter setting, see <a href="#">Table 8-4</a> for details.<br>Value of coefficient <i>a</i><br><br>0000b = DC block filter disabled<br><br>0001b = 1/4<br><br>0010b = 1/8<br><br>0011b = 1/16<br><br>0100b = 1/32<br><br>0101b = 1/64<br><br>0110b = 1/128<br><br>0111b = 1/256<br><br>1000b = 1/512<br><br>1001b = 1/1024<br><br>1010b = 1/2048<br><br>1011b = 1/4096<br><br>1100b = 1/8192<br><br>1101b = 1/16384<br><br>1110b = 1/32768<br><br>1111b = 1/65536 |

### 8.6.10 CH0\_CFG Register (Address = 9h) [reset = 0000h]

The CH0\_CFG register is shown in [Figure 8-35](#) and described in [Table 8-23](#).

Return to the [Summary Table](#).

**Figure 8-35. CH0\_CFG Register**

|                 |    |          |    |    |             |           |   |
|-----------------|----|----------|----|----|-------------|-----------|---|
| 15              | 14 | 13       | 12 | 11 | 10          | 9         | 8 |
| PHASE0[9:2]     |    |          |    |    |             |           |   |
| R/W-0000000000b |    |          |    |    |             |           |   |
| 7               | 6  | 5        | 4  | 3  | 2           | 1         | 0 |
| PHASE0[1:0]     |    | RESERVED |    |    | DCBLK0_DIS0 | MUX0[1:0] |   |
| R/W-0000000000b |    | R-000b   |    |    | R/W-0b      | R/W-00b   |   |

**Table 8-23. CH0\_CFG Register Field Descriptions**

| Bit  | Field       | Type | Reset       | Description                                                                                                                                                |
|------|-------------|------|-------------|------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:6 | PHASE0[9:0] | R/W  | 0000000000b | Channel 0 phase delay<br>Phase delay in modulator clock cycles provided in two's complement format. See <a href="#">Table 8-5</a> for details.             |
| 5:3  | RESERVED    | R    | 000b        | Reserved<br>Always write 000b                                                                                                                              |
| 2    | DCBLK0_DIS0 | R/W  | 0b          | DC block filter for channel 0 disable<br>0b = Controlled by DCBLOCK[3:0] (default)<br>1b = Disabled for this channel                                       |
| 1:0  | MUX0[1:0]   | R/W  | 00b         | Channel 0 input selection<br>00b = AIN0P and AIN0N (default)<br>01b = ADC inputs shorted<br>10b = Positive DC test signal<br>11b = Negative DC test signal |

### 8.6.11 CH0\_OCAL\_MSB Register (Address = Ah) [reset = 0000h]

The CH0\_OCAL\_MSB register is shown in [Figure 8-36](#) and described in [Table 8-24](#).

Return to the [Summary Table](#).

**Figure 8-36. CH0\_OCAL\_MSB Register**

|                 |    |    |    |    |    |   |   |
|-----------------|----|----|----|----|----|---|---|
| 15              | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| OCAL0_MSB[15:8] |    |    |    |    |    |   |   |
| R/W-00000000b   |    |    |    |    |    |   |   |
| 7               | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| OCAL0_MSB[7:0]  |    |    |    |    |    |   |   |
| R/W-00000000b   |    |    |    |    |    |   |   |

**Table 8-24. CH0\_OCAL\_MSB Register Field Descriptions**

| Bit  | Field           | Type | Reset                 | Description                                       |
|------|-----------------|------|-----------------------|---------------------------------------------------|
| 15:0 | OCAL0_MSB[15:0] | R/W  | 00000000<br>00000000b | Channel 0 offset calibration register bits [23:8] |

### 8.6.12 CH0\_OCAL\_LSB Register (Address = Bh) [reset = 0000h]

The CH0\_OCAL\_LSB register is shown in [Figure 8-37](#) and described in [Table 8-25](#).

Return to the [Summary Table](#).

**Figure 8-37. CH0\_OCAL\_LSB Register**

|                |    |    |    |    |    |   |   |
|----------------|----|----|----|----|----|---|---|
| 15             | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| OCAL0_LSB[7:0] |    |    |    |    |    |   |   |
| R/W-00000000b  |    |    |    |    |    |   |   |
| 7              | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| RESERVED       |    |    |    |    |    |   |   |
| R-00000000b    |    |    |    |    |    |   |   |

**Table 8-25. CH0\_OCAL\_LSB Register Field Descriptions**

| Bit  | Field          | Type | Reset     | Description                                      |
|------|----------------|------|-----------|--------------------------------------------------|
| 15:8 | OCAL0_LSB[7:0] | R/W  | 00000000b | Channel 0 offset calibration register bits [7:0] |
| 7:0  | RESERVED       | R    | 00000000b | Reserved<br>Always reads 00000000b               |

### 8.6.13 CH0\_GCAL\_MSB Register (Address = Ch) [reset = 8000h]

The CH0\_GCAL\_MSB register is shown in [Figure 8-38](#) and described in [Table 8-26](#).

Return to the [Summary Table](#).

**Figure 8-38. CH0\_GCAL\_MSB Register**

|                 |    |    |    |    |    |   |   |
|-----------------|----|----|----|----|----|---|---|
| 15              | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| GCAL0_MSB[15:8] |    |    |    |    |    |   |   |
| R/W-10000000b   |    |    |    |    |    |   |   |
| 7               | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| GCAL0_MSB[7:0]  |    |    |    |    |    |   |   |
| R/W-00000000b   |    |    |    |    |    |   |   |

**Table 8-26. CH0\_GCAL\_MSB Register Field Descriptions**

| Bit  | Field           | Type | Reset                 | Description                                     |
|------|-----------------|------|-----------------------|-------------------------------------------------|
| 15:0 | GCAL0_MSB[15:0] | R/W  | 1000000000<br>000000b | Channel 0 gain calibration register bits [23:8] |

### 8.6.14 CH0\_GCAL\_LSB Register (Address = Dh) [reset = 0000h]

The CH0\_GCAL\_LSB register is shown in [Figure 8-39](#) and described in [Table 8-27](#).

Return to the [Summary Table](#).

**Figure 8-39. CH0\_GCAL\_LSB Register**

|                |    |    |    |    |    |   |   |
|----------------|----|----|----|----|----|---|---|
| 15             | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| GCAL0_LSB[7:0] |    |    |    |    |    |   |   |
| R/W-00000000b  |    |    |    |    |    |   |   |
| 7              | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| RESERVED       |    |    |    |    |    |   |   |
| R-00000000b    |    |    |    |    |    |   |   |

**Table 8-27. CH0\_GCAL\_LSB Register Field Descriptions**

| Bit  | Field          | Type | Reset     | Description                                    |
|------|----------------|------|-----------|------------------------------------------------|
| 15:8 | GCAL0_LSB[7:0] | R/W  | 00000000b | Channel 0 gain calibration register bits [7:0] |
| 7:0  | RESERVED       | R    | 00000000b | Reserved<br>Always reads 00000000b             |

### 8.6.15 CH1\_CFG Register (Address = Eh) [reset = 0000h]

The CH1\_CFG register is shown in [Figure 8-40](#) and described in [Table 8-28](#).

Return to the [Summary Table](#).

**Figure 8-40. CH1\_CFG Register**

|                 |    |          |    |    |             |           |   |
|-----------------|----|----------|----|----|-------------|-----------|---|
| 15              | 14 | 13       | 12 | 11 | 10          | 9         | 8 |
| PHASE1[9:2]     |    |          |    |    |             |           |   |
| R/W-0000000000b |    |          |    |    |             |           |   |
| 7               | 6  | 5        | 4  | 3  | 2           | 1         | 0 |
| PHASE1[1:0]     |    | RESERVED |    |    | DCBLK1_DIS0 | MUX1[1:0] |   |
| R/W-0000000000b |    | R-000b   |    |    | R/W-0b      | R/W-00b   |   |

**Table 8-28. CH1\_CFG Register Field Descriptions**

| Bit  | Field       | Type | Reset       | Description                                                                                                                                                |
|------|-------------|------|-------------|------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:6 | PHASE1[9:0] | R/W  | 0000000000b | Channel 1 phase delay<br>Phase delay in modulator clock cycles provided in two's complement format. See <a href="#">Table 8-5</a> for details.             |
| 5:3  | RESERVED    | R    | 000b        | Reserved<br>Always reads 000b                                                                                                                              |
| 2    | DCBLK1_DIS0 | R/W  | 0b          | DC block filter for channel 1 disable<br>0b = Controlled by DCBLOCK[3:0] (default)<br>1b = Disabled for this channel                                       |
| 1:0  | MUX1[1:0]   | R/W  | 00b         | Channel 1 input selection<br>00b = AIN1P and AIN1N (default)<br>01b = ADC inputs shorted<br>10b = Positive DC test signal<br>11b = Negative DC test signal |



### 8.6.16 CH1\_OCAL\_MSB Register (Address = Fh) [reset = 0000h]

The CH1\_OCAL\_MSB register is shown in [Figure 8-41](#) and described in [Table 8-29](#).

Return to the [Summary Table](#).

**Figure 8-41. CH1\_OCAL\_MSB Register**

|                 |    |    |    |    |    |   |   |
|-----------------|----|----|----|----|----|---|---|
| 15              | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| OCAL1_MSB[15:8] |    |    |    |    |    |   |   |
| R/W-00000000b   |    |    |    |    |    |   |   |
| 7               | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| OCAL1_MSB[7:0]  |    |    |    |    |    |   |   |
| R/W-00000000b   |    |    |    |    |    |   |   |

**Table 8-29. CH1\_OCAL\_MSB Register Field Descriptions**

| Bit  | Field           | Type | Reset                 | Description                                       |
|------|-----------------|------|-----------------------|---------------------------------------------------|
| 15:0 | OCAL1_MSB[15:0] | R/W  | 00000000<br>00000000b | Channel 1 offset calibration register bits [23:8] |

### 8.6.17 CH1\_OCAL\_LSB Register (Address = 10h) [reset = 0000h]

The CH1\_OCAL\_LSB register is shown in [Figure 8-42](#) and described in [Table 8-30](#).

Return to the [Summary Table](#).

**Figure 8-42. CH1\_OCAL\_LSB Register**

|                |    |    |    |    |    |   |   |
|----------------|----|----|----|----|----|---|---|
| 15             | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| OCAL1_LSB[7:0] |    |    |    |    |    |   |   |
| R/W-00000000b  |    |    |    |    |    |   |   |
| 7              | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| RESERVED       |    |    |    |    |    |   |   |
| R-00000000b    |    |    |    |    |    |   |   |

**Table 8-30. CH1\_OCAL\_LSB Register Field Descriptions**

| Bit  | Field          | Type | Reset     | Description                                      |
|------|----------------|------|-----------|--------------------------------------------------|
| 15:8 | OCAL1_LSB[7:0] | R/W  | 00000000b | Channel 1 offset calibration register bits [7:0] |
| 7:0  | RESERVED       | R    | 00000000b | Reserved<br>Always reads 00000000b               |

### 8.6.18 CH1\_GCAL\_MSB Register (Address = 11h) [reset = 8000h]

The CH1\_GCAL\_MSB register is shown in [Figure 8-43](#) and described in [Table 8-31](#).

Return to the [Summary Table](#).

**Figure 8-43. CH1\_GCAL\_MSB Register**

|                 |    |    |    |    |    |   |   |
|-----------------|----|----|----|----|----|---|---|
| 15              | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| GCAL1_MSB[15:8] |    |    |    |    |    |   |   |
| R/W-10000000b   |    |    |    |    |    |   |   |
| 7               | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| GCAL1_MSB[7:0]  |    |    |    |    |    |   |   |
| R/W-00000000b   |    |    |    |    |    |   |   |

**Table 8-31. CH1\_GCAL\_MSB Register Field Descriptions**

| Bit  | Field           | Type | Reset                 | Description                                     |
|------|-----------------|------|-----------------------|-------------------------------------------------|
| 15:0 | GCAL1_MSB[15:0] | R/W  | 1000000000<br>000000b | Channel 1 gain calibration register bits [23:8] |

### 8.6.19 CH1\_GCAL\_LSB Register (Address = 12h) [reset = 0000h]

The CH1\_GCAL\_LSB register is shown in [Figure 8-44](#) and described in [Table 8-32](#).

Return to the [Summary Table](#).

**Figure 8-44. CH1\_GCAL\_LSB Register**

|                |    |    |    |    |    |   |   |
|----------------|----|----|----|----|----|---|---|
| 15             | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| GCAL1_LSB[7:0] |    |    |    |    |    |   |   |
| R/W-00000000b  |    |    |    |    |    |   |   |
| 7              | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| RESERVED       |    |    |    |    |    |   |   |
| R-00000000b    |    |    |    |    |    |   |   |

**Table 8-32. CH1\_GCAL\_LSB Register Field Descriptions**

| Bit  | Field          | Type | Reset     | Description                                    |
|------|----------------|------|-----------|------------------------------------------------|
| 15:8 | GCAL1_LSB[7:0] | R/W  | 00000000b | Channel 1 gain calibration register bits [7:0] |
| 7:0  | RESERVED       | R    | 00000000b | Reserved<br>Always reads 00000000b             |

## 8.6.20 CH2\_CFG Register (Address = 13h) [reset = 0000h]

The CH2\_CFG register is shown in [Figure 8-45](#) and described in [Table 8-33](#).

Return to the [Summary Table](#).

**Figure 8-45. CH2\_CFG Register**

|                 |    |          |    |    |             |           |   |
|-----------------|----|----------|----|----|-------------|-----------|---|
| 15              | 14 | 13       | 12 | 11 | 10          | 9         | 8 |
| PHASE2[9:2]     |    |          |    |    |             |           |   |
| R/W-0000000000b |    |          |    |    |             |           |   |
| 7               | 6  | 5        | 4  | 3  | 2           | 1         | 0 |
| PHASE2[2:0]     |    | RESERVED |    |    | DCBLK2_DIS0 | MUX2[1:0] |   |
| R/W-0000000000b |    | R-000b   |    |    | R/W-0b      | R/W-00b   |   |

**Table 8-33. CH2\_CFG Register Field Descriptions**

| Bit  | Field       | Type | Reset       | Description                                                                                                                                                |
|------|-------------|------|-------------|------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:6 | PHASE2[9:0] | R/W  | 0000000000b | Channel 2 phase delay<br>Phase delay in modulator clock cycles provided in two's complement format. See <a href="#">Table 8-5</a> for details.             |
| 5:3  | RESERVED    | R    | 000b        | Reserved<br>Always reads 000b                                                                                                                              |
| 2    | DCBLK2_DIS0 | R/W  | 0b          | DC block filter for channel 2 disable<br>0b = Controlled by DCBLOCK[3:0] (default)<br>1b = Disabled for this channel                                       |
| 1:0  | MUX2[1:0]   | R/W  | 00b         | Channel 2 input selection<br>00b = AIN2P and AIN2N (default)<br>01b = ADC inputs shorted<br>10b = Positive DC test signal<br>11b = Negative DC test signal |

### 8.6.21 CH2\_OCAL\_MSB Register (Address = 14h) [reset = 0000h]

The CH2\_OCAL\_MSB register is shown in [Figure 8-46](#) and described in [Table 8-34](#).

Return to the [Summary Table](#).

**Figure 8-46. CH2\_OCAL\_MSB Register**

|                 |    |    |    |    |    |   |   |
|-----------------|----|----|----|----|----|---|---|
| 15              | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| OCAL2_MSB[15:8] |    |    |    |    |    |   |   |
| R/W-00000000b   |    |    |    |    |    |   |   |
| 7               | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| OCAL2_MSB[7:0]  |    |    |    |    |    |   |   |
| R/W-00000000b   |    |    |    |    |    |   |   |

**Table 8-34. CH2\_OCAL\_MSB Register Field Descriptions**

| Bit  | Field           | Type | Reset                 | Description                                       |
|------|-----------------|------|-----------------------|---------------------------------------------------|
| 15:0 | OCAL2_MSB[15:0] | R/W  | 00000000<br>00000000b | Channel 2 offset calibration register bits [23:8] |

### 8.6.22 CH2\_OCAL\_LSB Register (Address = 15h) [reset = 0000h]

The CH2\_OCAL\_LSB register is shown in [Figure 8-47](#) and described in [Table 8-35](#).

Return to the [Summary Table](#).

**Figure 8-47. CH2\_OCAL\_LSB Register**

|                |    |    |    |    |    |   |   |
|----------------|----|----|----|----|----|---|---|
| 15             | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| OCAL2_LSB[7:0] |    |    |    |    |    |   |   |
| R/W-00000000b  |    |    |    |    |    |   |   |
| 7              | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| RESERVED       |    |    |    |    |    |   |   |
| R-00000000b    |    |    |    |    |    |   |   |

**Table 8-35. CH2\_OCAL\_LSB Register Field Descriptions**

| Bit  | Field          | Type | Reset     | Description                                      |
|------|----------------|------|-----------|--------------------------------------------------|
| 15:8 | OCAL2_LSB[7:0] | R/W  | 00000000b | Channel 2 offset calibration register bits [7:0] |
| 7:0  | RESERVED       | R    | 00000000b | Reserved<br>Always reads 00000000b               |

### 8.6.23 CH2\_GCAL\_MSB Register (Address = 16h) [reset = 8000h]

The CH2\_GCAL\_MSB register is shown in [Figure 8-48](#) and described in [Table 8-36](#).

Return to the [Summary Table](#).

**Figure 8-48. CH2\_GCAL\_MSB Register**

|                 |    |    |    |    |    |   |   |
|-----------------|----|----|----|----|----|---|---|
| 15              | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| GCAL2_MSB[15:8] |    |    |    |    |    |   |   |
| R/W-10000000b   |    |    |    |    |    |   |   |
| 7               | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| GCAL2_MSB[7:0]  |    |    |    |    |    |   |   |
| R/W-00000000b   |    |    |    |    |    |   |   |

**Table 8-36. CH2\_GCAL\_MSB Register Field Descriptions**

| Bit  | Field           | Type | Reset                 | Description                                     |
|------|-----------------|------|-----------------------|-------------------------------------------------|
| 15:0 | GCAL2_MSB[15:0] | R/W  | 1000000000<br>000000b | Channel 2 gain calibration register bits [23:8] |

### 8.6.24 CH2\_GCAL\_LSB Register (Address = 17h) [reset = 0000h]

The CH2\_GCAL\_LSB register is shown in [Figure 8-49](#) and described in [Table 8-37](#).

Return to the [Summary Table](#).

**Figure 8-49. CH2\_GCAL\_LSB Register**

|                |    |    |    |    |    |   |   |
|----------------|----|----|----|----|----|---|---|
| 15             | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| GCAL2_LSB[7:0] |    |    |    |    |    |   |   |
| R/W-00000000b  |    |    |    |    |    |   |   |
| 7              | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| RESERVED       |    |    |    |    |    |   |   |
| R-00000000b    |    |    |    |    |    |   |   |

**Table 8-37. CH2\_GCAL\_LSB Register Field Descriptions**

| Bit  | Field          | Type | Reset     | Description                                    |
|------|----------------|------|-----------|------------------------------------------------|
| 15:8 | GCAL2_LSB[7:0] | R/W  | 00000000b | Channel 2 gain calibration register bits [7:0] |
| 7:0  | RESERVED       | R    | 00000000b | Reserved<br>Always reads 00000000b             |

### 8.6.25 CH3\_CFG Register (Address = 18h) [reset = 0000h]

The CH3\_CFG register is shown in [Figure 8-50](#) and described in [Table 8-38](#).

Return to the [Summary Table](#).

**Figure 8-50. CH3\_CFG Register**

|                 |    |          |    |    |             |           |   |
|-----------------|----|----------|----|----|-------------|-----------|---|
| 15              | 14 | 13       | 12 | 11 | 10          | 9         | 8 |
| PHASE3[9:2]     |    |          |    |    |             |           |   |
| R/W-0000000000b |    |          |    |    |             |           |   |
| 7               | 6  | 5        | 4  | 3  | 2           | 1         | 0 |
| PHASE3[1:0]     |    | RESERVED |    |    | DCBLK3_DIS0 | MUX3[1:0] |   |
| R/W-0000000000b |    | R-000b   |    |    | R/W-0b      | R/W-00b   |   |

**Table 8-38. CH3\_CFG Register Field Descriptions**

| Bit  | Field       | Type | Reset       | Description                                                                                                                                                    |
|------|-------------|------|-------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:6 | PHASE3[9:0] | R/W  | 0000000000b | Channel 3 phase delay<br>Phase delay in modulator clock cycles provided in two's complement format. See <a href="#">Table 8-5</a> for details.                 |
| 5:3  | RESERVED    | R    | 000b        | Reserved<br>Always reads 000b                                                                                                                                  |
| 2    | DCBLK3_DIS0 | R/W  | 0b          | DC block filter for channel 3 disable<br><br>0b = Controlled by DCBLOCK[3:0] (default)<br>1b = Disabled for this channel                                       |
| 1:0  | MUX3[1:0]   | R/W  | 00b         | Channel 3 input selection<br><br>00b = AIN3P and AIN3N (default)<br>01b = ADC inputs shorted<br>10b = Positive DC test signal<br>11b = Negative DC test signal |

### 8.6.26 CH3\_OCAL\_MSB Register (Address = 19h) [reset = 0000h]

The CH3\_OCAL\_MSB register is shown in [Figure 8-51](#) and described in [Table 8-39](#).

Return to the [Summary Table](#).

**Figure 8-51. CH3\_OCAL\_MSB Register**

|                 |    |    |    |    |    |   |   |
|-----------------|----|----|----|----|----|---|---|
| 15              | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| OCAL3_MSB[15:8] |    |    |    |    |    |   |   |
| R/W-00000000b   |    |    |    |    |    |   |   |
| 7               | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| OCAL3_MSB[7:0]  |    |    |    |    |    |   |   |
| R/W-00000000b   |    |    |    |    |    |   |   |

**Table 8-39. CH3\_OCAL\_MSB Register Field Descriptions**

| Bit  | Field           | Type | Reset                 | Description                                       |
|------|-----------------|------|-----------------------|---------------------------------------------------|
| 15:0 | OCAL3_MSB[15:0] | R/W  | 00000000<br>00000000b | Channel 3 offset calibration register bits [23:8] |

### 8.6.27 CH3\_OCAL\_LSB Register (Address = 1Ah) [reset = 0000h]

The CH3\_OCAL\_LSB register is shown in [Figure 8-52](#) and described in [Table 8-40](#).

Return to the [Summary Table](#).

**Figure 8-52. CH3\_OCAL\_LSB Register**

|                |    |    |    |    |    |   |   |
|----------------|----|----|----|----|----|---|---|
| 15             | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| OCAL3_LSB[7:0] |    |    |    |    |    |   |   |
| R/W-00000000b  |    |    |    |    |    |   |   |
| 7              | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| RESERVED       |    |    |    |    |    |   |   |
| R-00000000b    |    |    |    |    |    |   |   |

**Table 8-40. CH3\_OCAL\_LSB Register Field Descriptions**

| Bit  | Field          | Type | Reset     | Description                                      |
|------|----------------|------|-----------|--------------------------------------------------|
| 15:8 | OCAL3_LSB[7:0] | R/W  | 00000000b | Channel 3 offset calibration register bits [7:0] |
| 7:0  | RESERVED       | R    | 00000000b | Reserved<br>Always reads 00000000b               |

### 8.6.28 CH3\_GCAL\_MSB Register (Address = 1Bh) [reset = 8000h]

The CH3\_GCAL\_MSB register is shown in [Figure 8-53](#) and described in [Table 8-41](#).

Return to the [Summary Table](#).

**Figure 8-53. CH3\_GCAL\_MSB Register**

|                 |    |    |    |    |    |   |   |
|-----------------|----|----|----|----|----|---|---|
| 15              | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| GCAL3_MSB[15:8] |    |    |    |    |    |   |   |
| R/W-10000000b   |    |    |    |    |    |   |   |
| 7               | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| GCAL3_MSB[7:0]  |    |    |    |    |    |   |   |
| R/W-00000000b   |    |    |    |    |    |   |   |

**Table 8-41. CH3\_GCAL\_MSB Register Field Descriptions**

| Bit  | Field           | Type | Reset                 | Description                                     |
|------|-----------------|------|-----------------------|-------------------------------------------------|
| 15:0 | GCAL3_MSB[15:0] | R/W  | 1000000000<br>000000b | Channel 3 gain calibration register bits [23:8] |

### 8.6.29 CH3\_GCAL\_LSB Register (Address = 1Ch) [reset = 0000h]

The CH3\_GCAL\_LSB register is shown in [Figure 8-54](#) and described in [Table 8-42](#).

Return to the [Summary Table](#).

**Figure 8-54. CH3\_GCAL\_LSB Register**

|                |    |    |    |    |    |   |   |
|----------------|----|----|----|----|----|---|---|
| 15             | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| GCAL3_LSB[7:0] |    |    |    |    |    |   |   |
| R/W-00000000b  |    |    |    |    |    |   |   |
| 7              | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| RESERVED       |    |    |    |    |    |   |   |
| R-00000000b    |    |    |    |    |    |   |   |

**Table 8-42. CH3\_GCAL\_LSB Register Field Descriptions**

| Bit  | Field          | Type | Reset     | Description                                    |
|------|----------------|------|-----------|------------------------------------------------|
| 15:8 | GCAL3_LSB[7:0] | R/W  | 00000000b | Channel 3 gain calibration register bits [7:0] |
| 7:0  | RESERVED       | R    | 00000000b | Reserved<br>Always reads 00000000b             |



### 8.6.30 REGMAP\_CRC Register (Address = 3Eh) [reset = 0000h]

The REGMAP\_CRC register is shown in [Figure 8-55](#) and described in [Table 8-43](#).

Return to the [Summary Table](#).

**Figure 8-55. REGMAP\_CRC Register**

|                     |    |    |    |    |    |   |   |
|---------------------|----|----|----|----|----|---|---|
| 15                  | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| REG_CRC[15:8]       |    |    |    |    |    |   |   |
| R-0000000000000000b |    |    |    |    |    |   |   |
| 7                   | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| REG_CRC[7:0]        |    |    |    |    |    |   |   |
| R-0000000000000000b |    |    |    |    |    |   |   |

**Table 8-43. REGMAP\_CRC Register Field Descriptions**

| Bit  | Field         | Type | Reset                 | Description      |
|------|---------------|------|-----------------------|------------------|
| 15:0 | REG_CRC[15:0] | R    | 00000000<br>00000000b | Register map CRC |

### 8.6.31 RESERVED Register (Address = 3Fh) [reset = 0000h]

The RESERVED register is shown in [Figure 8-56](#) and described in [Table 8-44](#).

Return to the [Summary Table](#).

**Figure 8-56. RESERVED Register**

|               |    |    |    |    |    |   |   |
|---------------|----|----|----|----|----|---|---|
| 15            | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| RESERVED      |    |    |    |    |    |   |   |
| R/W-00000000b |    |    |    |    |    |   |   |
| 7             | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| RESERVED      |    |    |    |    |    |   |   |
| R/W-00000000b |    |    |    |    |    |   |   |

**Table 8-44. RESERVED Register Field Descriptions**

| Bit  | Field    | Type | Reset                 | Description                                 |
|------|----------|------|-----------------------|---------------------------------------------|
| 15:0 | RESERVED | R/W  | 00000000<br>00000000b | Reserved,<br>Always write 0000000000000000b |

## 9 Application and Implementation

### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 9.1 Application Information

#### 9.1.1 Unused Inputs and Outputs

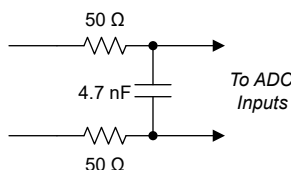
Leave any unused analog inputs floating or connect them to AGND.

Do not float unused digital inputs because excessive power-supply leakage current can result. Tie all unused digital inputs to the appropriate levels, DVDD or DGND. Leave the DRDY pin unconnected or connect this pin to DVDD using a weak pullup resistor if unused.

#### 9.1.2 Antialiasing

An analog low-pass filter is required in front of each of the channel inputs to prevent out-of-band noise and interferers from coupling into the band of interest. Because the ADS131M04-Q1 is a delta-sigma ADC, the integrated digital filter provides substantial attenuation for frequencies outside of the band of interest up to the frequencies adjacent to  $f_{MOD}$ . Therefore, a single-order RC filter provides sufficient antialiasing protection in the vast majority of applications.

Choosing the values of the resistor and capacitor depends on the desired cutoff frequency, limiting source impedance for the ADC inputs, and providing enough instantaneous charge to the ADC input sampling circuit through the filter capacitor. [Figure 9-1](#) shows the recommended filter component values. These recommendations are sufficient for CLKIN frequencies between 2 MHz and 8.2 MHz.



**Figure 9-1. Recommended Antialiasing Circuitry**

### 9.1.3 Minimum Interface Connections

Figure 9-2 depicts how the ADS131M04-Q1 can be configured for the minimum number of interface pins. This configuration is useful when using data isolation to minimize the number of isolation channels required or when the microcontroller (MCU) pins are limited.

The CLKIN pin requires an LVCMOS clock that can be either generated by the MCU or created using a local LVCMOS output device. Tie the  $\overline{\text{SYNC/RESET}}$  pin to DVDD in hardware if unused. The  $\overline{\text{DRDY}}$  pin can be left floating if unused. Connect either  $\overline{\text{SYNC/RESET}}$  or  $\overline{\text{DRDY}}$  to the MCU to ensure the MCU stays synchronized to ADC conversions. If the MCU provides CLKIN, the CLKIN periods can be counted to determine the sample period rather than forcing synchronization using the  $\overline{\text{SYNC/RESET}}$  pin or monitoring the  $\overline{\text{DRDY}}$  pin. Synchronization cannot be regained if a bit error occurs on the clock and samples can be missed if the  $\overline{\text{SYNC/RESET}}$  or  $\overline{\text{DRDY}}$  pins are not used.  $\overline{\text{CS}}$  can be tied low in hardware if the ADS131M04-Q1 is the only device on the SPI bus. Ensure the data input and output CRC are enabled and are used to guard against faulty register reads and writes if  $\overline{\text{CS}}$  is tied low permanently.

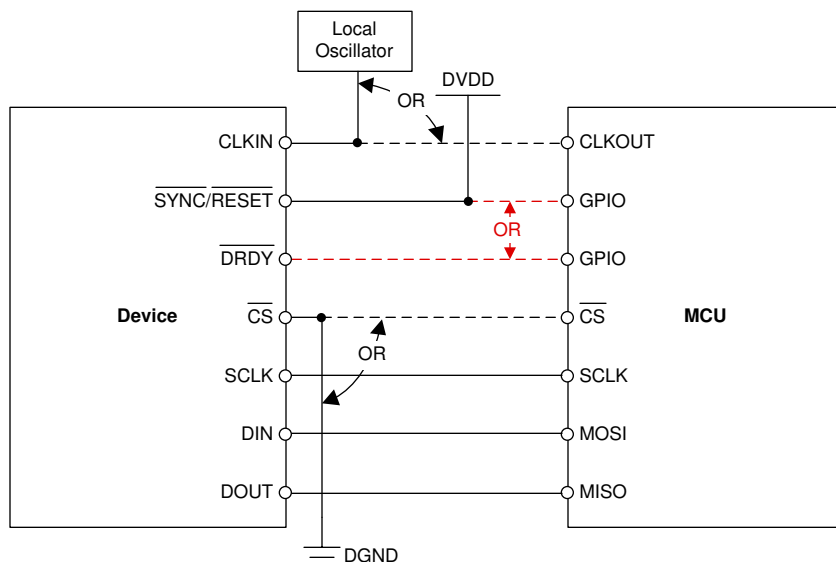


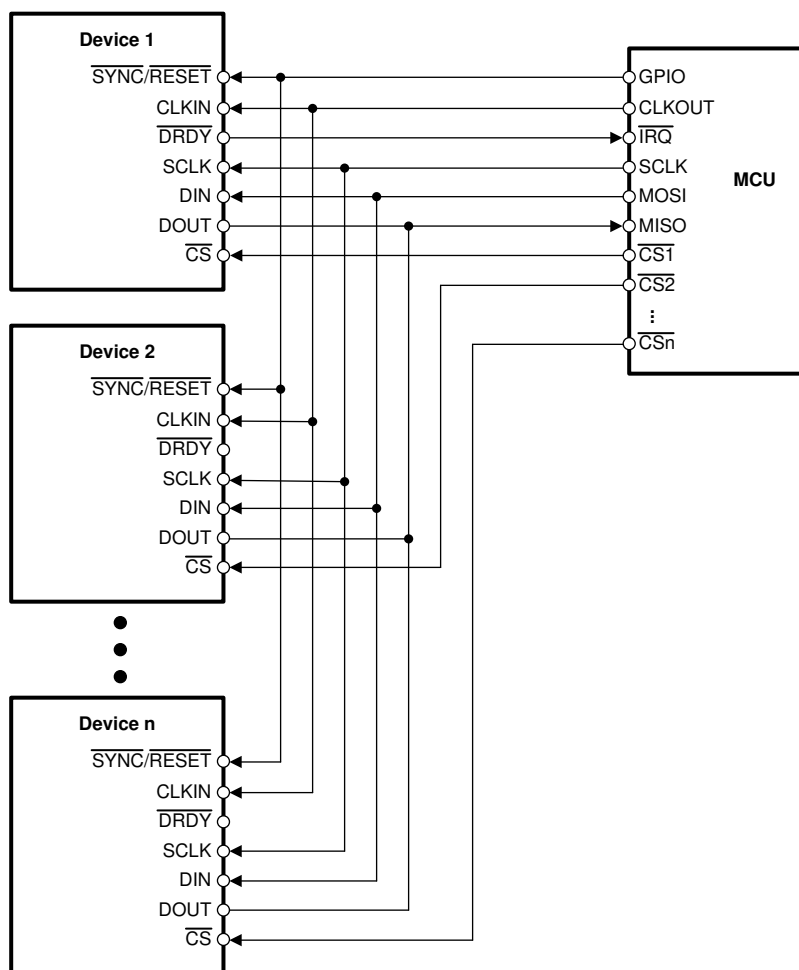
Figure 9-2. Minimum Connections Required to Operate the ADS131M04-Q1

### 9.1.4 Multiple Device Configuration

Multiple ADS131M04-Q1 devices can be arranged to capture all signals simultaneously. The same clock must be provided to all devices and the  $\overline{\text{SYNC/RESET}}$  pins must be strobed simultaneously at least one time to align the sample periods internally between devices. The phase settings of each device can be changed uniquely, but the host must take care to record which channel in the group of devices represents the *zero* phase.

The devices can also share the SPI bus where only the  $\overline{\text{CS}}$  pins for each device are unique. Each device can be addressed sequentially by asserting  $\overline{\text{CS}}$  for the device that the host wishes to communicate with. The DOUT pin remains high impedance when the  $\overline{\text{CS}}$  pin is high, allowing the DOUT lines to be shared between devices as long as no two devices sharing the bus simultaneously have their  $\overline{\text{CS}}$  pins low. Figure 9-3 shows multiple devices configured for simultaneous data acquisition while sharing the SPI bus.

Monitoring the  $\overline{\text{DRDY}}$  output of only one of the devices is sufficient because all devices convert simultaneously.



**Figure 9-3. Multiple Device Configuration**

### 9.1.5 Troubleshooting

[Table 9-1](#) lists common issues faced when designing with the ADS131M04-Q1 and the corresponding solutions. This list is not comprehensive.

**Table 9-1. Troubleshooting Common Issues Using the ADS131M04-Q1**

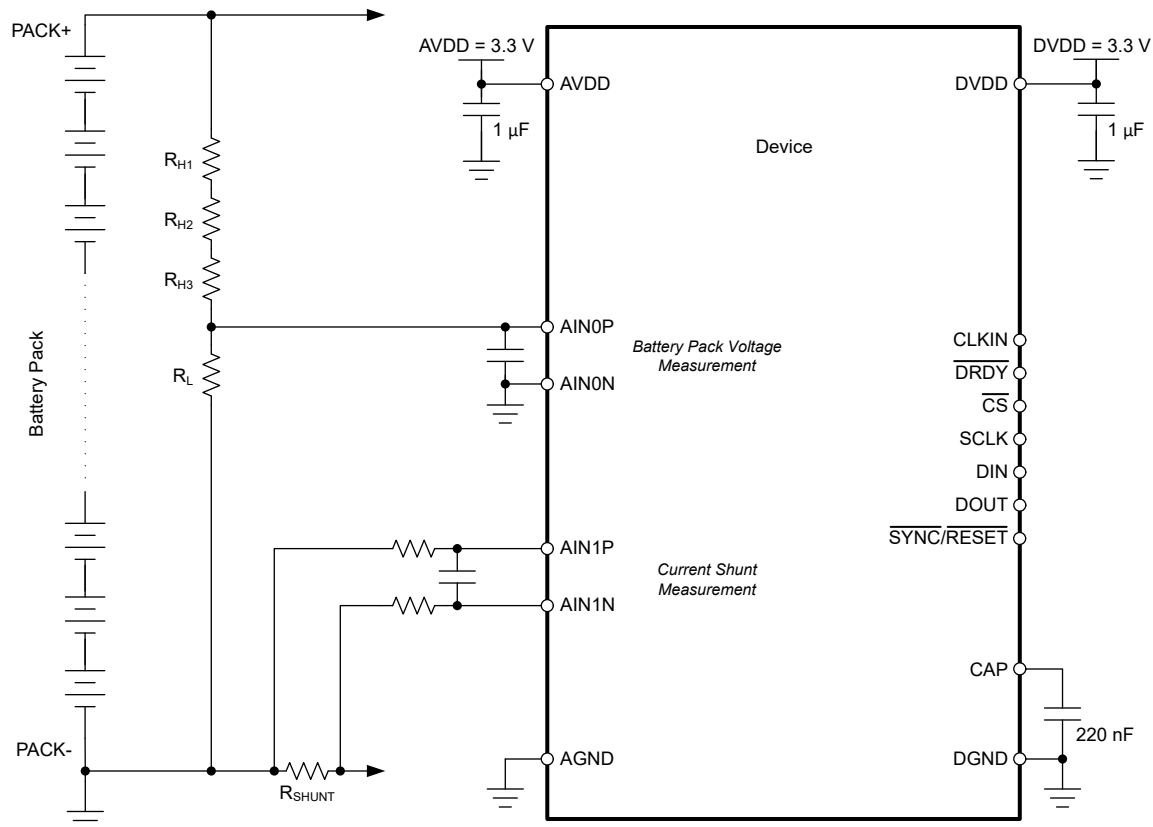
| ISSUE                                                                                | POSSIBLE ROOT CAUSE                                                                                                                                        | POSSIBLE SOLUTION                                                                                                                                                                                                                                               |
|--------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| The $\overline{\text{DRDY}}$ pin is toggling at half the expected frequency.         | ADC conversion data are not being read.<br>The two-deep ADC data FIFO overflows and triggers $\overline{\text{DRDY}}$ one time every two ADC data periods. | Read data after each $\overline{\text{DRDY}}$ falling edge after following the recommendations given in the <a href="#">Collecting Data for the First Time or After a Pause in Data Collection</a> section.                                                     |
| The F_RESYNC bit is set in the STATUS word even though this bit was already cleared. | The $\overline{\text{SYNC/RESET}}$ pin is being toggled asynchronously to CLKIN.                                                                           | The $\overline{\text{SYNC/RESET}}$ pin functions as a constant synchronization check, rather than a <i>convert start</i> pin. See the <a href="#">Synchronization</a> section for more details on the intended usage of the $\overline{\text{SYNC/RESET}}$ pin. |
| The same ADC conversion data are output twice before changing.                       | The entire frame is not being sent to the ADC. The ADC does not recognize data as being read.                                                              | Read all data words in the output data frame, including those for channels that are disabled.                                                                                                                                                                   |

## 9.2 Typical Application

This section describes a typical battery management system (BMS) application circuit using the ADS131M04-Q1. The device serves the following primary functions in this BMS:

- Measure battery current with high resolution and accuracy using a low-side current shunt sensor
- Measure peak currents and detect overcurrent or short-circuit conditions
- Measure battery-pack voltage using a high-voltage resistor divider

Figure 9-4 shows the front-end for the battery management system circuit design.



**Figure 9-4. ADS131M04-Q1 in a Typical Battery Management System Application**

### 9.2.1 Design Requirements

**Table 9-2. Design Requirements**

| DESIGN PARAMETER                        | VALUE        |
|-----------------------------------------|--------------|
| <b>Current Measurement</b>              |              |
| Current measurement range               | ±5 kA        |
| Current shunt value                     | 35 µΩ        |
| Update rate                             | 1 ms         |
| <b>Battery-Pack Voltage Measurement</b> |              |
| Voltage measurement range               | 0 V to 800 V |

## 9.2.2 Detailed Design Procedure

The following sections provide guidelines for selecting the external components and the configuration of the ADS131M04-Q1 for the various measurements in this application example.

### 9.2.2.1 Current Shunt Measurement

In a typical BMS, the current through the shunt resistor must be measured in both directions for charging and discharging the battery pack. In an overcurrent or short-circuit condition, the current can be as high as  $I_{BAT\_MAX} = \pm 5$  kA in this example application. Therefore, the maximum voltage drop across the shunt is up to  $V_{SHUNT} = R_{SHUNT} \times I_{BAT\_MAX} = 35 \mu\Omega \times \pm 4$  kA =  $\pm 140$  mV.

To measure this shunt voltage, configure channel 1 of the ADS131M04-Q1 for gain = 8, which allows differential voltage measurements of  $V_{IN1} = V_{AIN1P} - V_{AIN1N} = \pm V_{REF} / 8 = \pm 1.2$  V / 8 =  $\pm 150$  mV. The integrated charge pump in the device allows voltage measurements 1.3 V below AGND while using a unipolar analog power supply. This bipolar voltage measurement capability is important because one side of the shunt is connected to the same GND potential as the AGND pin of the ADS131M04-Q1, which means that the absolute voltage that the device must measure is up to 140 mV below AGND.

To enable fast overcurrent detection within 1 ms while providing high accuracy and resolution, operate the ADS131M04-Q1 at 4 kSPS (OSR = 1024, high-resolution mode) using global-chop mode. Global-chop mode enables measurements with minimal offset error over temperature and time. The conversion time using these settings is 0.754 ms according to Equation 9. The input-referred noise is approximately  $2.70 \mu V_{RMS} / \sqrt{2} = 1.91 \mu V_{RMS}$  following the explanations in the [Noise Measurements](#) section. Thus, currents as small as  $1.91 \mu V_{RMS} / 35 \mu\Omega = 55$  mA can be resolved. The resolution can be further improved by averaging the conversion results over a longer period of time in the microcontroller that interfaces with the ADS131M04-Q1.

### 9.2.2.2 Battery Pack Voltage Measurement

The 800-V battery-pack voltage is divided down to the voltage range of the ADS131M04-Q1 using a high-voltage resistor divider ( $R_{H1}$ ,  $R_{H2}$ ,  $R_{H3}$ , and  $R_L$ ). Gain = 1 is used for channel 0 in this case to allow differential voltage measurements of  $V_{IN0} = V_{AIN0P} - V_{AIN0N} = \pm 1.2$  V. The battery-pack voltage measurement is a unipolar, single-ended measurement. Thus, only the voltage range from 0 V to 1.2 V of the ADS131M04-Q1 is used. Equation 11 calculates the resistor divider ratio.

$$V_{IN} / V_{BAT\_MAX} = 1.2 \text{ V} / 800 \text{ V} = R_L / (R_L + R_{H1} + R_{H2} + R_{H3}) \quad (11)$$

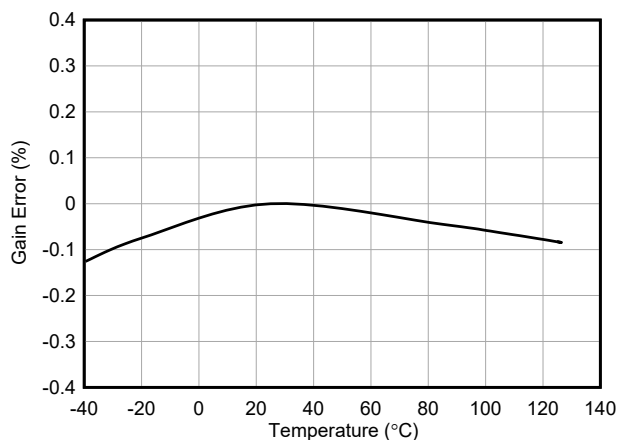
The leakage current drawn by the resistor divider must be less than 100  $\mu$ A in this example to avoid unnecessarily draining the battery. The resistance of the divider must therefore be larger than  $R_{TOTAL} \geq V_{BAT\_MAX} / I_{LEAKAGE} = 800 \text{ V} / 100 \mu\text{A} = 8$  M $\Omega$ . The resistor values are chosen as  $R_{H1} = R_{H2} = R_{H3} = 2.8$  M $\Omega$  and  $R_L = 12.4$  k $\Omega$ . Thus, the maximum voltage across  $R_L$  is 1.18 V at  $V_{BAT\_MAX} = 800$  V, leaving some headroom to the maximum input voltage of 1.2 V of the ADS131M04-Q1.

The maximum resistance of a single resistor that can be used in an automotive circuit design is often limited to a certain value. Also, the maximum voltage a single resistor can withstand is limited. These reasons are why the high-side resistor of the divider is split into multiple resistors ( $R_{H1}$ ,  $R_{H2}$ , and  $R_{H3}$ ). Another reason is that in case a single resistor has a short-circuit fault, the remaining resistors still limit the current into the ADS131M04-Q1 analog input pin (AIN0P) to safe levels.



### 9.2.3 Application Curve

Figure 9-5 shows the gain error of the current measurement (ADC channel 1) over temperature excluding the error of the shunt. The gain error is calibrated at 25°C.



**Figure 9-5. Gain Error vs Temperature**

## 9.3 Power Supply Recommendations

### 9.3.1 CAP Pin Behavior

The ADS131M04-Q1 core digital voltage of 1.8 V is created from an internal LDO from DVDD. The CAP pin outputs the LDO voltage created from the DVDD supply and requires an external bypass capacitor. When operating from DVDD > 2.7 V, place a 220-nF capacitor on the CAP pin to DGND. If DVDD ≤ 2 V, tie the CAP pin directly to the DVDD pin and decouple the star-connected pins using a 100-nF capacitor to DGND.

### 9.3.2 Power-Supply Sequencing

The power supplies can be sequenced in any order but the analog and digital inputs must never exceed the respective analog or digital power-supply voltage limits.

### 9.3.3 Power-Supply Decoupling

Good power-supply decoupling is important to achieve optimum performance. AVDD and DVDD must each be decoupled with a 1-μF capacitor. Place the bypass capacitors as close to the power-supply pins of the device as possible with low-impedance connections. Using multilayer ceramic chip capacitors (MLCCs) that offer low equivalent series resistance (ESR) and inductance (ESL) characteristics are recommended for power-supply decoupling purposes. For very sensitive systems, or for systems in harsh noise environments, avoiding the use of vias for connecting the capacitors to the device pins can offer superior noise immunity. The use of multiple vias in parallel lowers the overall inductance and is beneficial for connections to ground planes. The analog and digital ground are recommended to be connected together as close to the device as possible.

## 9.4 Layout

### 9.4.1 Layout Guidelines

For best performance, dedicate an entire PCB layer to a ground plane and do not route any other signal traces on this layer. However, depending on restrictions imposed by specific end equipment, a dedicated ground plane may not be practical. If ground plane separation is necessary, make a direct connection of the planes at the ADC. Do not connect individual ground planes at multiple locations because this configuration creates ground loops.

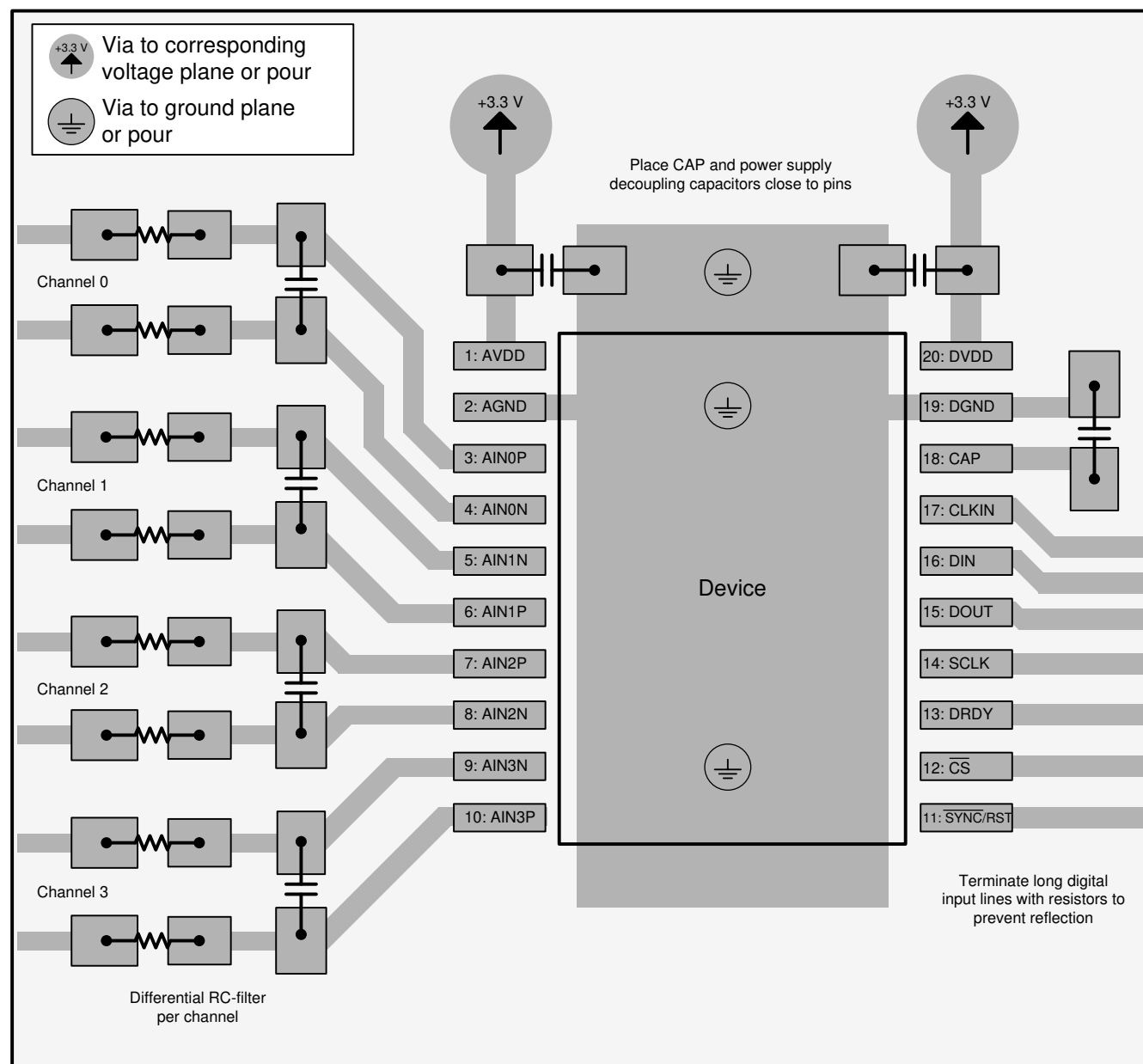
Route digital traces away from all analog inputs and associated components in order to minimize interference.

Use C0G capacitors on the analog inputs. Use ceramic capacitors (for example, X7R grade) for the power-supply decoupling capacitors. High-K capacitors (Y5V) are not recommended. Place the required capacitors as close as possible to the device pins using short, direct traces. For optimum performance, use low-impedance connections on the ground-side connections of the bypass capacitors.

When applying an external clock, be sure the clock is free of overshoot and glitches. A source-termination resistor placed at the clock buffer often helps reduce overshoot. Glitches present on the clock input can lead to noise within the conversion data.

## 9.4.2 Layout Example

Figure 9-6 shows an example layout of the ADS131M04-Q1 requiring a minimum of two PCB layers. In general, analog signals and planes are partitioned to the left and digital signals and planes to the right.



**Figure 9-6. Layout Example**

## 10 Device and Documentation Support

### 10.1 Documentation Support

#### 10.1.1 Related Documentation

For related documentation see the following:

- Texas Instruments, [REF50xx Low-Noise, Very Low Drift, Precision Voltage Reference data sheet](#)

### 10.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](#). Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 10.3 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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### 10.4 Trademarks

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### 10.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 10.6 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

## 11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| ADS131M04QPWRQ1  | ACTIVE        | TSSOP        | PW                 | 20   | 2000           | RoHS & Green    | NIPDAU                               | Level-3-260C-168 HR  | -40 to 125   | A131M04Q                | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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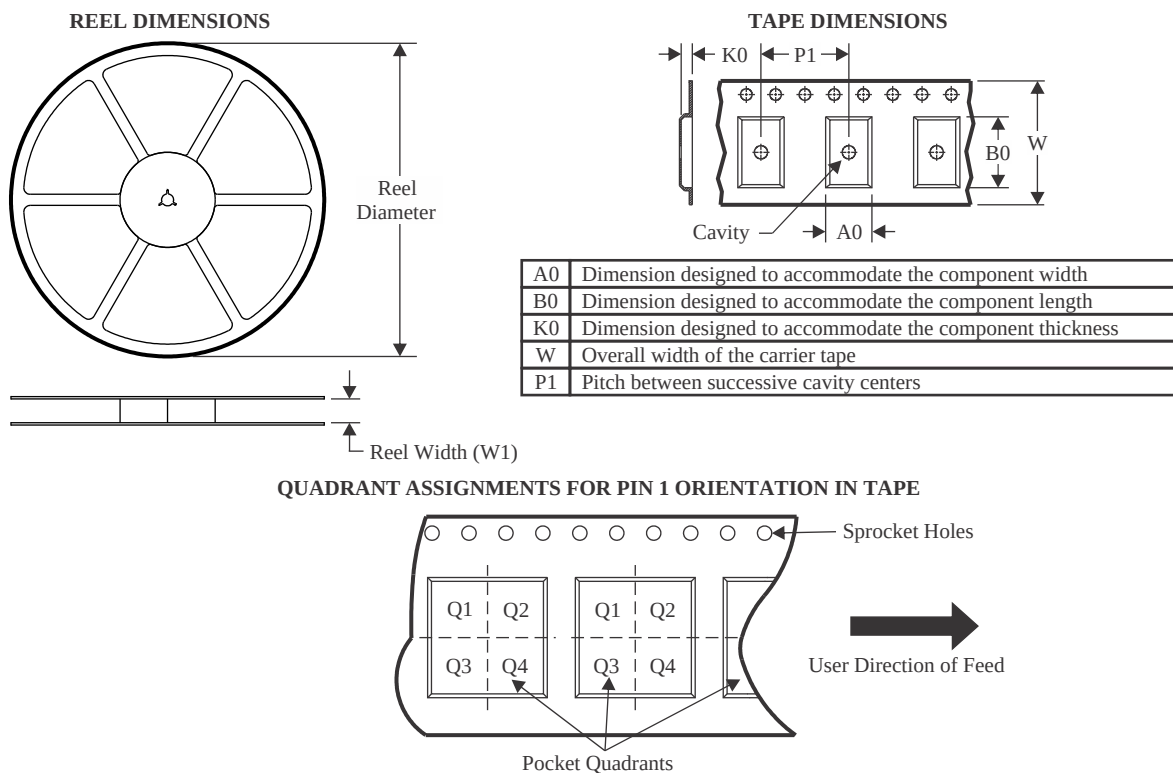
**OTHER QUALIFIED VERSIONS OF ADS131M04-Q1 :**

- Catalog : [ADS131M04](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

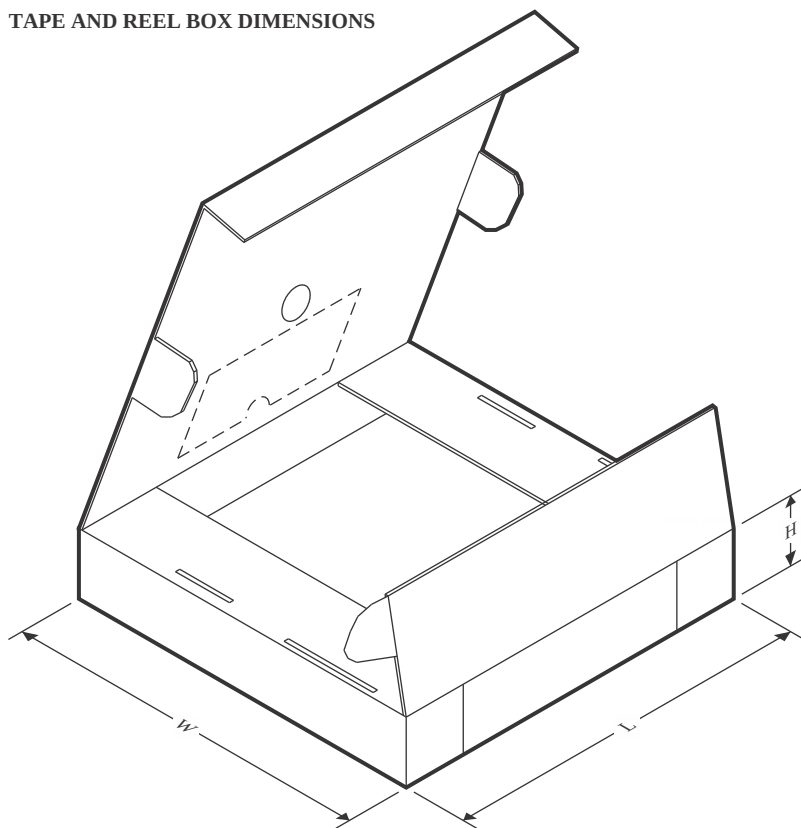
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| ADS131M04QPWRQ1 | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.0     | 1.4     | 8.0     | 16.0   | Q1            |

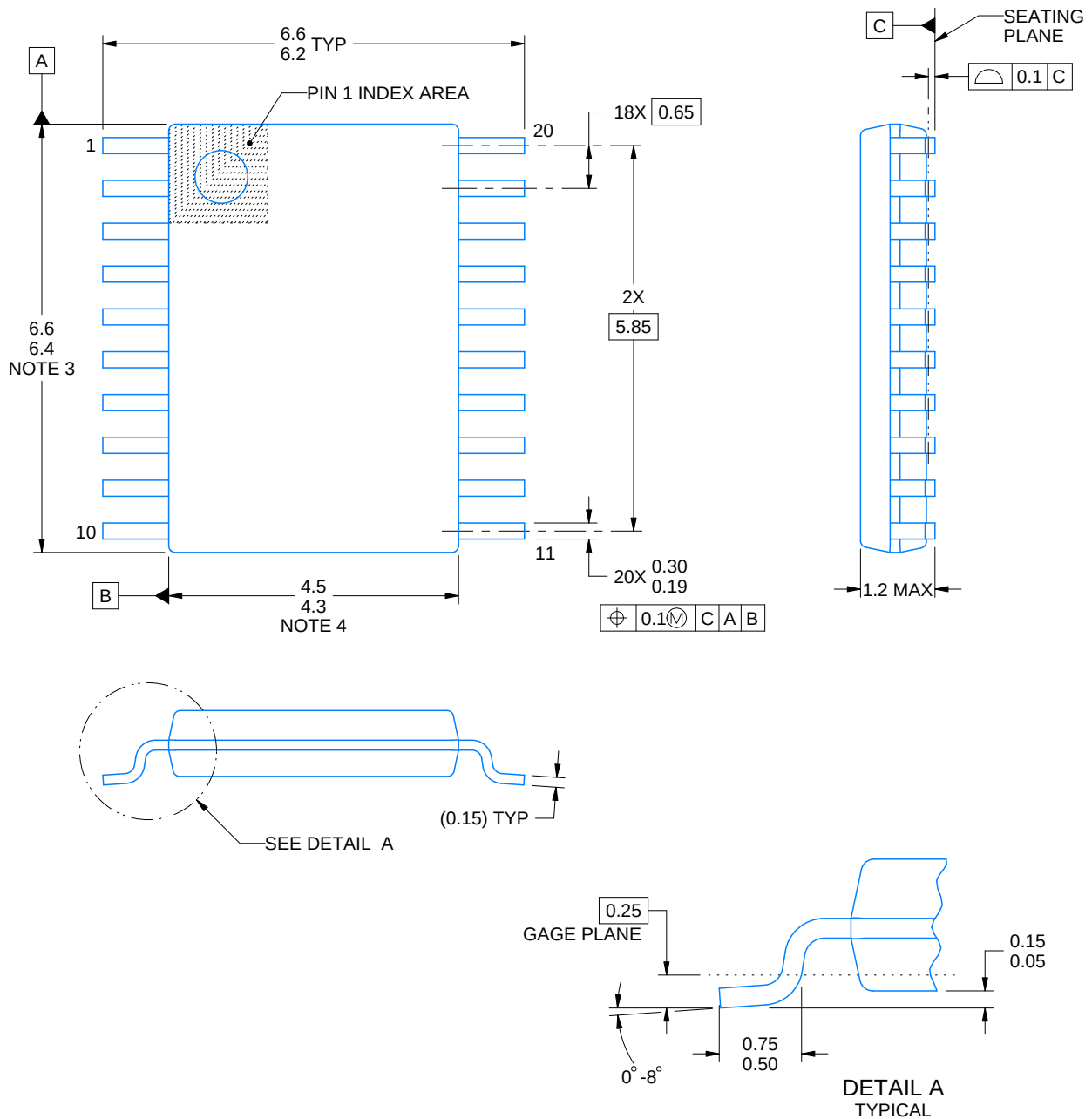
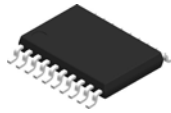
## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| ADS131M04QPWRQ1 | TSSOP        | PW              | 20   | 2000 | 356.0       | 356.0      | 35.0        |





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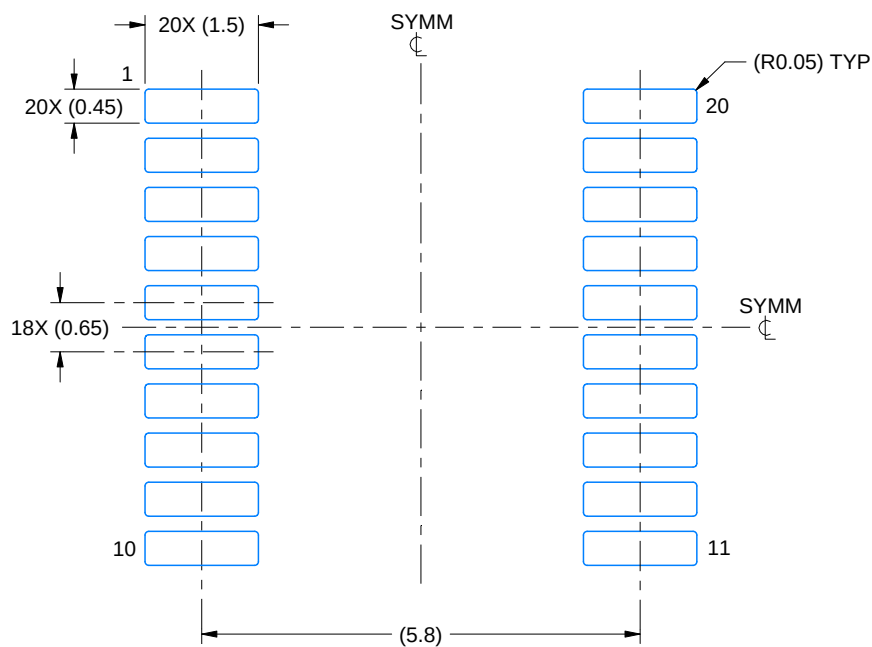
## NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

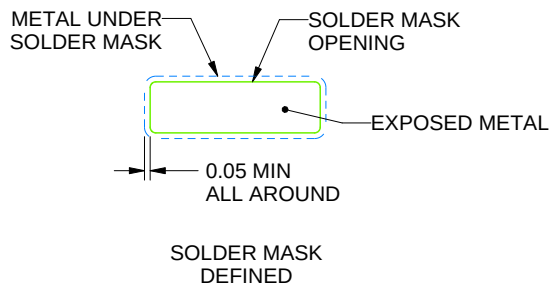
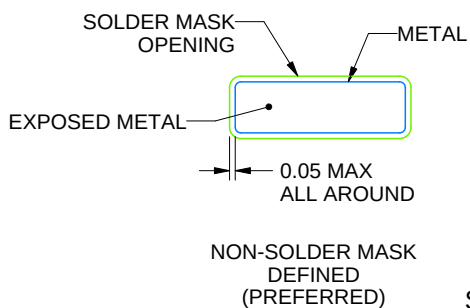
**PW0020A**

**TSSOP - 1.2 mm max height**

## SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



## SOLDER MASK DETAILS

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NOTES: (continued)

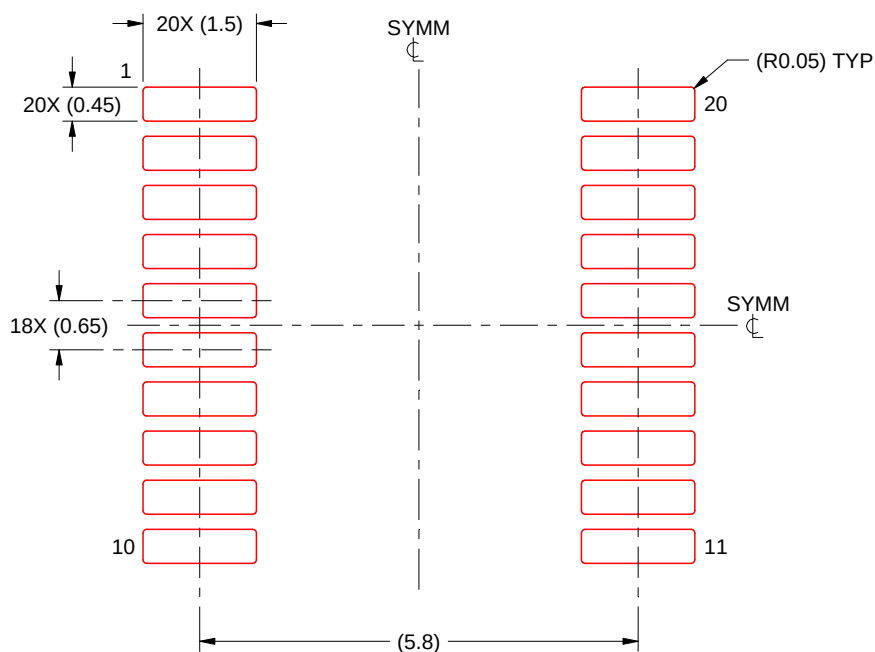
6. Publication IPC-7351 may have alternate designs.  
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

PW0020A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

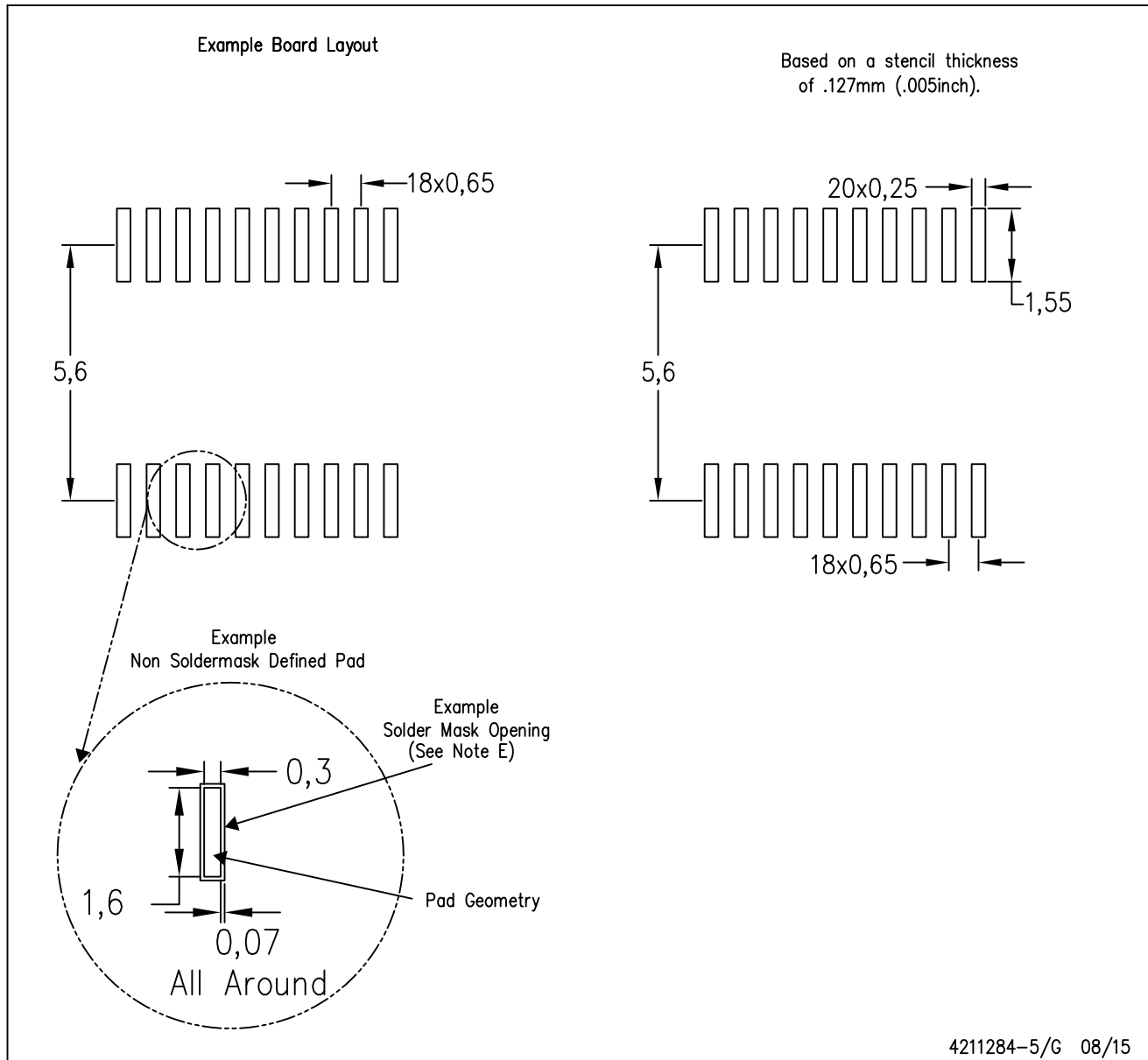
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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

PW (R-PDSO-G20)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate design.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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